

# LP3913

*LP3913 Power Management IC for Flash Memory Based Portable Media Players*



Literature Number: SNVS489H

# LP3913

## Power Management IC for Flash Memory Based Portable Media Players

### General Description

The LP3913 is a programmable system power management unit that is optimized for Flash Memory based Portable Media Players.

The LP3913 incorporates 2 low-dropout LDO voltage regulators, 3 integrated Buck DC/DC converters with Dynamic Voltage Scaling (DVS), a 4-channel 8-bit A/D converter, and a dual source Li-Ion/polymer battery charger. The charger has the capability to charge and maintain a single cell battery from a regulated wall adapter or USB power. When both USB and adapter sources are present, then the adapter source takes precedence and switching between USB and adapter power sources is seamless. In addition, the battery charger supports power routing, which allows system usage immediately after an external power source has been detected. The LP3913 also incorporates some advanced battery management functions such as battery temperature measurement, reverse current blocking for USB, LED charger status indication, thermally regulated internal power FETs, battery voltage monitoring, over-current protection and a 10-hour safety timer.

The 4-channel A/D converter measures the battery voltage and charge current, which can be used for fuel gauging. Two undedicated channels can be used to measure other analog parameters such as discharge current, battery temperature, keyboard resistor scanning and more.

The various IC parameters are programmable through a 400 kHz I<sup>2</sup>C compatible interface.

The LP3913 is available in a thermally-enhanced 6x6x0.8 mm 48 LLP package and operates over an ambient temperature range of -40°C to +85°C.

### Features

- 2 low-dropout regulators -- LDO1 is used for general purpose applications, LDO2 is used for low-noise analog applications. Both LDOs have programmable output voltages.
- Green and Red LED charger status drivers
- 4-channel 8-bit dual slope a/d converter
- 3 High-efficiency DVS Buck converters
- 400 kHz I<sup>2</sup>C compatible interface
- Linear constant-current / constant-voltage charger for single cell lithium-ion batteries
- USB and Adapter charging
- System power supply management
- 6x6x0.8mm 48 LLP package
- Voltage and thermal supervisory circuits
- Continuous battery voltage monitoring
- Interrupt Request output with 8 sources
- LP3913 is pin for pin and software compatible with the LP3910 Hard Drive based PMIC

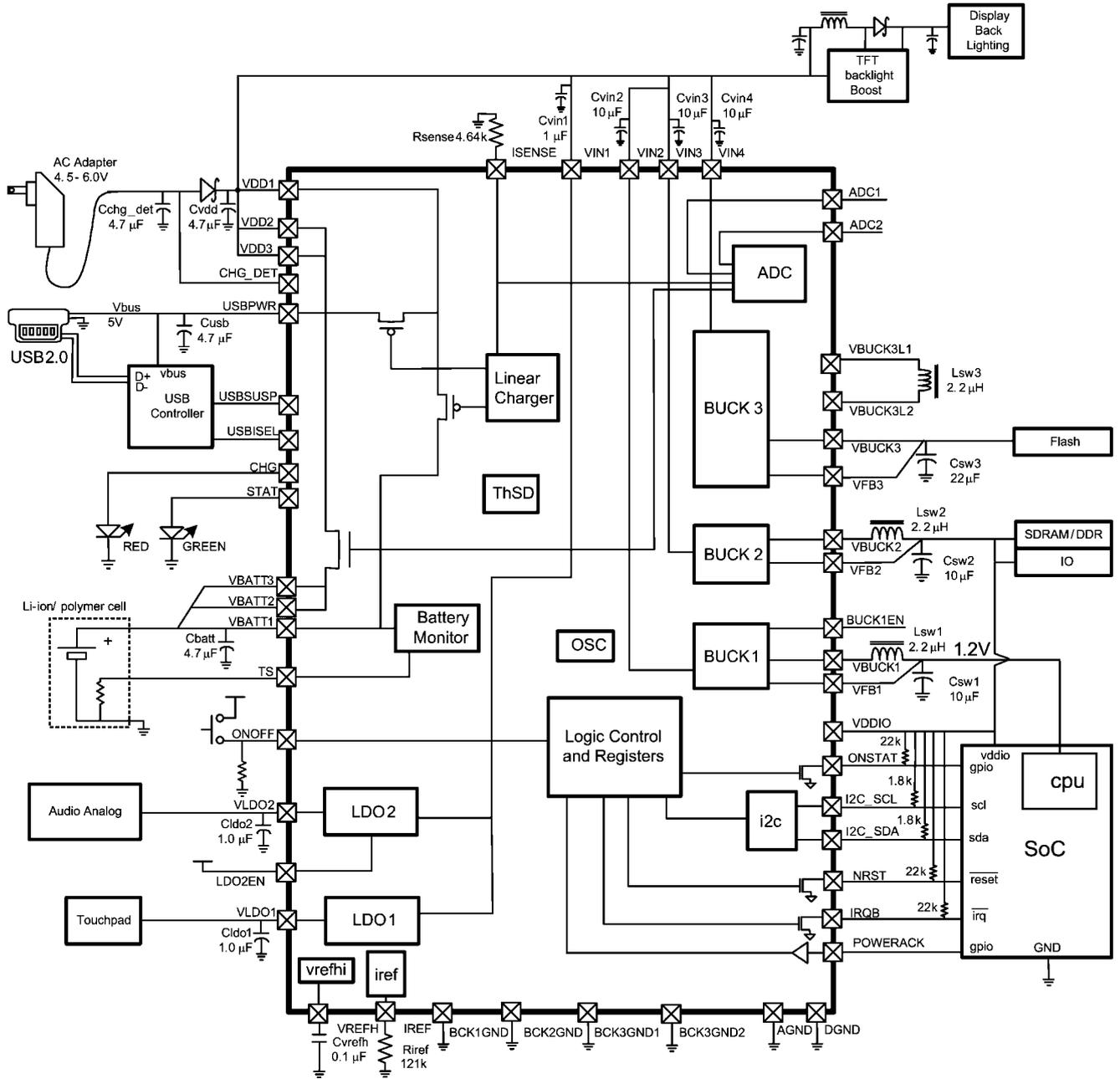
### Key Specifications

- LDO1: 150 mA, 1.2V–3.3V
- LDO2: 150 mA, 1.3V–3.3V
- Buck1: 600 mA, 0.8V–2.0V
- Buck2: 600 mA, 1.8V–3.3V
- Buck3: 500 mA, 1.8V–3.3V
- 50 mΩ battery path resistance
- 100 mA–1000 mA full-rate charge current using wall adapter
- Selectable 0.05C and 0.1C EOC current
- USB current limit of 100 mA, 500 mA, and 800 mA
- USB pre-qual current of 50 mA
- Selectable 4.1V, 4.2V or 4.38V battery termination voltages
- 0.35% battery termination accuracy
- ±1 LSB INL/DNL on 8-bit a/d converter

### Applications

- Flash-based portable media players
- Portable gaming devices
- Portable navigation systems

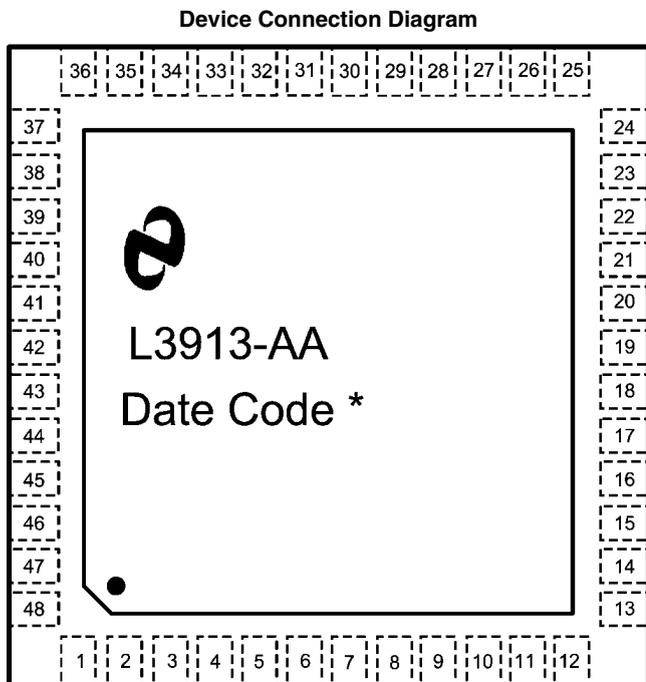
# Typical Application Circuit



30000101

FIGURE 1. Application Diagram

## Connection Diagram



**48 LLP Package (Top View)  
SQF48A**

30000102

The physical placement of the package marking will vary from part to part.

(\*) UZXYTT format: 'U' – wafer fab code; 'Z' – assembly code; 'XY' 2 digit date code; 'TT' – die run code

See [http://www.national.com/quality/marketing\\_conventions.html](http://www.national.com/quality/marketing_conventions.html) for more information on marking information.

## Ordering Information

| Order Number | Package Type | NSC Package Drawing | Top Mark | Supplied As      |
|--------------|--------------|---------------------|----------|------------------|
| LP3913SQ-AA  | 48-lead LLP  | SQF48A              | L3913-AA | 250 tape & reel  |
| LP3913SQX-AA | 48-lead LLP  | SQF48A              | L3913-AA | 2500 tape & reel |

## Device Default Options

| Order Number | LDO1 | LDO2 | Buck1 | Buck2 | Buck3 | I <sub>CHRG</sub> |
|--------------|------|------|-------|-------|-------|-------------------|
| LP3913SQ-AA  | 2.0V | 3.3V | 1.2V  | 3.3V  | 3.3V  | 100mA             |
| LP3913SQX-AA | 2.0V | 3.3V | 1.2V  | 3.3V  | 3.3V  | 100mA             |

## Pin Descriptions

| Name                 | I/O | Type       | Functional Description  | Pin # |
|----------------------|-----|------------|---|-------|
| TS                   | I   | A          | Battery temperature sense pin. This pin is normally connected to the thermistor pin of the battery cell.  | 1     |
| VBATT1               | O   | A          | Positive battery terminal. This pin must be externally shorted to VBATT2 and VBATT3   | 2     |
| AGND                 | G   | G          | Analog Ground   | 3     |
| VREFH                | O   | A          | Connection to bypass capacitor for internal high reference  | 4     |
| LDO2EN               | I   | D          | Digital input to enable/disable LDO2  | 5     |
| VLDO2                | O   | A          | LDO2 Output   | 6     |
| VIN1                 | I   | PWR        | Power input to LDO1 and LDO2. VIN1 pin must be externally shorted to the VDD pins.  | 7     |
| VLDO1                | O   | A          | LDO1 Output   | 8     |
| POWERACK             | I   | D          | Digital power acknowledgement input (see Power Sequencing)  | 9     |
| ISENSE               | I   | A          | A 4.64 k $\Omega$ resistor must be connected between this pin and GND. A fraction of the charge current flows through this resistor to enable the A to D converter to measure the charge current. | 10    |
| ADC2                 | I   | A          | Channel 2 input to AD converter   | 11    |
| ADC1                 | I   | A          | Channel 1 input to AD converter   | 12    |
| IRQB                 | O   | Open Drain | Open drain active low interrupt request   | 13    |
| NRST                 | O   | Open Drain | Open drain active low reset during Standby  | 14    |
| CHG                  | O   | D          | This output indicates that a valid charger supply source (USB adapter) has been detected, and the IC is charging. (Red LED)   | 15    |
| STAT                 | O   | D          | Battery Status output indicator - Off during CC, 50% duty cycle during CV, 100% duty cycle with a fully charged Li-ion battery (Green LED)  | 16    |
| BUCK1EN              | I   | D          | Digital input to enable/disable BUCK1   | 17    |
| VFB1                 | I   | A          | Buck1 Feedback input terminal   | 18    |
| BCKGND1              | G   | G          | Buck1 Ground  | 19    |
| VBUCK1               | O   | A          | Buck1 Output  | 20    |
| VIN2                 | I   | PWR        | Power input to BUCK1. VIN2 pin must be externally shorted to the VDD pins.  | 21    |
| VIN3                 | I   | PWR        | Power input to BUCK2. VIN3 pin must be externally shorted to the VDD pins.  | 22    |
| VBUCK2               | O   | A          | Buck2 Output  | 23    |
| BCKGND2              | G   | G          | Buck2 Ground  | 24    |
| VFB2                 | I   | A          | Buck2 Feedback input terminal   | 25    |
| ONOFF                | I   | D          | Power ON/OFF pin configured either as level (High or Low) triggered or edge (High or Low) triggered.  | 26    |
| I <sup>2</sup> C_SCL | I   | D          | I <sup>2</sup> C compatible interface clock terminal  | 27    |
| VDDIO                | I   | D          | Supply to input / output stages of digital I/O  | 28    |
| I <sup>2</sup> C_SDA | I/O | D          | I <sup>2</sup> C compatible interface data terminal   | 29    |
| ONSTAT               | O   | Open Drain | Open Drain output that reflects the debounced state of ONOFF pin.   | 30    |
| VFB3                 | I   | A          | Buck3 Feedback input terminal   | 31    |
| VBUCK3               | O   | A          | Buck3Output voltage   | 32    |
| VBUCK3L2             | I   | A          | Buck3 inductor  | 33    |
| BCK3GND1             | G   | G          | Buck3t high current ground  | 34    |
| VBUCK3L1             | I   | A          | Buck3 inductor  | 35    |
| VIN4                 | I   | PWR        | Power input to Buck3. VIN4 pin must be externally shorted to the VDD pins.  | 36    |
| USBSUSP              | I   | D          | This pin needs to be pulled high during USB suspend mode.   | 37    |
| USBISEL              | I   | D          | Pulling this pin low limits the USB charge current to 100 mA. Pulling this pin high limits the USB charge current to 500 mA.  | 38    |
| BUCK3GND2            | G   | G          | Buck3 Core Ground   | 39    |
| DGND                 | G   | G          | Digital ground  | 40    |

| Name    | I/O | Type | Functional Description  | Pin # |
|---------|-----|------|---|-------|
| VDD3    | I   | PWR  | Power input to supply application. This pin must be externally shorted to VDD1 and VDD2.  | 41    |
| VDD2    | I   | PWR  | Power input to supply application This pin must be externally shorted to VDD1 and VDD3.   | 42    |
| VBATT3  | O   | A    | Positive battery terminal. This pin must be externally shorted to VBATT1 and VBATT2.  | 43    |
| VBATT2  | O   | A    | Positive battery terminal. This pin must be externally shorted to VBATT1 and VBATT3.  | 44    |
| USBPWR  | I   | PWR  | USB power input pin   | 45    |
| VDD1    | I   | PWR  | Power input to supply application This pin is shorted to VDD2 and VDD3.   | 46    |
| CHG_DET | I   | A    | Wall adapter power input pin  | 47    |
| IREF    | I   | A    | A 121 k $\Omega$ resistor must be connected between this pin and AGND. The resistor value determines the reference current for the internal bias generator. | 48    |

## Absolute Maximum Ratings (Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

|  |                    |
|--|--------------------|
| Supply voltage range CHG_DET   | -0.3V to +6.5V     |
| Voltage range USBPWR,<br>VIN1, VIN2, VIN3, VIN4,<br>VDD1, VDD2, VDD3 | -0.3V to +6.2V     |
| Battery voltage range VBATT1, 2, 3                                   | -0.3V to +5V       |
| All other pins   | -0.3V to VDD +0.3V |
| Storage Temperature Range  | -45°C to +150°C    |
| Power Dissipation ( $T_A = 70^\circ\text{C}$ (Note 3)):              | 2.6W               |
| ESD Rating (Note 4)  |                    |
| Human Body Model:  | 2.0 kV             |
| Machine Model:   | 200V               |

## Operating Ratings (Notes 6, 7, 10)

|   |                 |
|---|-----------------|
| CHG_DET   | 4.5V to 6.0V    |
| USBPWR  | 4.35V to 6.0V   |
| VBATT1, 2, 3                                    | 0V to 4.5V      |
| VIN1, VIN2, VIN3, VIN4, VDD1,<br>VDD2, VDD3     | 2.5V to 6.0V    |
| VDDIO   | 2.5V to VDD     |
| Junction Temperature ( $T_J$ ) Range            | -40°C to +125°C |
| Ambient Temperature ( $T_A$ ) Range             | -40°C to +85°C  |
| Power Dissipation for $T_{JMAX}$ and $T_{AMAX}$ | 1.6W            |

## Thermal Information

|   |        |
|---|--------|
| Junction-to-Ambient Thermal Resistance ( $\theta_{JA}$ ),<br>48-pin LLP SQF48A Package (Note 7) | 25°C/W |
|---|--------|

## Electrical Characteristics

### General Electrical Characteristics

Unless otherwise noted, VDD = 5V, VBATT = 3.6V. Typical values and limits appearing in normal type apply for  $T_J = 25^\circ\text{C}$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $T_J = 0^\circ\text{C}$  to +125°C. (Notes 2, 7, 8, 9)

| Symbol         | Parameter                       | Conditions  | Min | Typ | Max       | Units            |
|----------------|---------------------------------|---|-----|-----|-----------|------------------|
| $I_{Q\_BATT}$  | Battery Standby Supply Current  | All circuits off except for POR and battery monitor. No adapter or USB power connected. |     | 6   | <b>20</b> | $\mu\text{A}$    |
| $V_{POR}$      | Power-On Reset Threshold        | VDD Falling Edge  |     | 1.9 |           | V                |
| $T_{SD}$       | Thermal Shutdown Threshold      |   |     | 160 |           | $^\circ\text{C}$ |
| $T_{SDH}$      | Thermal Shutdown Hysteresis     |   |     | 20  |           | $^\circ\text{C}$ |
| $T_{TH-ALERT}$ | Thermal Interrupt Threshold     |   |     | 115 |           | $^\circ\text{C}$ |
| VDDIO          | IO Supply                       |   | 2.5 |     | $V_{DD}$  | V                |
| $F_{CLK}$      | Internal System Clock Frequency |   |     | 2   |           | MHz              |

### I<sup>2</sup>C Interface Electrical Characteristics

Unless otherwise noted, VDDIO = 3.6V. Typical values and limits appearing in normal type apply for  $T_J = 25^\circ\text{C}$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $T_J = 0^\circ\text{C}$  to +125°C. (Notes 2, 7, 8, 9)

| Symbol          | Parameter                            | Conditions                                     | Min             | Typ | Max             | Units         |
|-----------------|--------------------------------------|--|-----------------|-----|-----------------|---------------|
| $V_{IL}$        | Low Level Input Voltage              | I <sup>2</sup> C_SDA &<br>I <sup>2</sup> C_SCL |                 |     | <b>0.3VDDIO</b> | V             |
| $V_{IH}$        | High Level Input Voltage             | I <sup>2</sup> C_SDA &<br>I <sup>2</sup> C_SCL | <b>0.7VDDIO</b> |     |                 | V             |
| $V_{OL}$        | Low Level Output Voltage             | I <sup>2</sup> C_SDA &<br>I <sup>2</sup> C_SCL | <b>0</b>        |     | <b>0.2VDDIO</b> | V             |
| $V_{HYS}$       | Schmitt Trigger Input Hysteresis     | I <sup>2</sup> C_SDA &<br>I <sup>2</sup> C_SCL | <b>0.1VDDIO</b> |     |                 | V             |
| $F_{CLK}$       | Clock Frequency                      |  |                 |     | <b>400</b>      | kHz           |
| $t_{BF}$        | Bus-Free Time between START and STOP | (Note 9)                                       | <b>1.3</b>      |     |                 | $\mu\text{s}$ |
| $t_{HOLD}$      | Hold Time Repeated START Condition   | (Note 9)                                       | <b>0.6</b>      |     |                 | $\mu\text{s}$ |
| $t_{CLK-LP}$    | CLK Low Period                       | (Note 9)                                       | <b>1.3</b>      |     |                 | $\mu\text{s}$ |
| $t_{CLK-HP}$    | CLK High Period                      | (Note 9)                                       | <b>0.6</b>      |     |                 | $\mu\text{s}$ |
| $t_{SU}$        | Set-up Time Repeated START Condition | (Note 9)                                       | <b>0.6</b>      |     |                 | $\mu\text{s}$ |
| $t_{DATA-HOLD}$ | Data Hold Time                       | (Note 9)                                       | <b>0</b>        |     |                 | $\mu\text{s}$ |
| $t_{DATA-SU}$   | Data Set-up Time                     | (Note 9)                                       | <b>100</b>      |     |                 | ns            |

| Symbol      | Parameter   | Conditions | Min        | Typ | Max | Units   |
|-------------|---|------------|------------|-----|-----|---------|
| $t_{SU}$    | Set-Up Time for STOP Condition  | (Note 9)   | <b>0.6</b> |     |     | $\mu s$ |
| $t_{TRANS}$ | Maximum Pulse Width of Spikes That Must Be Suppressed by the Input Filter of Both Data and CLK Signals. | (Note 9)   | 50         |     |     | $\mu s$ |

## Li-Ion Battery Charger Electrical Characteristics

Unless otherwise noted, VDD = 5.0V, VBATT = 3.6V, C<sub>BATT</sub> = 4.7  $\mu F$ , C<sub>CHG\_DET</sub> = 10  $\mu F$ , R<sub>IREF</sub> = 121 k $\Omega$ . Typical values and limits appearing in normal type apply for T<sub>J</sub> = 25°C. Limits appearing in **boldface type** apply over the entire junction temperature range for operation, T<sub>J</sub> = 0°C to +125°C. (Notes 2, 6, 7, 8, 10)

| Symbol                 | Parameter  | Conditions  | Min                                     | Typ                   | Max                                     | Units   |
|------------------------|--|---|---|-----------------------|---|---------|
| V <sub>USB</sub>       | Minimum External USB Supply Soltage  | USB Current Limit = 500 mA  | 4.15                                    | 4.25                  | 4.35                                    | V       |
| V <sub>USB_HYST</sub>  | USBPWR Detect Hysteresis   |   |   | 50                    |   | mV      |
| CHG_DET                | Minimum External Adapter Supply Voltage Range  | Adapter Current Limit = 1A<br>V <sub>FWD</sub> Schottky = 350 mV                                      | 4.4                                     | 4.5                   | 4.6                                     | V       |
| V <sub>CHG_HYST</sub>  | CHG_DET Input Hysteresis   |   |   | 150                   |   | mV      |
| I <sub>USB_SUSP</sub>  | Quiescent Current in USB Suspend Mode  | USB Suspend Mode,<br>V <sub>USB</sub> = 5.0V<br>USBSUSP = USBPWR<br>USBISEL = 0V                      |   | 30                    | <b>60</b>                               | $\mu A$ |
| V <sub>TERM_TOL</sub>  | Battery Charge Termination Voltage Tolerance   | T <sub>A</sub> = 25°C,<br>I <sub>PROG</sub> = 500 mA<br>I <sub>CHG</sub> = 50 mA                      | -0.35<br>-0.5<br>-0.5                   | 4.2V<br>4.1V<br>4.38V | +0.35<br>+0.5<br>+0.5                   | %       |
|                        |  | T <sub>A</sub> = 0°C to 125°C,<br>I <sub>PROG</sub> = 500 mA,<br>I <sub>CHG</sub> = 50 mA             | <b>-1</b><br><b>-1.5</b><br><b>-1.5</b> | 4.2V<br>4.1V<br>4.38V | <b>+1</b><br><b>+1.5</b><br><b>+1.5</b> |         |
| I <sub>CHG_WA</sub>    | Full-rate Charging Current from Wall Adapter Input (See Full-rate Charging Mode Description) | CHG_DET = 5.25V<br>V <sub>BATT</sub> = 3.6V<br>I <sub>PROG</sub> = 500 mA                             | <b>450</b>                              | 500                   | <b>550</b>                              | mA      |
| I <sub>CHG_USB</sub>   | Full-rate Charging Current from USBPWR Input (See Full-rate Charging Mode Description)       | USB = 5V<br>V <sub>BATT</sub> = 3.6V<br>I <sub>PROG</sub> = 500 mA<br>USB_ISEL = 800 mA               | <b>450</b>                              | 500                   | <b>550</b>                              | mA      |
|                        |  | USB = 5V<br>V <sub>BATT</sub> = 3.6V<br>I <sub>PROG</sub> = 500 mA<br>USB_ISEL = 500 mA               | <b>405</b>                              | 450                   | <b>495</b>                              | mA      |
| USB I <sub>LIMIT</sub> |  | USB_ISEL = 100 mA   | <b>90</b>                               | 95                    | <b>100</b>                              | mA      |
|                        |  | USB_ISEL = 500 mA   | <b>450</b>                              | 475                   | <b>500</b>                              |         |
|                        |  | USB_ISEL = 800 mA   | <b>720</b>                              | 760                   | <b>800</b>                              |         |
| I <sub>PREQUAL</sub>   | Pre-qualification Current  | V <sub>BATT</sub> = 2.5V, Wall Adapter Charge Current.<br>Percentage of Programmed Full Rate Current. | <b>8</b>                                | 10                    | <b>12</b>                               | %       |
|                        |  | V <sub>BATT</sub> = 2.5V, USB Charge Current  | <b>40</b>                               | 50                    | <b>60</b>                               | mA      |
| V <sub>FULL_RATE</sub> | Full-rate Qualification Threshold  | V <sub>BATT</sub> Rising, Transition from Pre-Qualification to Full-rate Charging                     | <b>2.75</b>                             | 2.85                  | <b>2.95</b>                             | V       |
| V <sub>TH_H</sub>      | Upper T <sub>S</sub> Comparator Limit  |   | <b>2.82</b>                             | 2.87                  | <b>2.93</b>                             | V       |
| V <sub>TH_L</sub>      | Lower T <sub>S</sub> Comparator Limit  | 45°C CHSPV Reg D3 = 0   | <b>0.315</b>                            | 0.33                  | <b>0.345</b>                            | V       |
|                        |  | 50°C CHSPV Reg D3 = 1   | <b>0.255</b>                            | 0.27                  | <b>0.285</b>                            |         |
| I <sub>TSENSE</sub>    | Battery Temperature Sense Current  |   | <b>7.75</b>                             | 8.00                  | <b>8.25</b>                             | $\mu A$ |
| T <sub>REG</sub>       | Regulated Charger Junction Temperature   |   | 105                                     | 115                   | 125                                     | °C      |

## Detection and Timing

| Symbol                | Parameter   | Conditions  | Min                  | Typ                   | Max                  | Units |
|-----------------------|---|---|----------------------|-----------------------|----------------------|-------|
| I <sub>EOC</sub>      | End-of-Charge Current   | I <sub>PROG</sub> = 500 mA,<br>10% EOC Setting                                    | 40                   | 50                    | 60                   | mA    |
|                       |   | I <sub>PROG</sub> = 500 mA<br>5% EOC Setting                                      | 20                   | 25                    | 30                   | mA    |
| V <sub>RESTARTI</sub> | Battery Restart Charging Voltage  | V <sub>TERM</sub> = 4.1V<br>V <sub>TERM</sub> = 4.2V<br>V <sub>TERM</sub> = 4.38V | 3.82<br>3.94<br>4.14 | 3.9V<br>4.0V<br>4.2 V | 3.94<br>4.06<br>4.26 | V     |
| T <sub>CHG_IN</sub>   | Deglitch Adapter Insertion  |   | 28                   | 32                    | 36                   | ms    |
| T <sub>USB</sub>      | Deglitch USB Power Insertion  |   | 28                   | 32                    | 36                   | ms    |
| T <sub>PQ_FULL</sub>  | Deglitch Time for Pre-qualification to Full-rate Charge Transition              |   | 8                    | 10                    | 12                   | ms    |
| T <sub>FULL_PQ</sub>  | Deglitch Time for Full-rate to Pre-qualification Transition                     |   | 8                    | 10                    | 12                   | ms    |
| T <sub>BATLOWF</sub>  | Deglitch Time for V <sub>BATT</sub> Falling below V <sub>BATLOW</sub> Threshold |   | 4                    | 5                     | 6                    | ms    |
| T <sub>BATLOWR</sub>  | Deglitch Time for V <sub>BATT</sub> Rising above V <sub>BATLOW</sub> Threshold  |   | 4                    | 5                     | 6                    | ms    |
| T <sub>BATTEMP</sub>  | Deglitch Time for Recovery from Battery Temperature Fault                       |   | 8                    | 10                    | 12                   | ms    |
| T <sub>ONOFF_F</sub>  | Deglitching on Falling Edge of ONOFF Pin  |   | 28                   | 32                    | 36                   | ms    |
| T <sub>ONOFF_R</sub>  | Deglitching on Rising Edge of ONOFF Pin   |   | 28                   | 32                    | 36                   | ms    |
| T <sub>RESTART</sub>  | Deglitching on Falling V <sub>BATT</sub> Crossing V <sub>RESTART</sub>          |   | 8                    | 10                    | 12                   | ms    |
| T <sub>CCCV</sub>     | Deglitching of CC->CV Charging Transition                                       |   | 8                    | 10                    | 12                   | ms    |
| T <sub>CVEOC</sub>    | Deglitching of CV->EOC (End of Charge)  |   | 8                    | 10                    | 12                   | ms    |
| T <sub>POWERACK</sub> | Deglitching of POWERACK Pin   |   | 4                    | 5                     | 6                    | ms    |
| T <sub>TSHD</sub>     | Deglitching of Thermal Shutdown   |   |                      | 2                     |                      | ms    |
| T <sub>TOPOFF</sub>   | Topoff Timer  |   | 17                   | 21                    | 25                   | min   |
| T <sub>10HR</sub>     | 10 Hour Safety Timer  |   | 9                    | 10                    | 11                   | hours |
| T <sub>1HR</sub>      | 1 Hour Prequal Safety Timer   |   | 0.9                  | 1                     | 1.1                  | hour  |

## Outputs Electrical Characteristics: CHG, STAT

Unless otherwise noted, V<sub>DD</sub> = 5V, V<sub>BATT</sub> = 3.6V. C<sub>BATT</sub> = 4.7 μF, C<sub>CHG\_DET</sub> = 10 μF. Typical values and limits appearing in normal type apply for T<sub>J</sub> = 25°C. Limits appearing in **boldface type** apply over the entire junction temperature range for operation, T<sub>J</sub> = 0°C to +125°C. (Notes 2, 6, 7, 8, 10)

| Symbol               | Parameter          | Conditions  | Min | Typ | Max | Units |
|----------------------|--------------------|---|-----|-----|-----|-------|
| I <sub>LED</sub>     | Output High Level  | V <sub>LED</sub> = 2.0V<br>CHSPV Register (02)h bit 5 = 1 | 4   | 5   | 6   | mA    |
| I <sub>LED</sub>     | Output High Level  | V <sub>LED</sub> = 2.0V<br>CHSPV Register (02)h bit 5 = 0 | 8   | 10  | 12  | mA    |
| I <sub>LEAKAGE</sub> | Leakage Current    | V <sub>LED</sub> = 1.5V, LED off                          |     | 0.1 | 5   | μA    |
| LED <sub>FREQ</sub>  | Blinking Frequency |   | 0.8 | 1   | 1.2 | Hz    |

## Outputs Electrical Characteristics: NRST, IRQB, ONSTAT

Unless otherwise noted,  $V_{DD} = 5V$ ,  $V_{BATT} = 3.6V$ .  $C_{BATT} = 4.7 \mu F$ ,  $C_{CHG\_DET} = 10 \mu F$ . Typical values and limits appearing in normal type apply for  $T_J = 25^\circ C$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $T_J = 0^\circ C$  to  $+125^\circ C$ . (Notes 2, 6, 7, 8, 10)

| Symbol        | Parameter        | Conditions                          | Min       | Typ | Max        | Units   |
|---------------|------------------|-------------------------------------|-----------|-----|------------|---------|
| $V_{OL}$      | Output Low Level | $I_{OL} = 4 \text{ mA}$             |           |     | <b>0.4</b> | V       |
| $I_{LEAKAGE}$ | Leakage Current  | $V_{DD} = 2.5V$ , Output Logic High | <b>-1</b> |     | <b>1</b>   | $\mu A$ |

## Inputs Electrical Characteristics: USBSUSP, USBISEL

Unless otherwise noted,  $V_{USB} = 5V$ ,  $V_{BATT} = 3.6V$ .  $C_{BATT} = 4.7 \mu F$ ,  $C_{CHG\_DET} = 10 \mu F$ . Typical values and limits appearing in normal type apply for  $T_J = 25^\circ C$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $T_J = 0^\circ C$  to  $+125^\circ C$ . (Notes 2, 6, 7, 8, 10)

| Symbol        | Parameter        | Conditions | Min                                   | Typ | Max                                   | Units   |
|---------------|------------------|------------|---------------------------------------|-----|---------------------------------------|---------|
| $V_{IL}$      | Input Low Level  |            |                                       |     | <b><math>0.3 \cdot V_{USB}</math></b> | V       |
| $V_{IH}$      | Input High Level |            | <b><math>0.7 \cdot V_{USB}</math></b> |     |                                       | V       |
| $I_{LEAKAGE}$ | Input Leakage    |            | <b>-1</b>                             |     | <b>1</b>                              | $\mu A$ |

## Inputs Electrical Characteristics: POWERACK, ONOFF, LDO2EN, BUCK1EN

Unless otherwise noted,  $V_{DD} = 5V$ ,  $V_{BATT} = 3.6V$ .  $C_{BATT} = 4.7 \mu F$ ,  $C_{CHG\_IN} = 10 \mu F$ . Typical values and limits appearing in normal type apply for  $T_J = 25^\circ C$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $T_J = 0^\circ C$  to  $+125^\circ C$ . (Notes 2, 6, 7, 8, 10)

| Symbol        | Parameter        | Conditions | Min        | Typ | Max        | Units   |
|---------------|------------------|------------|------------|-----|------------|---------|
| $V_{IL}$      | Input Low Level  |            |            |     | <b>0.4</b> | V       |
| $V_{IH}$      | Input High Level |            | <b>1.4</b> |     |            | V       |
| $I_{LEAKAGE}$ | Input Leakage    |            | <b>-1</b>  |     | <b>1</b>   | $\mu A$ |

## LDO1: Low Drop Out Linear Regulators

Unless otherwise noted,  $V_{IN1} = 3.6V$ ,  $I_{MAX} = 150 \text{ mA}$ ,  $V_{OUT} = \text{Default Value}$ ,  $C_{VDD} = 10 \mu F$ ,  $C_{LDO1} = 1.0 \mu F$ ,  $ESR = 5 \text{ m}\Omega$ – $500 \text{ m}\Omega$ ,  $C_{VREFH} = 100 \text{ nF}$ . Typical values and limits appearing in normal type apply for  $T_J = 25^\circ C$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $0^\circ C$  to  $+125^\circ C$ .

| Symbol             | Parameter                        | Conditions   | Min        | Typ | Max        | Units    |
|--------------------|----------------------------------|--|------------|-----|------------|----------|
| $V_{IN1}$          | Operational Voltage Range        |  | <b>2.5</b> |     | <b>6.0</b> | V        |
| $V_{OUT}$ Range    | Output Voltage Programming Range | $T_A = 25^\circ C$<br>1.2V–3.3V in 100 mV Steps  | 1.2        |     | 3.3        | V        |
| $V_{OUT}$ Accuracy | Output Voltage Accuracy          | $1 \text{ mA} \leq I_{OUT} \leq I_{MAX}$ , Over Full Line and Load Regulation.<br>$V_{OUT} = \text{Default Value}$ . | <b>-3</b>  |     | <b>3</b>   | %        |
| $\Delta V_{OUT}$   | Line Regulation                  | $V_{IN} = (V_{OUT} + 500 \text{ mV})$ to $5.5V$ ,<br>Load Current = $I_{MAX}$  |            | 3   |            | mV       |
|                    | Load Regulation                  | $V_{IN} = 3.6V$ ,<br>Load Current = $1 \text{ mA}$ to $I_{MAX}$  |            | 10  |            | mV       |
| $I_{SC}$           | Short Circuit Current Limit      | $V_{OUT} = 0V$   | <b>600</b> | 750 |            | mA       |
| $V_{IN} - V_{OUT}$ | Dropout Voltage                  | Load Current = $I_{MAX}$   |            | 60  | <b>150</b> | mV       |
| PSRR               | Power Supply Ripple Rejection    | $F = 10 \text{ kHz}$ , Load Current = $I_{MAX}$  |            | 30  |            | dB       |
| $R_{SHUNT}$        | LDO Output Impedance             | LDO Disabled, $V_{OUT} = \text{Default Value}$   |            |     | <b>200</b> | $\Omega$ |

## LDO2: Low Drop Out Linear Regulator

Unless otherwise noted  $V_{IN1} = 3.6V$ ,  $I_{MAX} = 150\text{ mA}$ ,  $V_{OUT} = \text{Default Value}$ ,  $C_{VDD} = 10.0\text{ }\mu\text{F}$ ,  $C_{LDO2} = 1.0\text{ }\mu\text{F}$ ,  $ESR = 5\text{ m}\Omega - 500\text{ m}\Omega$ ,  $C_{VREFH} = 100\text{ nF}$ . Typical values and limits appearing in normal type apply for  $T_J = 25^\circ\text{C}$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $0^\circ\text{C}$  to  $+125^\circ\text{C}$ .

| Symbol                             | Parameter   | Conditions  | Min        | Typ | Max        | Units            |
|------------------------------------|---|---|------------|-----|------------|------------------|
| VIN2                               | Operational Voltage Range                           |   | <b>2.5</b> |     | <b>6.0</b> | V                |
| V <sub>OUT</sub> Range             | Output Voltage Programming Range                    | $T_A = 25^\circ\text{C}$<br>1.3V–3.3V in 100 mV Steps                         | 1.3        |     | 3.3        | V                |
| V <sub>OUT</sub> Accuracy          | Output Voltage Accuracy (Default V <sub>OUT</sub> ) | $1\text{ mA} \leq I_{OUT} \leq I_{MAX}$ , Over Full Line and Load Regulation. | <b>-3</b>  |     | <b>3</b>   | %                |
| $\Delta V_{OUT}$                   | Line Regulation                                     | $V_{IN} = (V_{OUT} + 500\text{ mV})$ to 5.5V, Load Current = $I_{MAX}$        |            | 3   |            | mV               |
|                                    | Load Regulation                                     | $V_{IN} = 3.6V$ , Load Current = 1 mA to $I_{MAX}$                            |            | 10  |            | mV               |
| I <sub>SC</sub>                    | Short Circuit Current Limit                         | $V_{OUT} = 0V$  | <b>600</b> | 750 |            | mA               |
| V <sub>IN</sub> – V <sub>OUT</sub> | Dropout Voltage                                     | Load Current = $I_{MAX}$  |            | 60  | <b>150</b> | mV               |
| PSRR                               | Power Supply Ripple Rejection                       | F = 1 kHz, Load Current = $I_{MAX}$   |            | 50  |            | dB               |
|                                    |   | F = 10 kHz, Load Current = $I_{MAX}$  |            | 35  |            |                  |
| e <sub>N</sub>                     | Analog Supply Output Noise Voltage                  | 10 Hz < F < 100 kHz   |            | 50  |            | $\mu\text{Vrms}$ |
| R <sub>SHUNT</sub>                 | LDO Output Impedance                                | LDO Disabled, $V_{OUT} = \text{Default Value}$                                |            |     | <b>200</b> | $\Omega$         |

## BUCK1 Converter Electrical Characteristics

Unless otherwise noted,  $V_{IN2} = 3.6\text{ V}$ ,  $V_{OUT} = \text{default value}$ ,  $C_{VIN2} = 10\text{ }\mu\text{F}$ ,  $C_{SW1} = 10\text{ }\mu\text{F}$ ,  $L_{SW1} = 2.2\text{ }\mu\text{H}$  Typical values and limits appearing in normal type apply for  $T_J = 25^\circ\text{C}$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $0^\circ\text{C}$  to  $+125^\circ\text{C}$ . Modulation mode is PWM mode with automatic switch to PFM at light loads.

| Symbol                 | Parameter                        | Conditions   | Min        | Typ   | Max         | Units         |
|------------------------|----------------------------------|--|------------|-------|-------------|---------------|
| VIN2                   | Input Voltage                    |  | <b>2.7</b> |       | <b>6.0</b>  | V             |
| V <sub>OUT</sub> Range | Output Voltage Programming Range | 0.80V–2.00V in 50 mV Steps                                     | 0.8        |       | 2.0         | V             |
| $\Delta V_{OUT}$       | Static Output Voltage Tolerance  | $I_{OUT} = 200\text{ mA}$ , Including Line and Load Regulation | <b>-3</b>  |       | <b>3</b>    | %             |
|                        | Line Regulation                  | $I_{OUT} = 10\text{ mA}$<br>$V_{IN2} = 2.5V - V_{DD}$          |            | 0.2   |             | %/V           |
|                        | Load Regulation                  | $100\text{ mA} < I_{OUT} < 300\text{ mA}$                      |            | 0.002 |             | %/mA          |
| I <sub>OUT</sub>       | Continuous Output Current        |  | <b>600</b> |       |             | mA            |
|                        | Peak Output Current Limit        |  | <b>850</b> | 1000  | <b>1150</b> | mA            |
| I <sub>PFM</sub>       | Max I <sub>LOAD</sub> , PFM Mode |  |            | 75    |             | mA            |
| I <sub>Q</sub>         | Quiescent Current                | $I_{OUT} = 0\text{ mA}$  |            | 30    | <b>90</b>   | $\mu\text{A}$ |
|                        |                                  | Buck1 Disabled   |            |       | <b>1</b>    |               |
| F <sub>OSC</sub>       | Internal Oscillator Frequency    | PWM Mode   |            | 2     |             | MHz           |
| $\eta$                 | Peak Efficiency                  |  |            | 90    |             | %             |
| T <sub>ON</sub>        | Turn-on Time                     | To 95% Level (Note 9)  |            |       | <b>1</b>    | ms            |

## BUCK2 Converter Electrical Characteristics

Unless otherwise noted,  $V_{IN3} = 3.6V$ ,  $V_{OUT} = \text{default value}$ ,  $C_{VIN3} = 10\text{ }\mu\text{F}$ ,  $C_{SW1} = 10\text{ }\mu\text{F}$ ,  $L_{SW2} = 2.2\text{ }\mu\text{H}$  Typical values and limits appearing in normal type apply for  $T_J = 25^\circ\text{C}$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $0^\circ\text{C}$  to  $+125^\circ\text{C}$ . Modulation mode is PWM mode with automatic switch to PFM at light loads.

| Symbol                 | Parameter                        | Conditions                  | Min        | Typ | Max        | Units |
|------------------------|----------------------------------|-----------------------------|------------|-----|------------|-------|
| VIN3                   | Input Voltage                    |                             | <b>2.7</b> |     | <b>6.0</b> | V     |
| V <sub>OUT</sub> Range | Output Voltage Programming Range | 1.80V–3.30V in 100 mV Steps | 1.8        |     | 3.3        | V     |

| Symbol           | Parameter                       | Conditions   | Min        | Typ   | Max         | Units   |
|------------------|---------------------------------|--|------------|-------|-------------|---------|
| $\Delta V_{OUT}$ | Static Output Voltage Tolerance | $I_{OUT} = 200$ mA, Including Line and Load Regulation | <b>-3</b>  |       | <b>3</b>    | %       |
|                  | Line Regulation                 | $I_{OUT} = 10$ mA<br>$V_{IN3} = 2.5V - V_{DD}$         |            | 0.2   |             | %/V     |
|                  | Load Regulation                 | $100$ mA < $I_{OUT}$ < $300$ mA                        |            | 0.002 |             | %/mA    |
| $I_{OUT}$        | Continuous Output Current       |  | <b>600</b> |       |             | mA      |
|                  | Peak Output Current Limit       |  | <b>850</b> | 1000  | <b>1150</b> | mA      |
| $I_{PFM}$        | Max $I_{LOAD}$ , PFM Mode       |  |            | 75    |             | mA      |
| $I_Q$            | Quiescent Current               | $I_{OUT} = 0$ mA                                       |            | 30    | <b>90</b>   | $\mu$ A |
|                  |                                 | Buck2 Disabled   |            |       | <b>1</b>    |         |
| $F_{OSC}$        | Internal Oscillator Frequency   | PWM Mode   |            | 2     |             | MHz     |
| $\eta$           | Peak Efficiency                 |  |            | 90    |             | %       |
| $T_{ON}$         | Turn-on Time                    | To 95% Level (Note 9)                                  |            |       | <b>1</b>    | ms      |

## BUCK3 Electrical Characteristics

Unless otherwise noted,  $V_{IN4} = 3.6V$ ,  $C_{VIN4} = 10$   $\mu$ F,  $C_{BB} = 22$   $\mu$ F,  $L_{BB} = 2.2$   $\mu$ H Typical values and limits appearing in normal type apply for  $T_J = 25^\circ C$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $0^\circ C$  to  $+125^\circ C$ . Modulation mode is PWM mode with automatic switch to PFM at light loads.

| Symbol           | Parameter                        | Conditions  | Min        | Typ    | Max         | Units   |
|------------------|----------------------------------|---|------------|--------|-------------|---------|
| $V_{IN4}$        | Input Voltage                    | $I_{OUTMAX} = 500$ mA                                       | <b>2.7</b> |        | <b>5.7</b>  | V       |
| $V_{OUT}$ Range  | Output Voltage Programming Range | 1.80V – 3.30V in 50 mV Steps                                | 1.8        |        | 3.3         | V       |
| $\Delta V_{OUT}$ | Static Output Voltage Tolerance  | $I_{OUT} = 0$ mA–500 mA, Including Line and Load Regulation | <b>-4</b>  |        | <b>4</b>    | %       |
|                  | Line Regulation                  | $I_{OUT} = 10$ mA   |            | 0.2    |             | %/V     |
|                  | Load Regulation                  | $100$ mA < $I_{OUT}$ < $500$ mA                             |            | 0.0016 |             | %/mA    |
| $I_{OUT}$        | Continuous Output Current        |   | <b>500</b> |        |             | mA      |
|                  | Peak Inductor Current Limit      | $V_{OUT} = 3.3V$<br>1A Load at $V_{IN} = 2.7V$              | <b>900</b> |        | <b>1200</b> | mA      |
| $I_{PFM}$        | Max $I_{LOAD}$ , PFM Mode        |   |            | 75     |             | mA      |
| $I_Q$            | Quiescent Current                | $I_{OUT} = 0$ mA PFM No Switching                           |            | 80     |             | $\mu$ A |
|                  |                                  | Buck3 Disabled  |            |        | <b>1</b>    |         |
| $F_{OSC}$        | Internal Oscillator Frequency    | PWM Mode  |            | 2      |             | MHz     |
| $\eta$           | Peak Efficiency                  |   |            | 93     |             | %       |
| $T_{ON}$         | Turn-on Time                     | To 95% Level (Note 9)                                       |            |        | <b>1</b>    | ms      |

## ADC Electrical Characteristics

External components:

| Symbol              | Parameter                               | Conditions                        | Min          | Typ   | Max               | Units |
|---------------------|---|-----------------------------------|--------------|-------|-------------------|-------|
| $V_{REF}$           | Reference Voltage                       | $T = 25^\circ C$                  | 1.220        | 1.225 | 1.230             | V     |
|                     |   | $T = 0^\circ C$ to $+125^\circ C$ | <b>1.200</b> | 1.225 | <b>1.230</b>      | V     |
| INL                 | Core ADC Integral Non-linearity         | $V_{REF} = 1.225$ (Note 9)        | -1           |       | 1                 | LSB   |
| DNL                 | Core ADC Differential Non-linearity     | $V_{REF} = 1.225$ (Note 9)        | -0.5         |       | 0.5               | LSB   |
| $V_{GP\_IN}$        | General Purpose ADC Input Voltage Range |                                   | $V_{REF}$    |       | $2 \cdot V_{REF}$ | V     |
| $V_{BATT, RANGE 0}$ | Battery Max Voltage Scalar Output       | $V_{BATT} = 3.5V$                 | 2.435        | 2.45  | 2.465             | V     |
|                     | Battery Min Voltage Scalar Output       | $V_{BATT} = 2.6V$                 | 1.217        | 1.225 | 1.232             | V     |
| $V_{BATT, RANGE 1}$ | Battery Max Voltage Scalar Output       | $V_{BATT} = 4.4V$                 | 2.435        | 2.45  | 2.465             | V     |
|                     | Battery Min Voltage Scalar Output       | $V_{REF} = 2.6V$                  | 1.217        | 1.225 | 1.232             | V     |

| Symbol                        | Parameter                             | Conditions   | Min   | Typ   | Max   | Units |
|-------------------------------|---------------------------------------|--|-------|-------|-------|-------|
| $V_{ISENSE}$                  | ISENSE Max Voltage Scalar Output      | $V_{ISENSE} = 0.6463V$<br>( $I_{CHG} = 0.605A$ ,<br>$R_{SENSE} = 4.64 k\Omega$ ) | 2.373 | 2.45  | 2.519 | V     |
| RANGE 0                       | ISENSE Min Voltage Scalar Output      | $V_{ISENSE} = 0V$<br>( $I_{CHG} = 0A$ ,<br>$R_{SENSE} = 4.64 k\Omega$ )          | 1.186 | 1.225 | 1.260 | V     |
| $V_{ISENSE}$                  | ISENSE Max Voltage Scalar Output      | $V_{ISENSE} = 1.175V$<br>( $I_{CHG} = 1.1A$ ,<br>$R_{SENSE} = 4.64 k\Omega$ )    | 2.373 | 2.45  | 2.519 | V     |
| RANGE 1                       | ISENSE Min Voltage Scalar Output      | $V_{ISENSE} = 0V$ ( $I_{CHG} = 0A$ ,<br>$R_{SENSE} = 4.64 k\Omega$ )             | 1.186 | 1.225 | 1.260 | V     |
| ADC1 &<br>ADC2 <sub>MIN</sub> | ADC1 & ADC2 Min Voltage Scalar Output | $V_{REFH} = 1.225$   | 1.218 | 1.225 | 1.230 | V     |
| ADC1 &<br>ADC2 <sub>MAX</sub> | ADC1 & ADC2 Max Voltage Scalar Output | $V_{REFH} = 1.225$   | 2.436 | 2.45  | 2.46  | V     |
| $t_{CONV}$                    | Conversion Time                       | (Note 9)   |       |       | 5     | ms    |
| $t_{WARM}$                    | Warm-up Time                          |  |       | 2     |       | ms    |

**Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the component may occur. Operating Ratings are conditions under which operation of the device is guaranteed. Operating Ratings do not imply guaranteed performance limits. For guaranteed performance limits and associated test conditions, see the Electrical Characteristics tables.

**Note 2:** All voltages are with respect to the potential at the GND pin.

**Note 3:** Internal thermal shutdown circuitry protects the device from permanent damage. Thermal shutdown engages at  $T_J = 160^\circ\text{C}$  (typ.) and disengages at  $T_J = 140^\circ\text{C}$  (typ.).

**Note 4:** The Human body model is a 100 pF capacitor discharged through a 1.5 k $\Omega$  resistor into each pin. The machine model is a 200 pF capacitor discharged directly into each pin. MIL-STD-883 3015.7.

**Note 5:** In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature ( $T_{A-MAX}$ ) is dependent on the maximum operating junction temperature ( $T_{J-MAX-OP} = 125^\circ\text{C}$ ), the maximum power dissipation of the device in the application ( $P_{D-MAX}$ ), and the junction-to-ambient thermal resistance of the part/package in the application ( $\theta_{JA}$ ), as given by the following equation:  $T_{A-MAX} = T_{J-MAX-OP} - (\theta_{JA} \times P_{D-MAX})$ .

**Note 6:** Junction-to-ambient thermal resistance is highly application and board-layout dependent. In applications where high maximum power dissipation exists, special care must be paid to thermal dissipation issues in board design.

**Note 7:** Min and Max limits are guaranteed by design, test, or statistical analysis. Typical numbers are not guaranteed, but do represent the most likely norm.

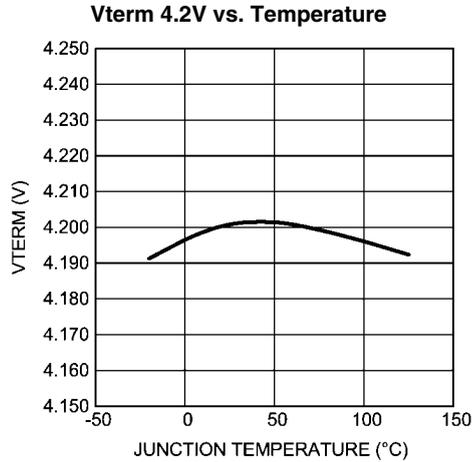
**Note 8:** Low ESR Surface-Mount Ceramic Capacitors (MLCCs) are used in setting electrical characteristics.

**Note 9:** Specifications guaranteed by design. Not tested during production.

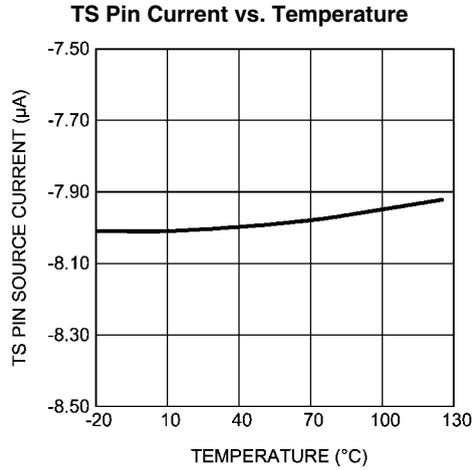
**Note 10:** Typical values and limits appearing in normal type for  $T_J = 25^\circ\text{C}$ . Limits appearing in **boldface type** apply over the entire junction temperature range for operation,  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ .

**Note 11:** LDO2EN, BUCK1EN, and USBSUSP have weak internal pull downs while pins POWERACK, ONOFF do not have this.

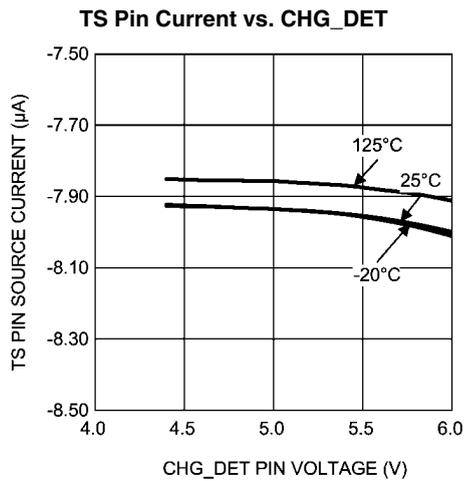
# Typical Performance Characteristics — Battery Charger $T_A = 25^\circ\text{C}$ unless otherwise noted



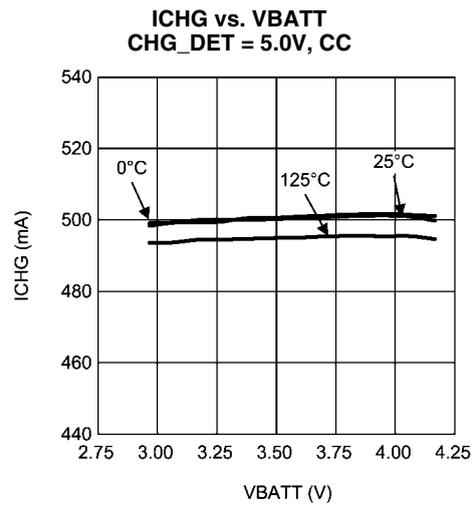
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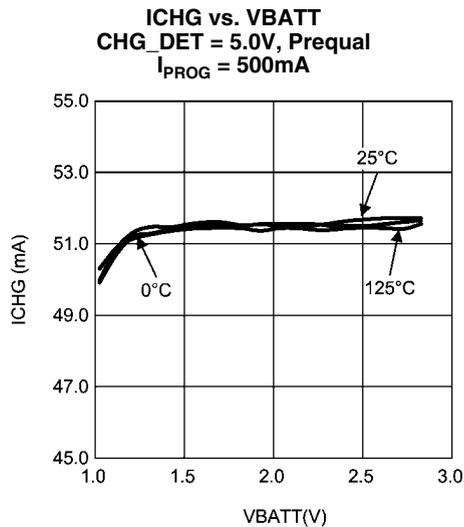
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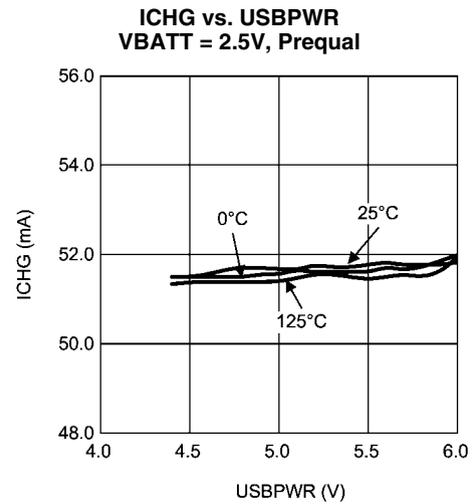
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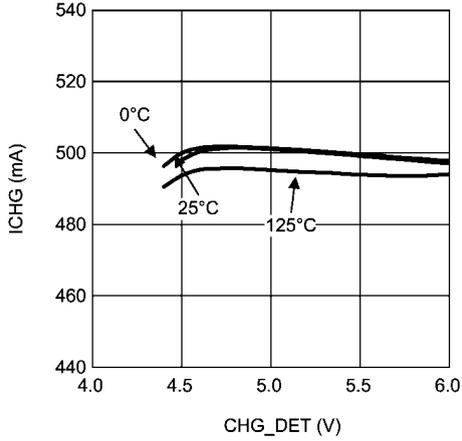


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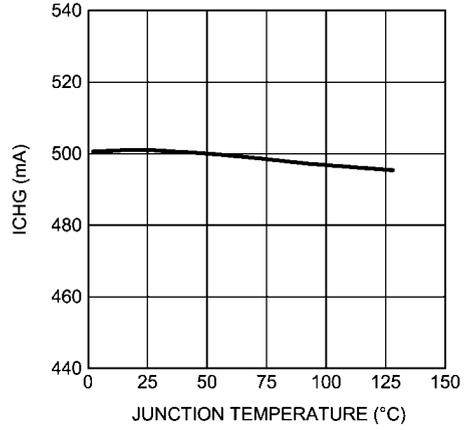
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**ICHG vs. CHG\_DET**  
VBATT = 3.5V, CC



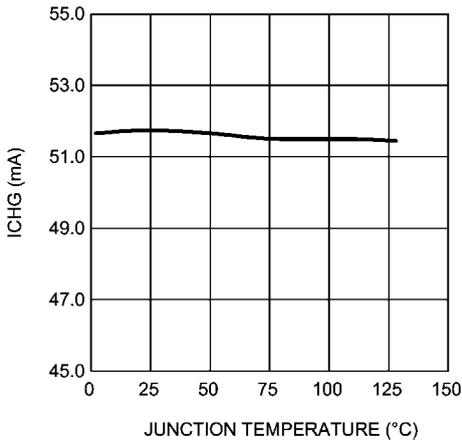
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**ICHG vs. Temperature**  
CHG\_DET = 5V, VBATT = 3.75V, CC



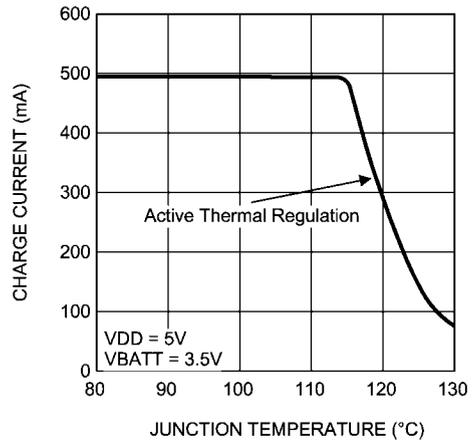
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**ICHG vs. Temperature**  
CHG\_DET = 5V, VBATT = 2.5V, Prequal



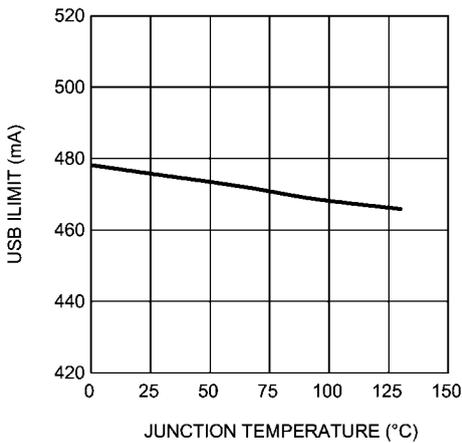
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**Thermal Regulation of Charge Current**



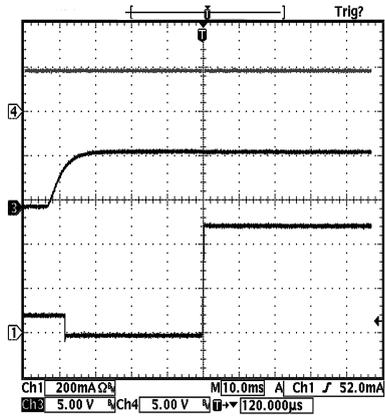
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**USB ILIMIT vs. Temperature**



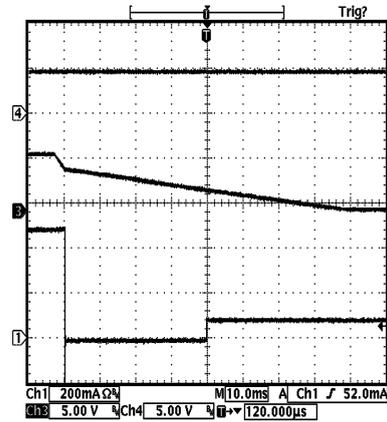
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Wall Adapter Insertion with USBPWR present  
CH1 = Charge Current (mA); CH3 = CHG\_DET (V);  
CH4 = USBPWR (V)



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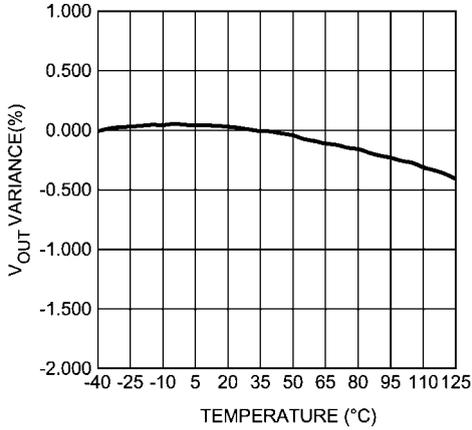
Wall Adapter Removal with USBPWR present  
CH1 = Charge Current (mA); CH3 = CHG\_DET (V);  
CH4 = USBPWR (V)



300001a1

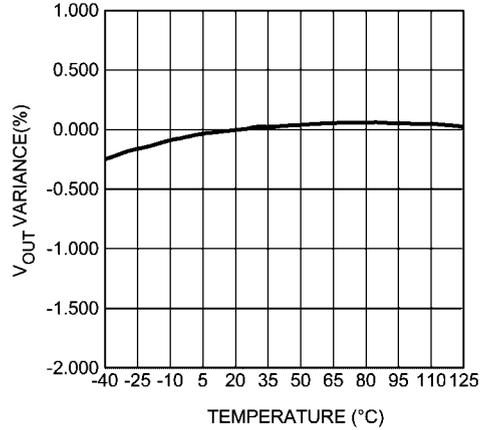
# Typical Performance Characteristics — LDO $T_A = 25^\circ\text{C}$ unless otherwise noted

**Output Voltage Change vs Temperature (LDO1)**  
 $V_{in} = 4.3\text{V}$ ,  $V_{out} = 3.3\text{V}$ , 100 mA load



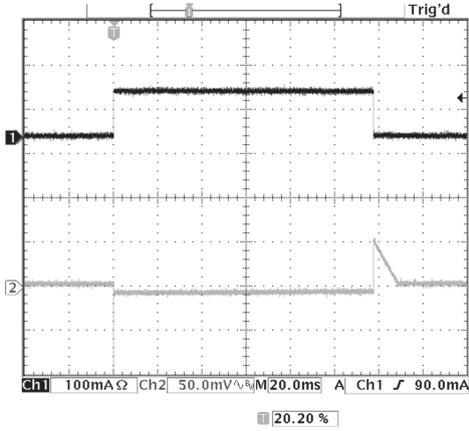
30000146

**Output Voltage Change vs Temperature (LDO2)**  
 $V_{in} = 4.3\text{V}$ ,  $V_{out} = 1.8\text{V}$ , 100 mA load



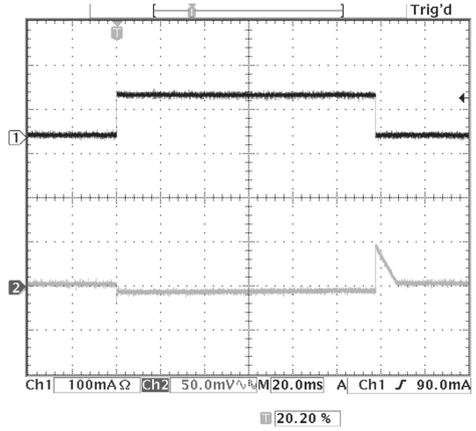
30000147

**Load Transient (LDO1)**  
 $3.6\text{V}_{in}$ ,  $3.3\text{V}_{out}$ , 0 – 100 mA load



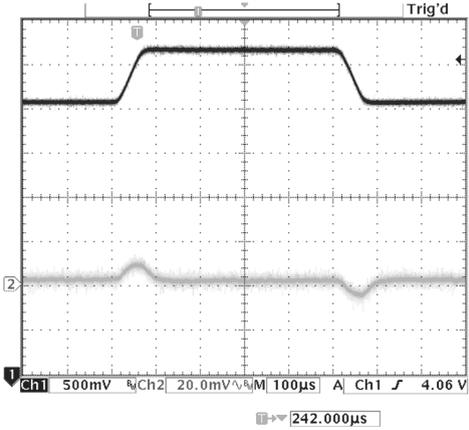
30000148

**Load Transient (LDO2)**  
 $3.6\text{V}_{in}$ ,  $1.8\text{V}_{out}$ , 0 – 100 mA load



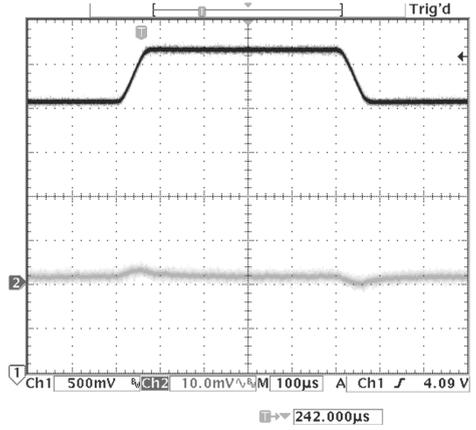
30000149

**Line Transient (LDO1)**  
 $3.6 - 4.5\text{V}_{in}$ ,  $3.3\text{V}_{out}$ , 150 mA load



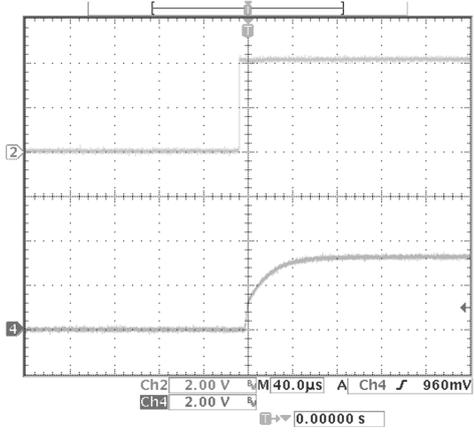
30000150

**Line Transient (LDO2)**  
 $3 - 4.2\text{V}_{in}$ ,  $1.8\text{V}_{out}$ , 150 mA load



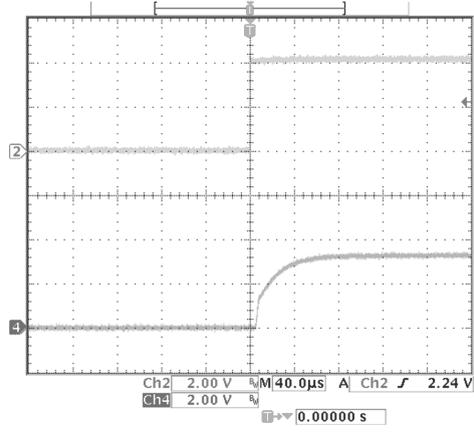
30000151

Enable Start-up time (LDO1)  
0-3.6 Vin, 3.3 Vout, 1mA load



30000152

Enable Start-up time (LDO2)  
0 - 3.6 Vin, 1.8 Vout, 1 mA load

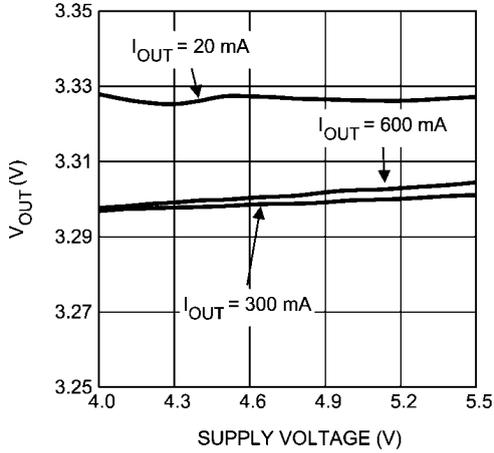


30000153

# Typical Performance Characteristics - Buck

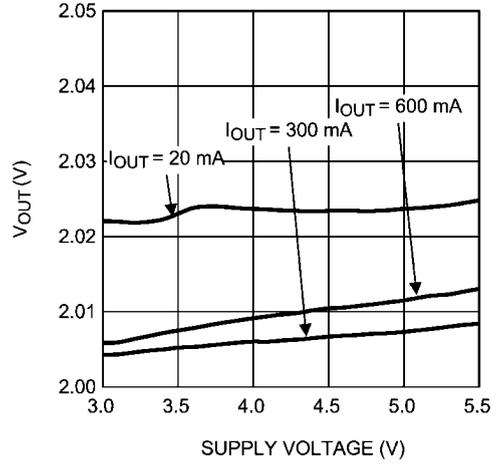
$T_A = 25^\circ\text{C}$  unless otherwise noted

**Output Voltage vs. Supply Voltage  
( $V_{out} = 3.3\text{ V}$ )**



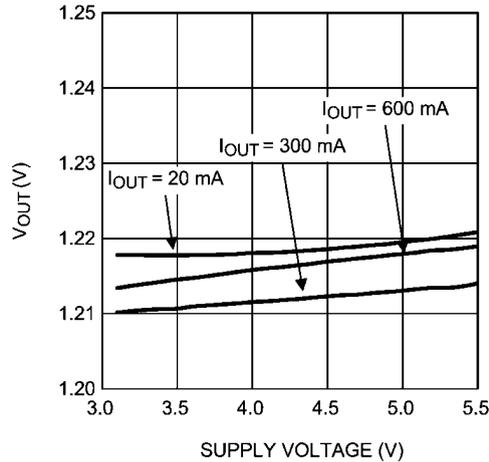
30000154

**Output Voltage vs. Supply Voltage  
( $V_{out} = 2.0\text{ V}$ )**



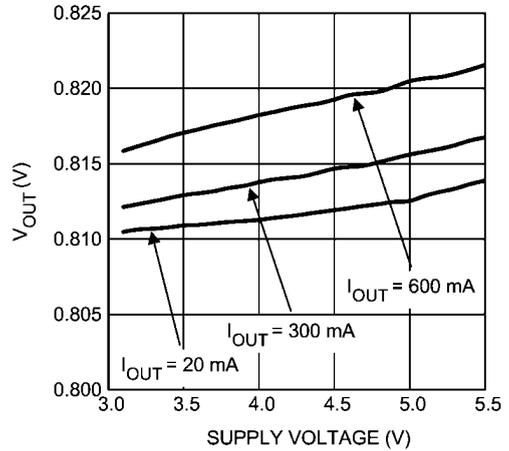
30000155

**Output Voltage vs. Supply Voltage  
( $V_{out} = 1.2\text{ V}$ )**



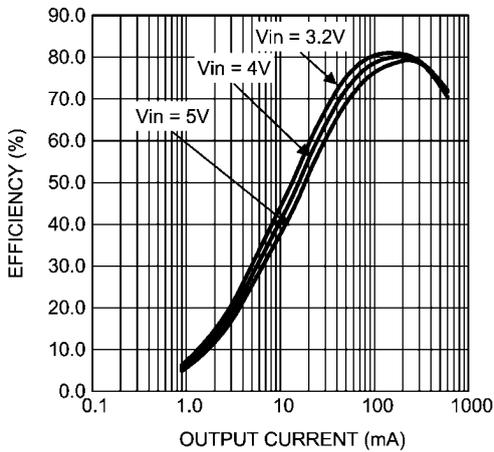
30000156

**Output Voltage vs. Supply Voltage  
( $V_{out} = 0.8\text{ V}$ )**



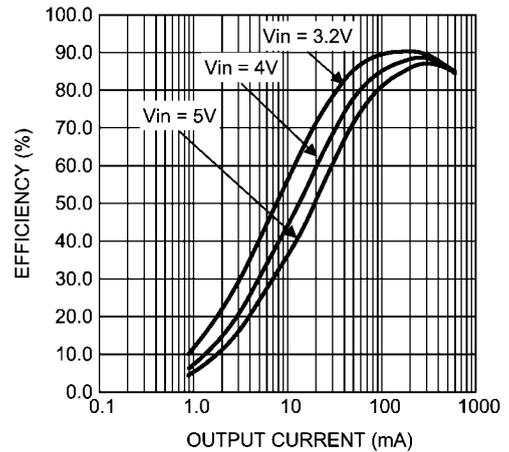
30000157

**Buck 1 Efficiency vs Output Current  
(Forced PWM Mode,  $V_{out} = 1.2\text{ V}$ ,  $L = 2.2\mu\text{H}$ )**



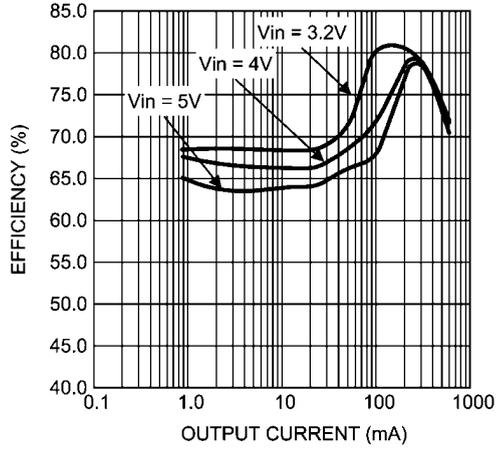
30000158

**Buck 1 Efficiency vs Output Current  
(Forced PWM Mode,  $V_{out} = 2.0\text{ V}$ ,  $L = 2.2\mu\text{H}$ )**



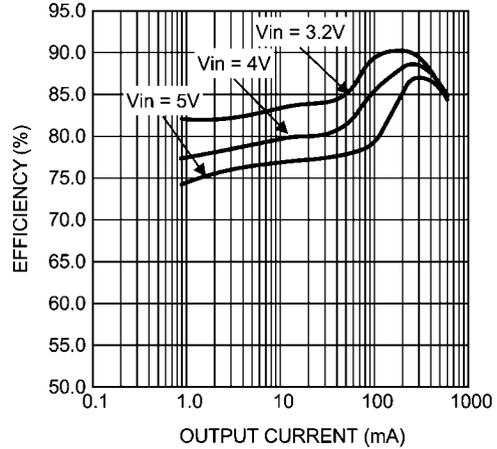
30000159

**Buck 1 Efficiency vs Output Current  
(PFM to PWM mode,  $V_{out} = 1.2V$ ,  $L = 2.2\mu H$ )**



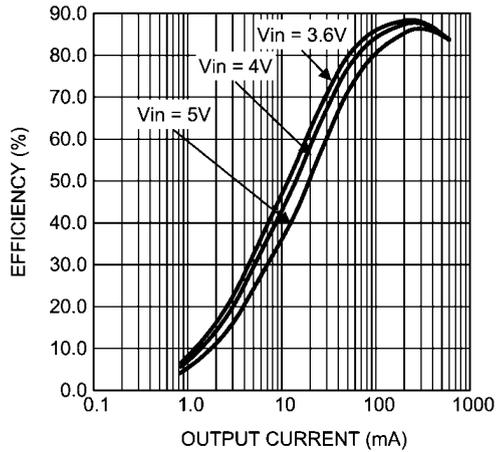
30000160

**Buck 1 Efficiency vs Output Current  
(PFM to PWM mode,  $V_{out} = 2.0V$ ,  $L = 2.2\mu H$ )**



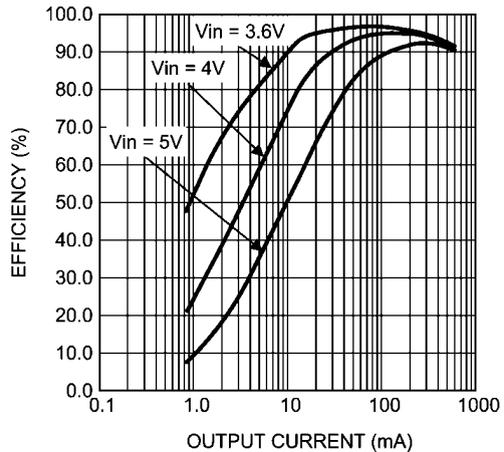
30000161

**Buck 2 Efficiency vs Output Current  
(Forced PWM Mode,  $V_{out} = 1.8V$ ,  $L = 2.2\mu H$ )**



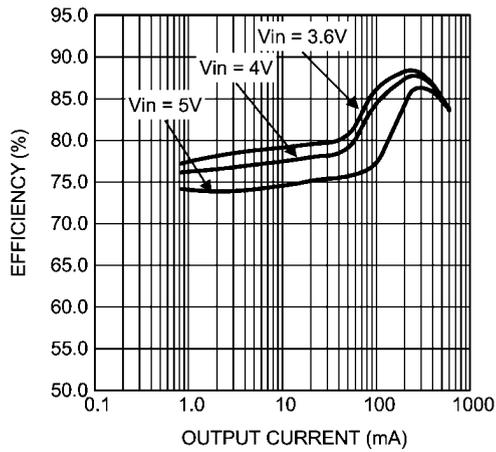
30000162

**Buck 2 Efficiency vs Output Current  
(Forced PWM Mode,  $V_{out} = 3.3V$ ,  $L = 2.2\mu H$ )**



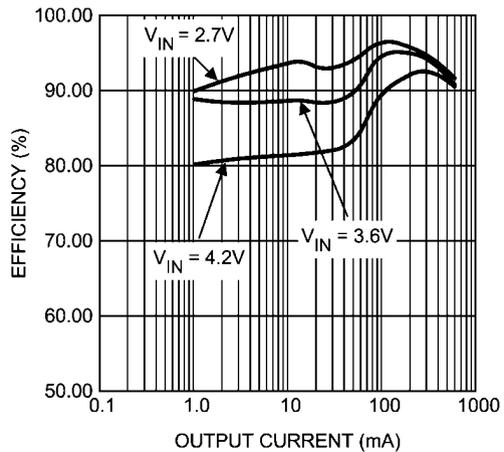
30000163

**Buck 2 Efficiency vs Output Current  
(PFM to PWM Mode,  $V_{out} = 1.8V$ ,  $L = 2.2\mu H$ )**



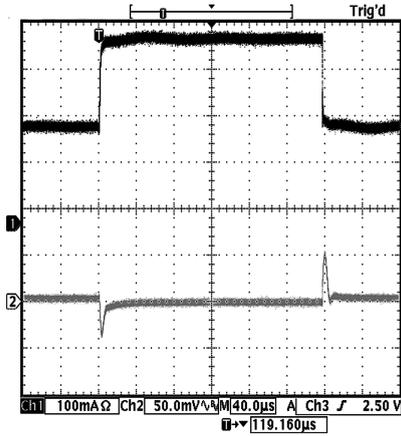
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**Buck 2 Efficiency vs Output Current  
(PFM to PWM Mode,  $V_{out} = 3.3V$ ,  $L = 2.2\mu H$ )**



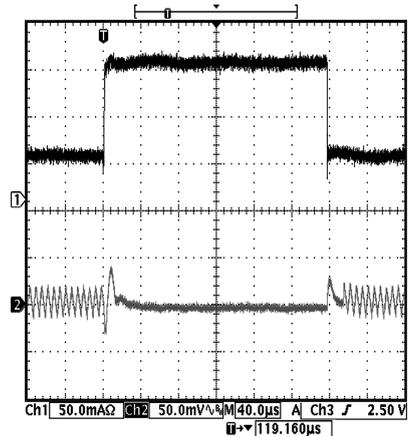
30000165

**Buck 1 Load Transient Response**  
 VIN = 4.2V, VOUT = 1.2V  
 ILOAD = 200-400mA (PWM Mode)



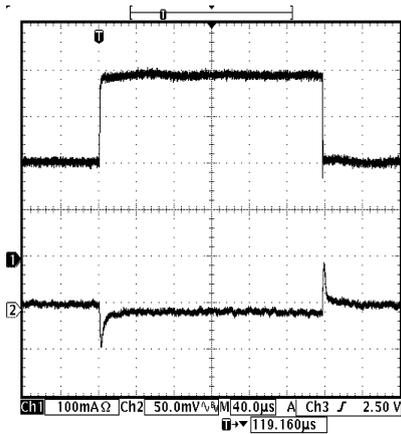
30000166

**Buck 1 Load Transient Response**  
 VIN = 4.2V, VOUT = 1.2V  
 ILOAD = 50-150mA (PFM to PWM)



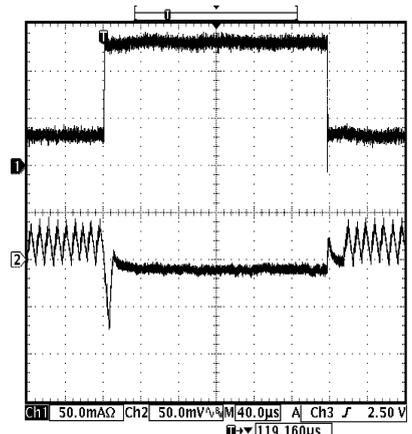
30000167

**Buck 2 Load Transient Response**  
 VIN = 4.2V, VOUT = 3.3V  
 ILOAD = 200-400mA (PWM Mode)



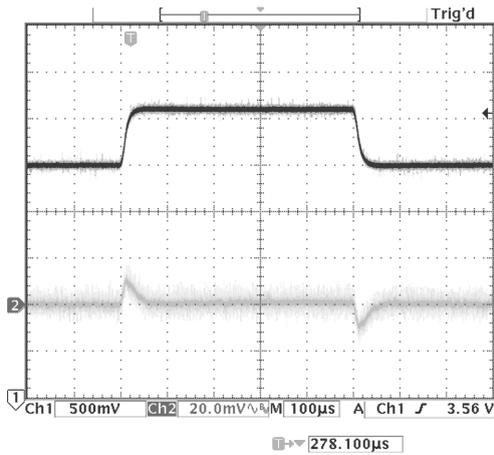
30000168

**Buck 2 Load Transient Response**  
 VIN = 4.2V, VOUT = 3.3V  
 ILOAD = 50-150mA (PFM to PWM)



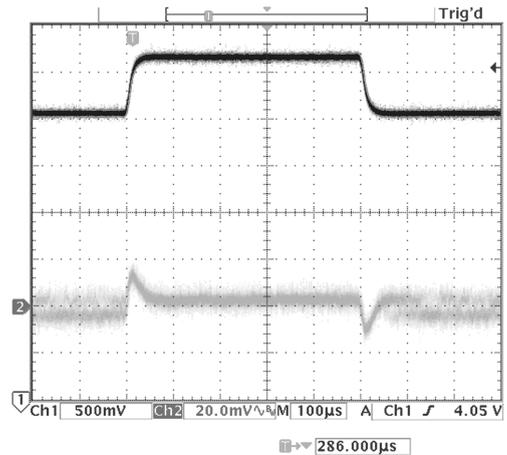
30000169

**Line Transient Response**  
 Vin = 3 – 3.6 V, Vout = 1.2 V, 250 mA load



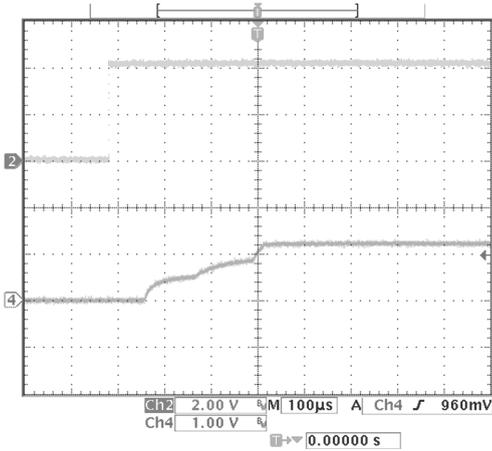
30000170

**Line Transient Response**  
 Vin = 3.6 – 4.2 V, Vout = 3.3 V, 250 mA load



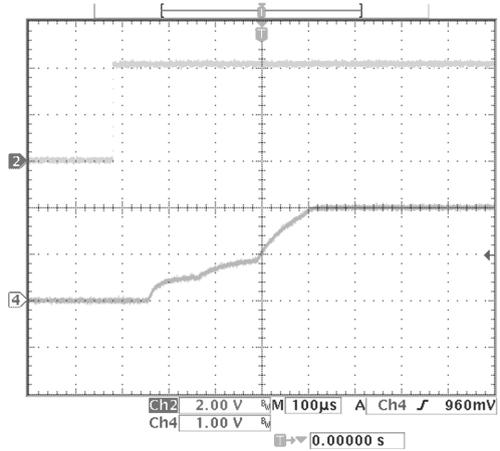
30000171

Start up into PWM Mode  
Vout = 1.8 V, 30 mA load



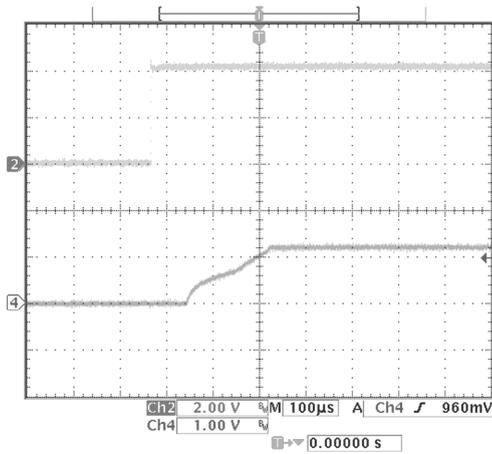
30000172

Start up into PWM Mode  
Vout = 3.3 V, 30 mA load



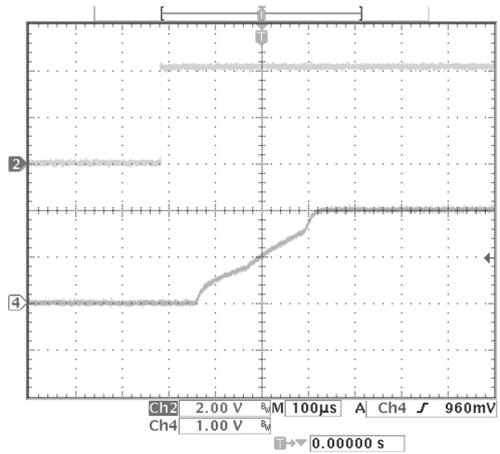
30000173

Start up into PFM Mode  
Vout = 1.8 V, 30 mA load



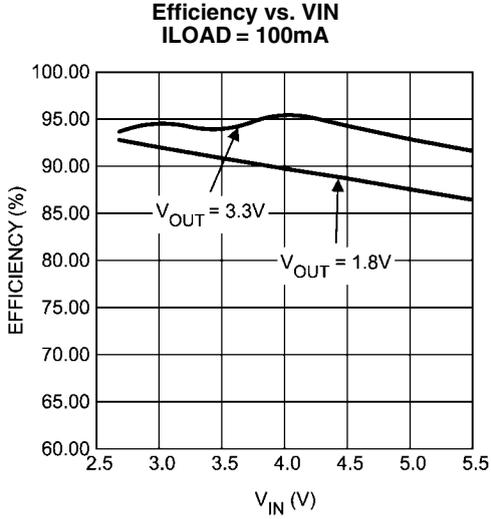
30000174

Start up into PFM Mode  
Vout = 3.3 V, 30 mA load

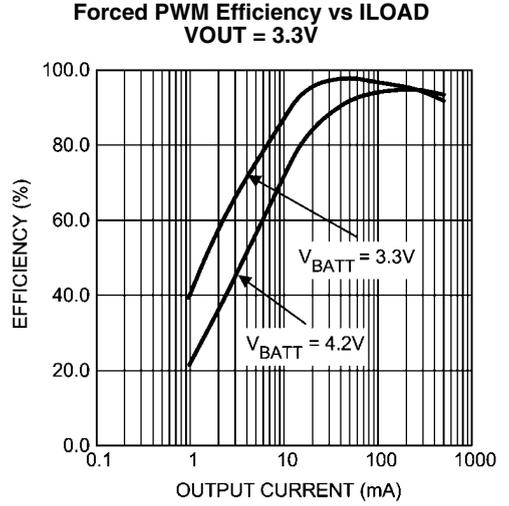


30000175

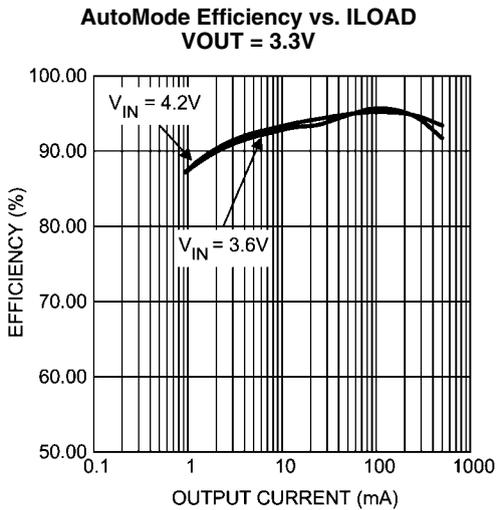
# Typical Performance Characteristics - Buck3 $T_A = 25^\circ\text{C}$ unless otherwise noted



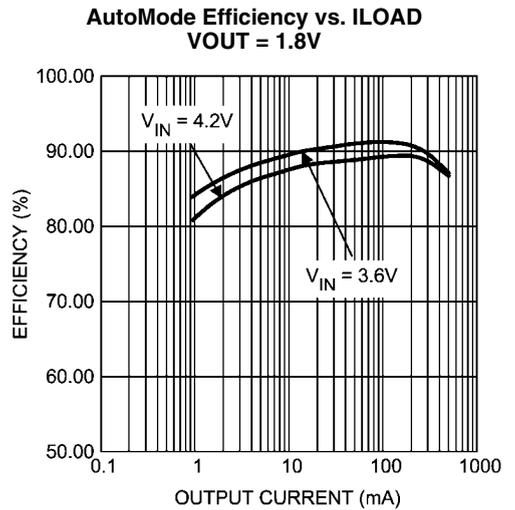
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30000177

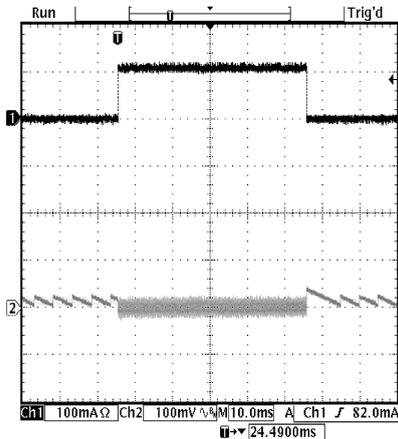


30000178



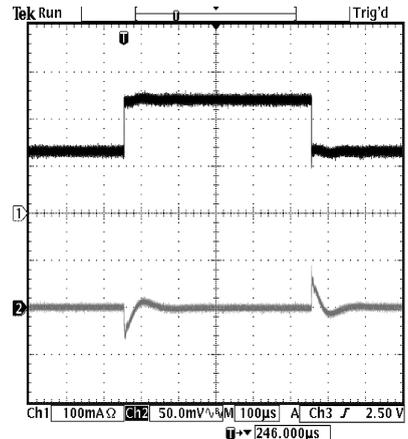
30000179

**Buck3 Load Transient Response**  
VIN = 4.2V, VOUT = 3.3V,  
ILOAD = 0-100mA (PFM Mode)



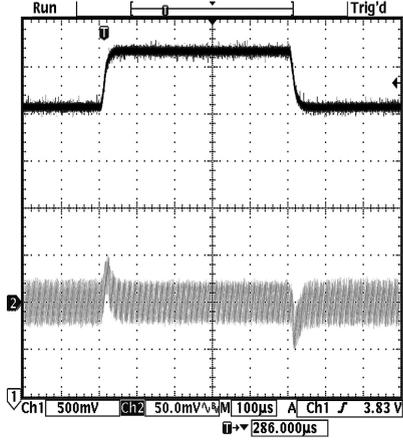
30000184

**Buck3 Load Transient Response**  
VIN = 3.6V, VOUT = 3.3V,  
ILOAD = 150-250mA (PWM Mode)



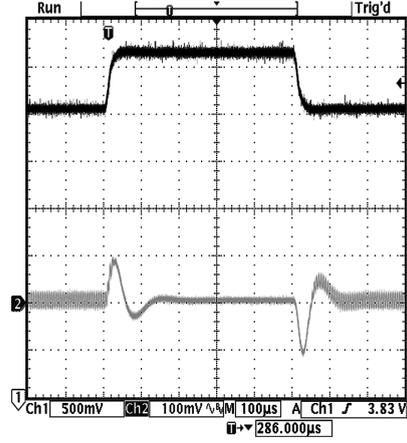
30000185

**Line Transient Response**  
VIN = 3.6 - 4.2V, VOUT = 3.3V, ILOAD = 80mA



30000186

**Line Transient Response**  
VIN = 3.6 - 4.2V VOUT = 3.3V, ILOAD = 260mA

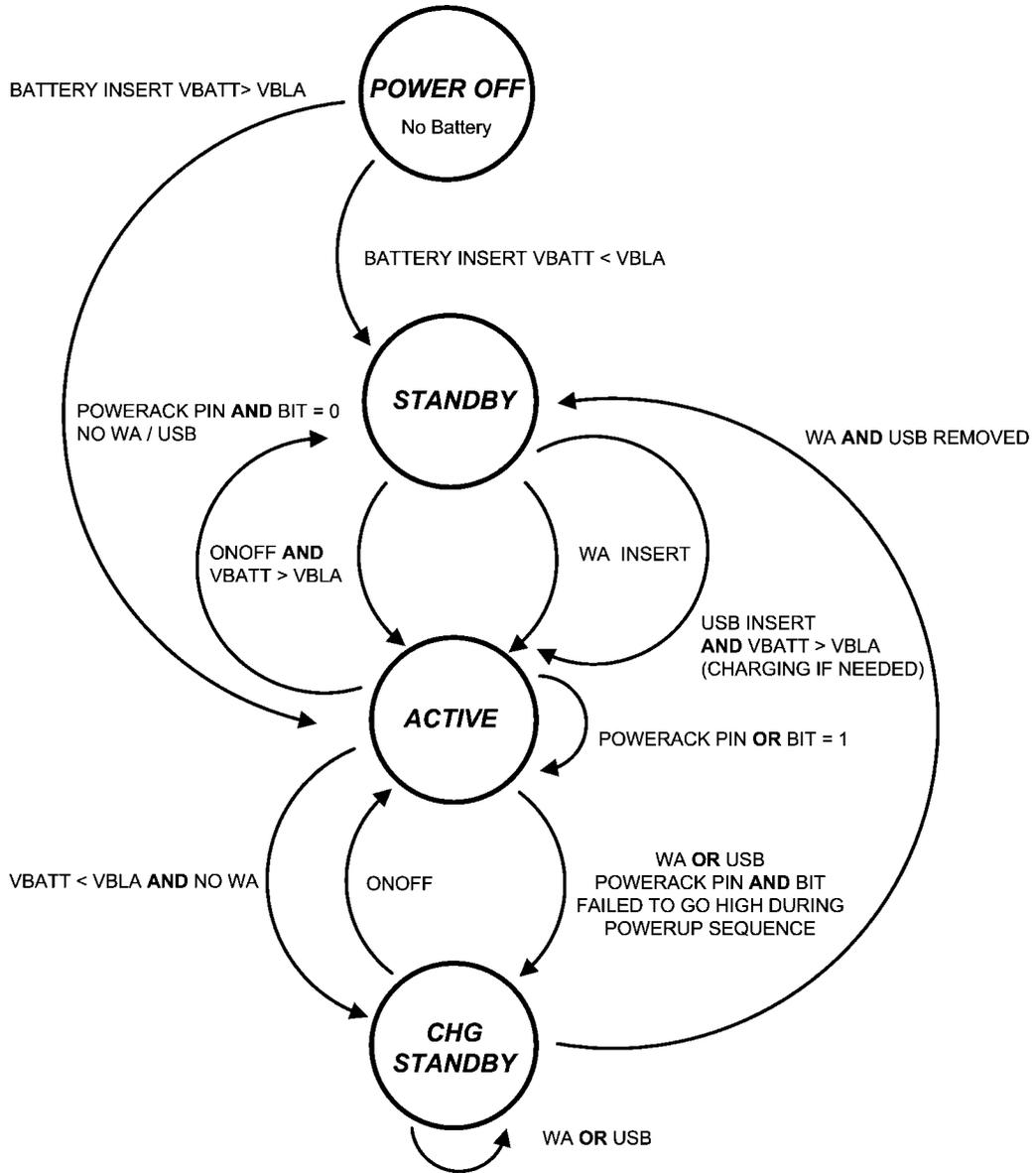


30000187

# Functional Description

## OPERATING MODES

The LP3913 can be in 3 different operating modes as illustrated in the following Operating Mode State Diagram:



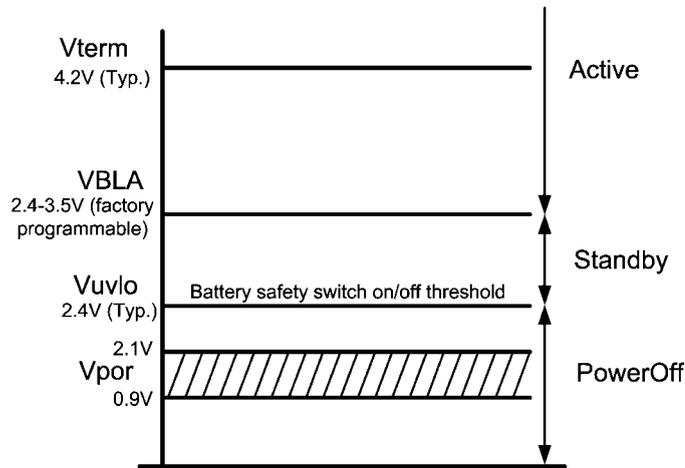
30000103

### State Machine Definitions

**V<sub>BLA</sub>** Battery low alarm threshold  
**V<sub>BATT</sub>** Battery voltage  
**WA** Wall Adapter

**USB** Universal Serial Bus Adapter  
**ONOFF** On off pin event  
**POWERACK** Acknowledgment from the Host Processor

**Voltage Threshold Levels**



30000104

**Power State Table**

|                            | <b>Power Off</b> | <b>Standby</b> | <b>Active</b>                  | <b>Charger Standby</b>         |
|----------------------------|------------------|----------------|--------------------------------|--------------------------------|
| LDO1,2                     | Off              | Off            | On                             | Off                            |
| BUCK1,2                    | Off              | Off            | On                             | Off                            |
| BUCK3                      | Off              | Off            | On                             | Off                            |
| CHARGER                    | Off              | Off            | On if Charger / USB Present    | On if Charger / USB Present    |
| A/D Converter              | Off              | Off            | On                             | Off                            |
| NRST                       | Low              | Low            | High                           | Low                            |
| I <sup>2</sup> C interface | Off              | Off            | On                             | On                             |
| Internal System Oscillator | Off              | Off            | On                             | On                             |
| Battery Monitor            | Off              | On             | On                             | On                             |
| Current consumption        | <1 μA            | 10 μA (typ)    | See Electrical Characteristics | See Electrical Characteristics |

**Power-On-Reset**

The LP3913 is equipped with an internal Power-On-Reset (“POR”) circuit that will reset the logic when  $V_{DD} < V_{POR}$ . This guarantees that the logic is properly initialized when  $V_{DD}$  rises above the minimum operating voltage of the Logic and the internal oscillator that clocks the Sequential Logic in the Control section.

**Thermal Shutdown and Thermal Alarm**

An internal temperature sensor monitors the junction temperature of the LP3913 and forcibly invokes standby mode in the unusual case when the junction temperature of the silicon exceeds the normal operating level due to excessive loads on all power regulators and the Li-ion charger and/or due to an abnormally high ambient temperature. The thermal Shutdown threshold is 160°C.

The thermal shutdown is preceded by a Thermal alarm that generates an interrupt request if unmasked (see Interrupt Request generation). The temperature threshold for triggering the alarm is 115°C.

**NRST Pin**

The NRST pin is an open-drain output and is active low during Standby, Power Off and Charger Standby modes. The NRST timing is determined by a factory programmable counter.

**Control Registers**

The LP3913 contains 14 user programmable registers that configure the functionality of the individual modules inside the IC. Registers are programmed through an I<sup>2</sup>C interface and have default values that are invoked during an internal reset. Some of the default values can be tailored to the specific needs of the system designer (see Application Notes).

Throughout this product specification, the register address is noted in hexadecimal notation immediately following the register name as illustrated below:

**PON Register (00)h Power On Event Register**

|  |      |    |    |    |    |
|--|------|----|----|----|----|
|  | D7-4 | D3 | D2 | D1 | D0 |
|--|------|----|----|----|----|

**Battery Monitor**

The battery voltage is monitored and will invoke the Power Off mode when the battery low threshold is breached for more than 5 ms (Typ.). The battery low threshold DEFAULT is factory programmed. The battery low threshold range is 2.5V–3.5V with steps of 50 mV. The Battery low threshold in the table below refers to a decreasing battery voltage. The threshold when the battery voltage is transitioning out of the  $V_{BATTLOW}$  is 50 mV (Typ.) higher than the values listed in the table below due to a built-in hysteresis of 50 mV (Typ.).

The battery low IRQ is triggered 200 mV above the battery low alarm threshold that powers down the IC. This gives the user time for a controlled shutdown.

**BATTLOW Register (04)h Battery Low Alarm Register**

|        | D7–5        | D4–0                                     |      |  |
|--------|-------------|--|------|--|
| Access | Read Only 0 | rw                                       |      |  |
| Data   | reserved    | <b>Battery Low threshold voltage (V)</b> |      | <b>Battery low IRQ threshold Voltage (V)</b> |
|        |             | 5'h14–1F                                 | 2.50 | 2.70   |
|        |             | 5'h13                                    | 2.55 | 2.75   |
|        |             | 5'h12                                    | 2.60 | 2.80   |
|        |             | 5'h11                                    | 2.65 | 2.85   |
|        |             | 5'h10                                    | 2.70 | 2.90   |
|        |             | 5'h0F                                    | 2.75 | 2.95   |
|        |             | 5'h0E                                    | 2.80 | 3.00   |
|        |             | 5'h0D                                    | 2.85 | 3.05   |
|        |             | 5'h0C                                    | 2.90 | 3.10   |
|        |             | 5'h0B                                    | 2.95 | 3.15   |
|        |             | 5'h0A                                    | 3.00 | 3.20   |
|        |             | 5'h09                                    | 3.05 | 3.25   |
|        |             | 5'h08                                    | 3.10 | 3.30   |
|        |             | 5'h07                                    | 3.15 | 3.35   |
|        |             | 5'h06                                    | 3.20 | 3.40   |
|        |             | 5'h05                                    | 3.25 | 3.45   |
|        | 5'h04       | 3.30                                     | 3.50 |  |
|        | 5'h03       | 3.35                                     | 3.55 |  |
|        | 5'h02       | 3.40                                     | 3.60 |  |
|        | 5'h01       | 3.45                                     | 3.65 |  |
|        | 5'h00       | 3.50                                     | 3.70 |  |
| Reset  | n/a         | 5'h0C                                    | 2.90 | 3.10   |

**PowerOff Mode**

In Power Off mode the main battery, the battery charger supply, and the USB supply are below their minimum on levels. All internal circuits are disabled as the supply voltage is below the level to activate them. The LP3913 is in Power Off mode when the battery voltage is below the battery  $V_{UVLO}$  (2.4V typ) except when a valid external supply is detected.

**Standby**

When the LP3913 is in Standby Mode, the chip is waiting for a valid power-on event to transition to Active Mode. There are 3 valid wakeup signals. First is the ONOFF pin. Second is Wall Adapter Insertion. Third is the USB insertion.  $V_{BATT}$  must be greater than the battery  $V_{UVLO}$  in order to stay in Standby Mode, otherwise the chip transitions to Power Off Mode. Standby Mode is skipped when advancing from Power Off Mode when a battery is inserted that is above the battery low alarm threshold.

If the battery is below the battery low alarm threshold, Power Off Mode transitions to Standby Mode. However, hot insertion of the battery with the adapter connected is NOT permitted. In Standby Mode, the current consumption is reduced to  $I_Q$  (10  $\mu$ A TYP).

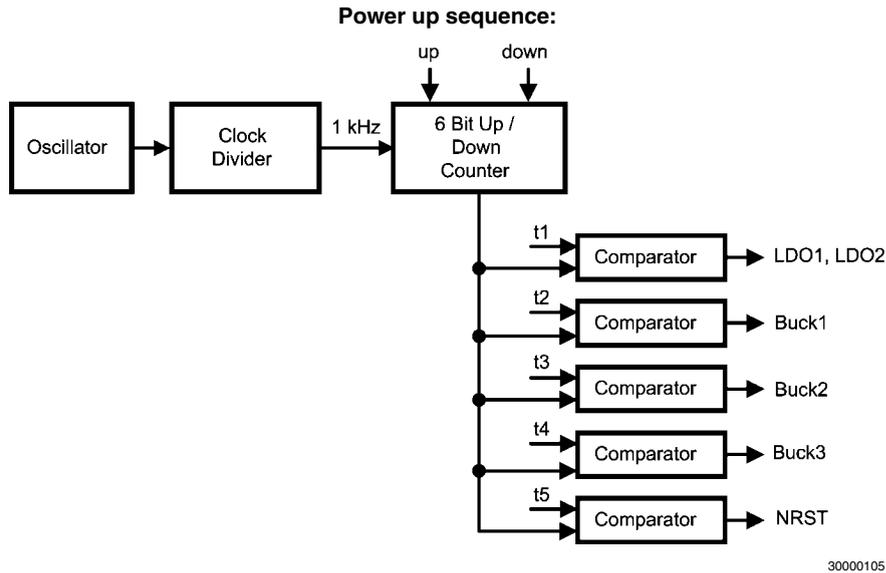
**Active Mode**

All LP3913 circuits are fully operational in Active mode.

**Power On/Off Sequencing**

Each DC/DC converter (Buck1, Buck2, Buck3, LDO1, LDO2) and the NRST pin of the LP3913 has its own delay after which

it is enabled following a power-on event or disabled following a power-off event. Following the deglitching of the power-on event, the system bandgaps are enabled. Following this is a 5 ms delay that internal circuitry requires to cleanly powerup. The programmable delays are measured from this time point. Following the deglitching of a power-down event (up to 5 ms if POWERACK pin is used), the power-down sequencer will start. Each delay ranges from 0 ms to 63 ms in steps of 1 ms and is factory programmed to the desired values submitted by the system designer. As illustrated below, the power-on/off sequencing is designed around a 6-bit up/down timer that is clocked at 1 kHz. A power-on or power-off event will trigger the timer, which counts up from 0 during a power-on sequence and counts down from 5'b11111 during a power-down cycle. The timer output is connected to 5 comparators with factory programmed timeout values that correspond to the on and off delays for each DC/DC converter and the NRST pin. Once the timer has incremented beyond the comparator timeout value during a power-on cycle, the output of the comparator enables the corresponding DC/DC converter or raises the NRST pin to a logic high level. Subsequently, once the timer has decremented below the comparator timeout value during a power-down cycle, the output of the comparator will disable the corresponding DC/DC converter or will activate the NRST pin to a logic low level.



**Power On Timing**

Each timeout T1 thru to T5 are factory programmed from 0 ms to 63 ms. The following defaults are shown below.

| Symbol | Description                          | Time | Units |
|--------|--------------------------------------|------|-------|
| T1     | Programmable Delay for LDO1 and LDO2 | 5    | ms    |
| T2     | Programmable Delay to Buck1          | 15   | ms    |
| T3     | Programmable Delay for Buck2         | 20   | ms    |
| T4     | Programmable Delay for Buck3         | 25   | ms    |
| T5     | Programmable Delay for NRST          | 60   | ms    |

**Power Off Timing**

The timing delays during a power off sequence are equal to 63 ms minus the timing delay during the power on sequence.

| Symbol | Description                          | Time | Units |
|--------|--------------------------------------|------|-------|
| T1     | Programmable delay for LDO1 and LDO2 | 58   | ms    |
| T2     | Programmable delay to Buck1          | 48   | ms    |
| T3     | Programmable delay for Buck2         | 43   | ms    |
| T4     | Programmable delay for Buck3         | 38   | ms    |
| T5     | Programmable delay for NRST          | 3    | ms    |

**Transitioning from Standby to Active Mode (Power Up)  
Battery Power Present Only**

When only battery power is present and the battery voltage  $V_{BATT} > V_{BATTLOW}$ , the LP3913 is waiting for one of three valid wakeup signals. The first is the ONOFF pin. The second and third wakeups are the Wall Adapter and USBPWR. The ONOFF pin is factory programmable wakeup source. It can be a rising edge, a falling edge, a level high, or a level low event. Regardless of the mode, the signal requires a 32 ms deglitch time. A deglitched version of the ONOFF pin is output on the open-drain output pin ONSTAT. ONOFF is usually connected to a push button. Asserting the ONOFF pin starts the power on sequencer. This enables the DC/DC converters

including the Buck1 DC/DC converter that supplies power to the system processor. The system processor then needs to set bit D4 (PACK bit) in the Power On Event Register through the I<sup>2</sup>C interface or apply a logic high to the POWERACK pin to keep the LP3913 in the Active mode. These serve as a Power Acknowledgement, confirming the power on request initiated by the ONOFF pin. If neither the PACK bit (D4) in the PON register or the POWERACK pin is set within 128 ms (max) of the start of the power-up sequencer, then the LP3913 will automatically turn off, as the system failed to acknowledge the power on request. Connecting the battery will be considered a Power on event. However hot insertion of the battery with the adapter connected is NOT permitted.

**PON Register (00)h Power On Event Register**

|        | D7–5        | D4  | D3   | D2  | D1   | D0   |
|--------|-------------|---|--|---|--|--|
| Access | Read Only 0 | rw  | Read Only  |   |  |  |
| Data   | Reserved    | <b>PACK</b><br>0: Disable Power, go in standby, and wait for power on event.<br>1: Acknowledge Power On request | <b>Battery Insert</b><br>0: default<br>1: Battery Insert caused by Battery Insertion | <b>PON by ONOFF</b><br>0: default<br>1: ONOFF caused Power On event | <b>PON by CHG_IN</b><br>0: default<br>1: Power On caused by CHG_IN power detection | <b>PON by USB Power</b><br>0: default<br>1: Power On caused by USB power detection |
| Reset  | n/a         | 0   | 0  | 0   | 0  | 0  |

**External Power and Battery Detection**

When a Wall Adapter is detected, regardless of the battery voltage, the LP3913 moves to the Active Mode and the Power-up sequencer is started. Similar to the ONOFF pin, there is a 32 ms deglitch time to ensure a clean wall adapter detection and the system processor needs to set the PACK bit (D4) in the PON register or the POWERACK pin within 128 ms (max) of the start of the power-up sequencer.

When USB PWR is detected and the battery is above the low battery alarm threshold, the LP3913 moves to the Active Mode and the Power-up sequencer is started. Similar to the ONOFF pin, there is a 32 ms deglitch time to ensure a clean USB detection and the system processor needs to set the PACK bit (D4) in the PON register or the POWERACK pin

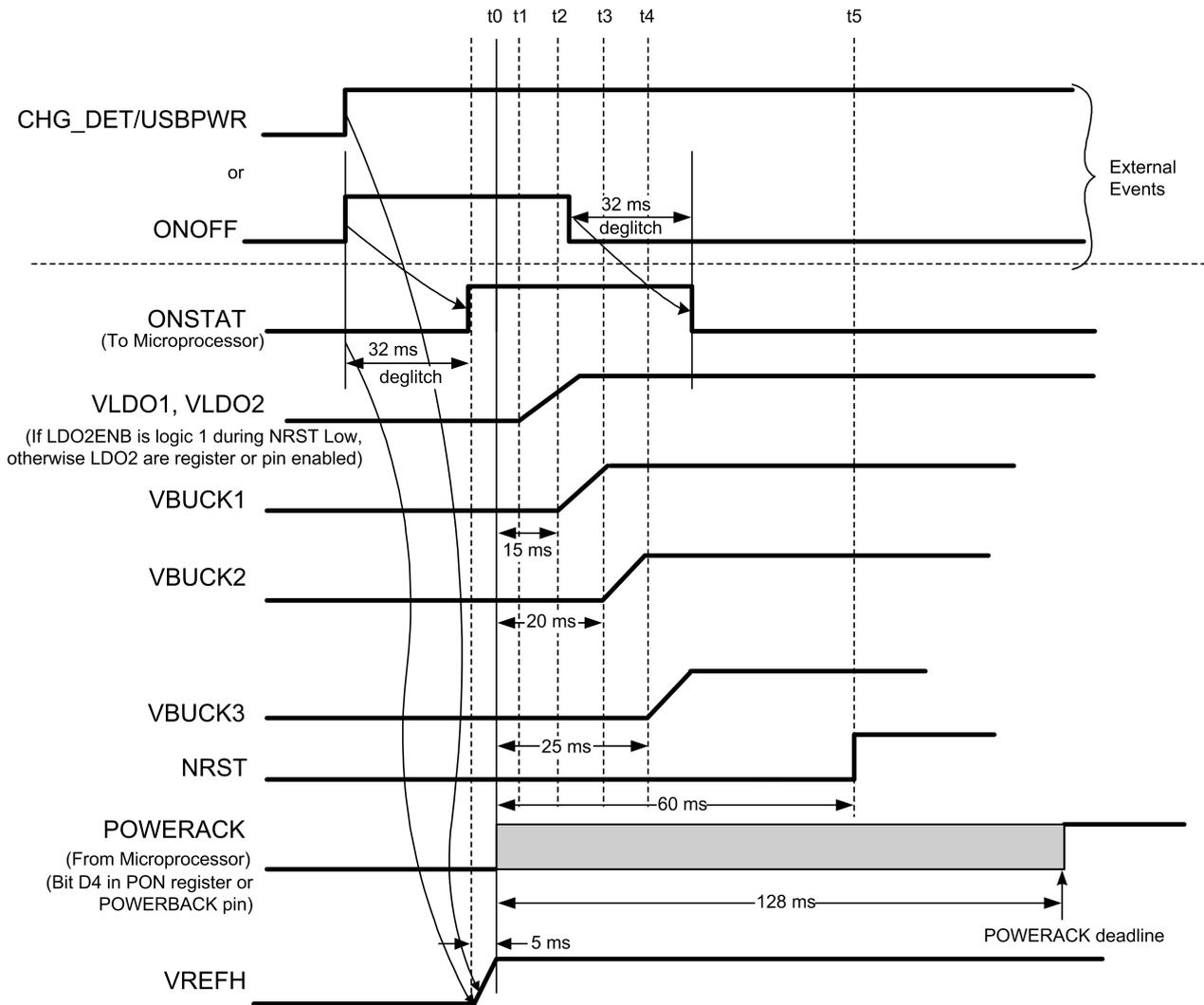
within 128 ms (max) of the start of the power-up sequencer. If the battery is below the low battery alarm threshold, the system will remain powered down until the USBPWR charges the battery up to the battery low alarm threshold, at which point the power-up sequencer is started.

The four LSB bits of the PON register indicate which PON source was responsible for moving the LP3913 out of standby and into active mode:

- Battery insert
- ONOFF push button
- CHG\_IN detect (connection of power adapter)
- USB power (plug-in of powered USB cable)

These bits are cleared upon powering off.

**Power Up Sequence**  
**Power Up Sequence**



**Transitioning From Active Mode To Standby Mode**

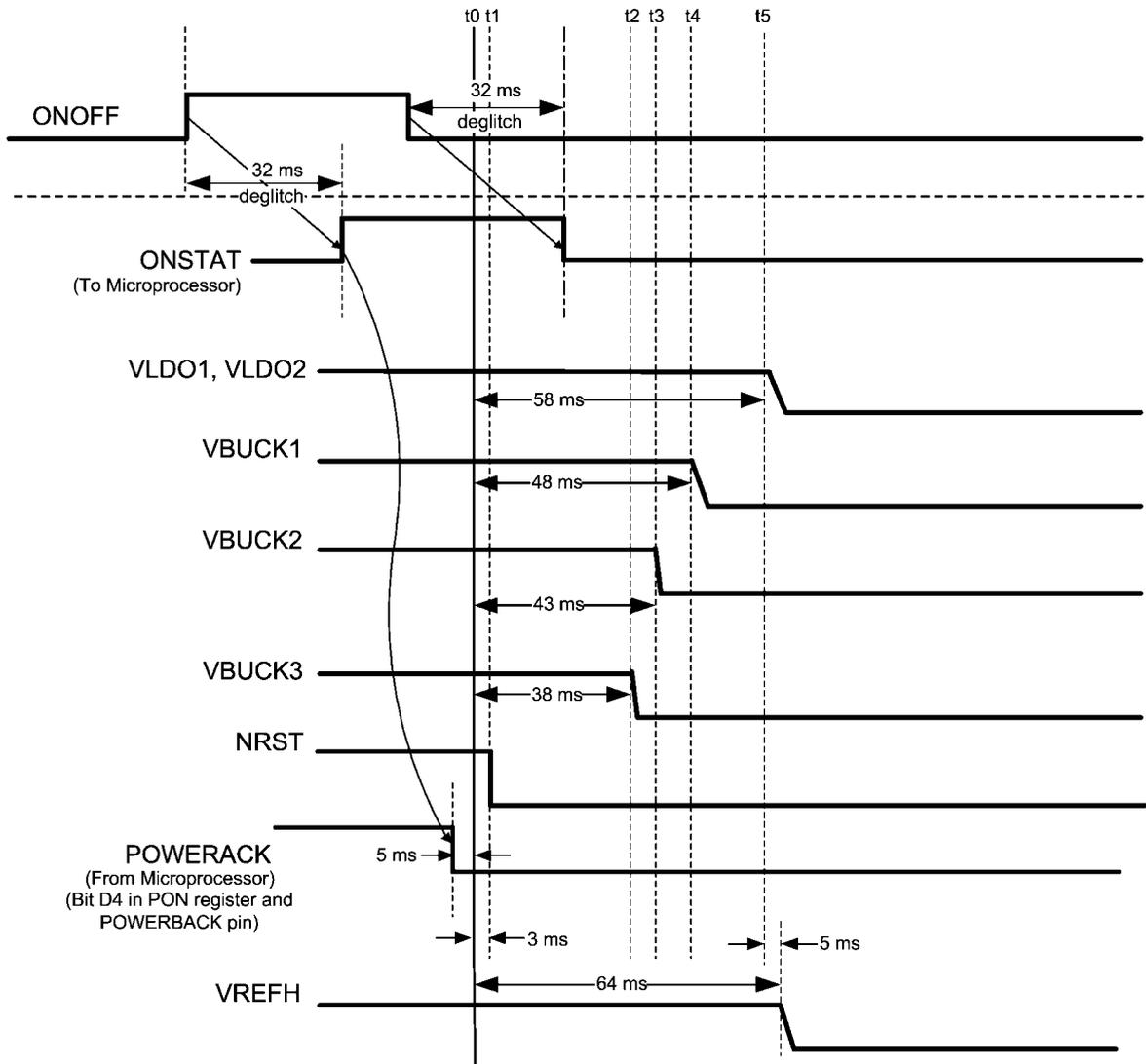
**External Event Triggers the Transition from Active to Standby Mode**

When the device is active, a subsequent re-assertion of the push button will turn off the LP3913 indirectly by first flagging the system processor through the ONSTAT pin. Upon detecting the ONSTAT transition, the system processor must clear bit D4 (PACK) in the Power On Event Register and apply a logic low to the POWERACK pin to power down the LP3913, which then transitions to Standby Mode. Clearing the PACK

30000106  
register bit and POWERACK pin while external supply sources are present (either USB or CHG\_IN) will *not* power down the LP3913, to keep the charger active. The system can as always disable all necessary DC/DC converters, except BUCK1, through the register control.

When external power is disconnected, LP3913 will remain in its Active state unless the battery voltage is below  $V_{BLA}$  (Battery Low Alarm) or unless the PACK (either bit D4 in the PON register and the POWERACK pin) is cleared by the system processor.

**Power Down Caused by External Event**  
**Power Down Caused by External Event**



**Transition from Active to Standby Mode Due to Expiring POWERACK Deadline**

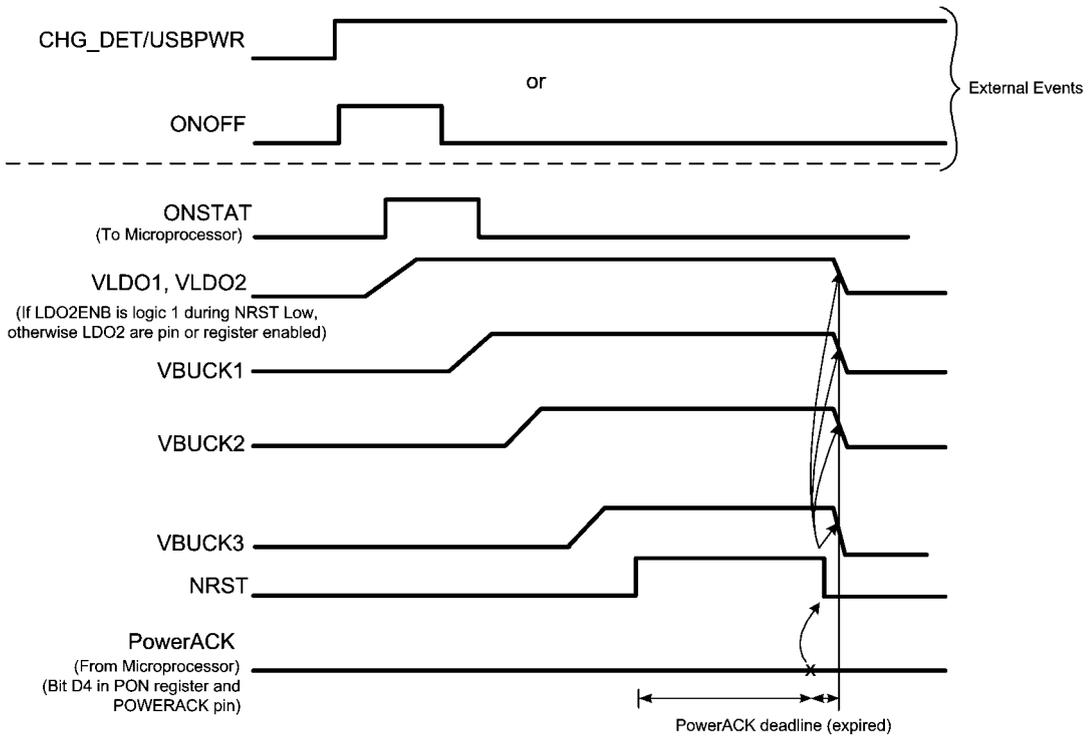
With no external charger present when the system processor fails to acknowledge the power-on in time by setting either the PACK bit (D4) in the PON register or the POWERACK pin before the 128 ms deadline following the start of the power-up sequencer, then the NRST is immediately de-asserted and after 2 ms all power sources will be disabled before transitioning to Standby Mode. This 2 ms delay allows the microprocessor to receive a clean reset before the power is de-

asserted. A new power-on event is then required to transition back to Active mode.

With either external charger present when the system processor fails to acknowledge the power-on in time by setting either the PACK bit (D4) in the PON register or the POWERACK pin before the 128 ms deadline following the start of the power-up sequencer, then the NRST is immediately de-asserted and after 2 ms all power sources will be disabled before transitioning to Charger Standby Mode.

30000107

**Power Down Caused by Expiring PowerACK Deadline**  
**Power Down Caused by Expiring PowerACK deadline**



**Transition from Charger Standby Mode to Either Active or Standby Mode**

While in Charger Standby mode, the battery is charged using the default values of  $I_{PROG}$ ,  $E_{OC}$ ,  $V_{TERM}$ , Batt Temp Range and USB  $I_{SEL}$ . In Charger Standby mode, all the regulators

and the I<sup>2</sup>C are disabled. A new power-on event is required to transition back to Active Mode. Removing the charger during Charger Standby Mode causes a transition back to Standby Mode.

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**I<sup>2</sup>C Compatible Serial Interface**

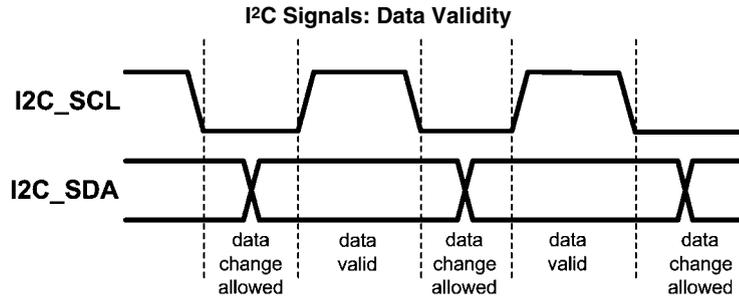
**I<sup>2</sup>C Signals**

The LP3913 features an I<sup>2</sup>C compatible serial interface, using two dedicated pins: I<sup>2</sup>C\_SCL and I<sup>2</sup>C\_SDA for I<sup>2</sup>C clock and data respectively. Both signals need a pull-up resistor according to the I<sup>2</sup>C specification. The LP3913 interface is an I<sup>2</sup>C slave that is clocked by the incoming SCL clock.

Signal timing specifications are according to the I<sup>2</sup>C bus specification. The maximum bit rate is 400 kbit/s. See I<sup>2</sup>C specification from Philips for further details.

**I<sup>2</sup>C Data Validity**

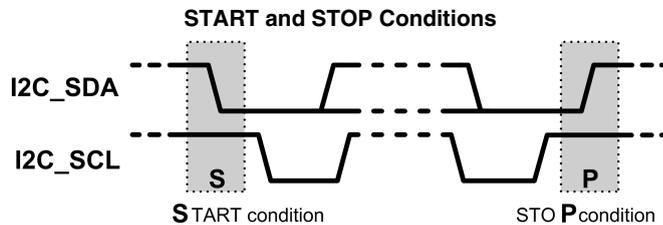
The data on I<sup>2</sup>C\_SDA line must be stable during the HIGH period of the clock signal (I<sup>2</sup>C\_SCL), e.g., the state of the data line can only be changed when CLK is LOW.



**I<sup>2</sup>C START and STOP Conditions**

START and STOP bits classify the beginning and the end of the I<sup>2</sup>C session. The START condition is defined as the I<sup>2</sup>C\_SDA signal transitioning from HIGH to LOW while SCL line is HIGH. The STOP condition is defined as the SDA transitioning from LOW to HIGH while I<sup>2</sup>C\_SCL is HIGH. The I<sup>2</sup>C

master always generates START and STOP bits. The I<sup>2</sup>C bus is considered to be busy after a START condition and free after a STOP condition. During data transmission, I<sup>2</sup>C master can generate repeated START conditions. First START and repeated START conditions are equivalent, function-wise.



**Transferring Data**

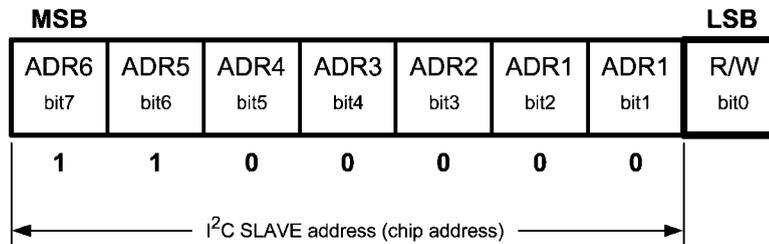
Every byte put on the I<sup>2</sup>C\_SDA line must be eight bits long, with the most significant bit (MSB) being transferred first. Each byte of data has to be followed by an acknowledge bit. The acknowledged related clock pulse is generated by the master. The transmitter releases the I<sup>2</sup>C\_SDA line (HIGH) during the acknowledge clock pulse. The receiver must pull down the I<sup>2</sup>C\_SDA line during the 9th clock pulse, signifying acknowledgement. A receiver which has been addressed must generate an acknowledgement ("ACK") after each byte has been received.

**Register Write Cycle**

After the START condition, the I<sup>2</sup>C master sends a chip address. This address is seven bits long followed by an eighth bit which is a data direction bit (R/W). For the eighth bit, a "0" indicates a WRITE and a "1" indicates a READ. The second byte selects the register to which the data will be written. The third byte contains data that will be written to the selected register.

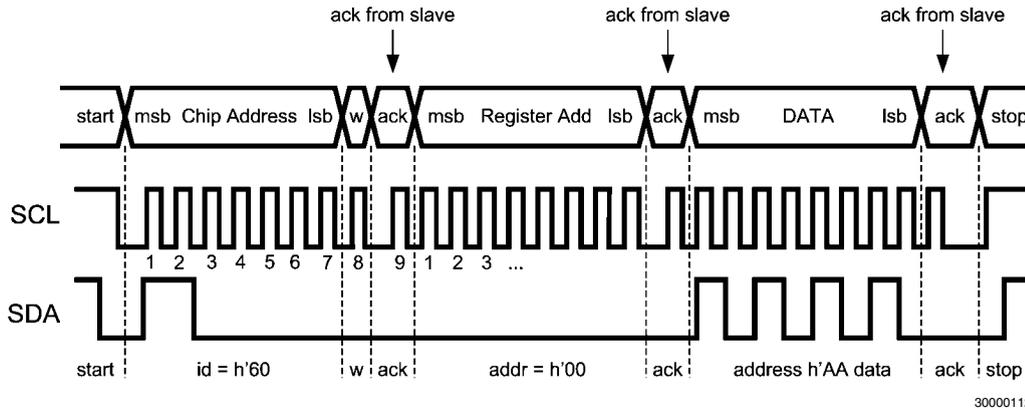
LP3913 has a chip address of 60'h, which is set by a metal mask option.

**I<sup>2</sup>C Chip Address**



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### I<sup>2</sup>C Write Cycle

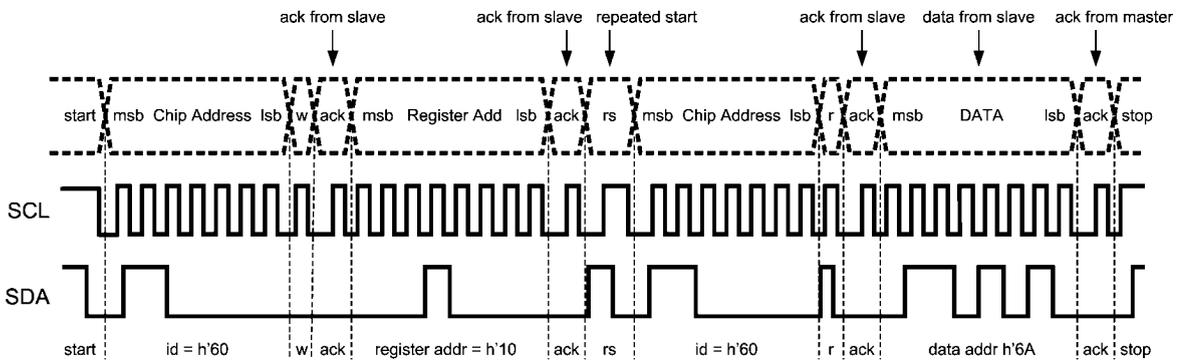


w = write (I<sup>2</sup>C\_SDA = "0")  
 r = read (I<sup>2</sup>C\_SDA = "1")  
 ack = acknowledge (I<sup>2</sup>C\_SDA pulled down by either master or slave)  
 rs = repeated start  
 id = LP3913 chip address : 60'h

### Register Read Cycle

When a READ function is to be accomplished, a WRITE function must precede the READ function, as shown in the Read Cycle waveform.

### I<sup>2</sup>C Read Cycle



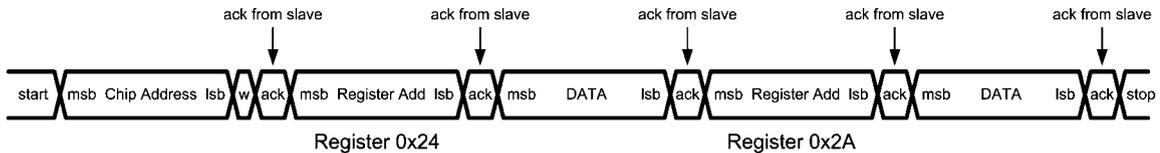
### Multi-byte I<sup>2</sup>C Command sequence

The LP3913's I<sup>2</sup>C serial interface shall support Random register Multi-byte command sequencing: During a multi-byte write the Master sends the Start command followed by the Device address, which is sent only once, followed by the 8-bit register address, then 8 bits of data. The I<sup>2</sup>C slave must then accept the next random register address followed by 8 bits of data and continue this process until the master sends a valid stop condition.

A Typical Multi-byte random register transfer is outlined below:

Device Address, Register A Address, Ack, Register A Data, Ack Register M Address, Ack, Register M Data, Ack Register X Address, Ack, Register X Data, Ack Register Z Address, Ack, Register Z Data, Ack, Stop

**Note:** the PMIC is not required to see the I<sup>2</sup>C device address for each transaction. A, M, X, and Z are random numbers

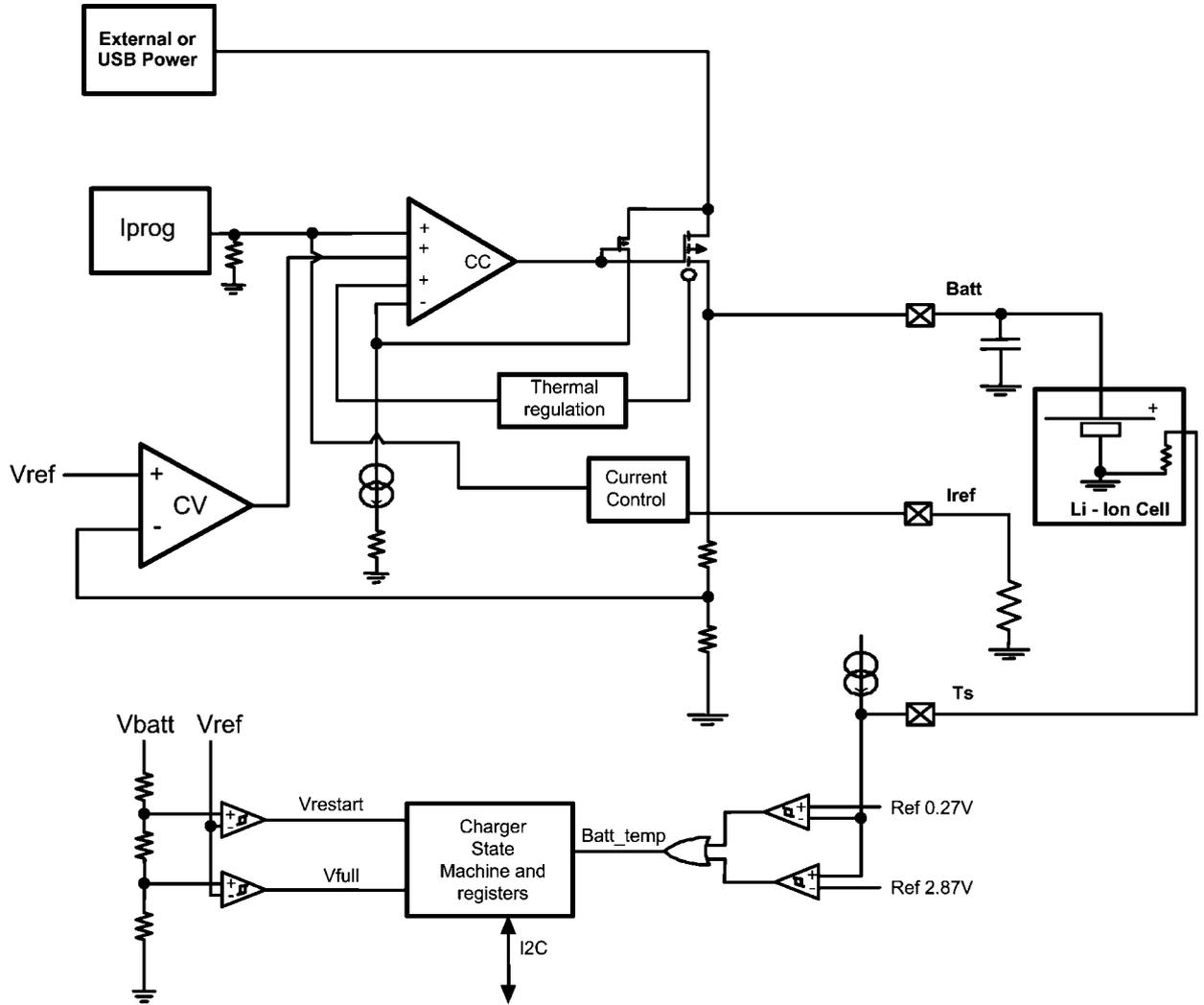


**LI-ION LINEAR CHARGER**

**Charger Architecture**

The LP3913 can safely charge and maintain a single cell Li-Ion/Polymer battery operating off a regulated 6V Car adapter,

AC wall adapter, or USB power (VBUS). Input power source selection of USB/adapter is seamless. If present, the charger will use the adapter power regardless of the presence of USB power. The connection of either power source is detected by LP3913.

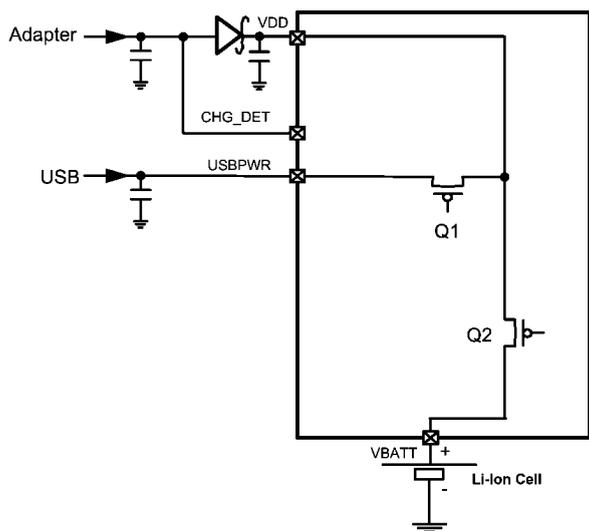


CV: Constant Voltage regulation  
 CC: Constant Current regulation

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The charger module is a linear charger with constant current pre-qualification, constant current (“CC”) full-rate charging and constant voltage (“CV”) charging. CC and CV regulation is performed using an internal Power FET Q2 with reverse current blocking. The termination voltage is controlled to within  $\pm 0.35\%$  at room temperature.

The power FET Q1 acts as a switch with programmable current limit for USB operation.



### Charge Status Indication

Two LEDs connected to the LP3913 are used to indicate the status of the charging. The CHG pin is connected to a red LED that is enabled when an external power source is connected and the battery is charging. The second STAT pin is connected to a green LED. When the battery charging transitions from CC to CV mode, then the green LED is blinking with a 50% duty cycle and a period of 1 second. When the battery is fully charged, then the green LED is always on.

Both LEDs are off when there is no external power connected. Truth table for the LED status indicators.

| Condition         | RED LED | GREEN LED |
|-------------------|---------|-----------|
| No Charger or USB | OFF     | OFF       |
| Charger off       | ON      | OFF       |

### CHCTL Register (01)h Charger Control Register

|        | D7–6  | D5–2  | D1                        | D0                          |
|--------|---|---|---------------------------|-----------------------------|
| Access | rw  |   |                           |                             |
| Data   | <b>Termination voltage</b>  | <b>I<sub>CC</sub>: Full Rate Charge current</b>   | <b>Charger enable</b>     | <b>End of Charge Select</b> |
|        | 00: 4.1V (Li Ion)<br>01: 4.2V (Li Polymer )<br>10: 4.38V (Li Polymer)<br>11: reserved | 0000: 100 mA<br>0001: 200 mA<br>0010: 300 mA<br>0011: 400 mA<br>0100: 500 mA<br>0101: 600 mA<br>0110: 700 mA<br>0111: 800 mA<br>1000: 900 mA<br>1001: 1000 mA | 0: disabled<br>1: enabled | 0: 5%<br>1: 10%             |
| Reset  | 01  | 0000  | 1                         | 1                           |

### BATTERY CHARGER OPERATING MODES

#### Pre-Qualification Mode

Lithium batteries cannot be subjected to a high current when the battery voltage is under a certain threshold, otherwise the longevity of the battery would be compromised. Below this threshold of  $V_{FULLRATE}$ , which typically measures 2.85V, the charger circuit supplies a pre-qualification charge current. If the wall adapter is charging the battery, the charger circuit

| Condition                              | RED LED        | GREEN LED      |
|--|----------------|----------------|
| Pre-Qualification                      | ON             | OFF            |
| Constant Current CC                    | ON             | OFF            |
| Constant Voltage CV                    | ON             | 50% duty cycle |
| EOC / Top-OFF charging                 | ON             | ON             |
| Charge cycle complete                  | ON             | ON             |
| ERROR (Battery Temp, Thermal shutdown) | 50% duty cycle | OFF            |
| Safety Timer Expired                   | 50% duty cycle | OFF            |

50% duty cycle indicates the LED is pulsed on/off for equal times at a frequency of 1 Hz.

The RED pin and GREEN pin are connected to a regulated driver to ensure that the brightness is independent from the external power. The LEDs need to be connected between the CHG / STAT pins and GND.

#### Thermal Charger Power FET Regulation

The internal power FET Q2 in the linear charger module is thermally regulated to the junction temperature of 115°C to guarantee optimal charging of the battery. The charge current is limited by the charge current selected in the Charger Control Register but is also thermally limited to prevent the junction from overheating during high charge currents at high ambient temperatures as the package power dissipation is limited.

Thermal regulation guarantees maximum charge current and superior charge rate without exceeding the power dissipation limits of LP3913.

supplies a constant current of 10% of the programmed charge current. If the USB is charging the battery, the charger circuit supplies a constant 50 ma charge current. When the battery voltage reaches  $V_{FULLRATE}$ , the charger transitions from pre-qualification to full-rate charging. In Pre-qualification mode, the STAT2, STAT1, and STAT0 bits in the charger supervisory register are respectively low, low, high.

**Full-Rate Charging Mode**

The full-rate charge cycle is initiated following the successful completion of the pre-qualification mode. During Full-Rate charging, the battery voltage steadily increases while charged with a constant current (CC). The three charger status bits STAT2, STAT1 and STAT0 are respectively low, high, and low. The full-rate charge current is selected using the Charge Control Register, which defaults to 100 mA.

It is recommended to charge Li-Ion batteries at a rate of 1C, where “C” is the capacity of the battery. As an example, it is recommended to charge a battery with a capacity of 800 mAh at 800 mA, or 1C. Charging at a higher rate may compromise the quality and lifetime of the battery.

**Constant-Voltage (CV) Charging Mode**

The battery voltage increases rapidly as a result of full-rate charging and once it reaches the programmable termination voltage of either 4.1V, 4.2V or 4.38V, the charger will move to constant-voltage charge mode. During this mode, the charge current gradually decreases while the battery remains at the termination voltage. The termination voltage can be selected to be either 4.1V, 4.2V or 4.38V by programming bits

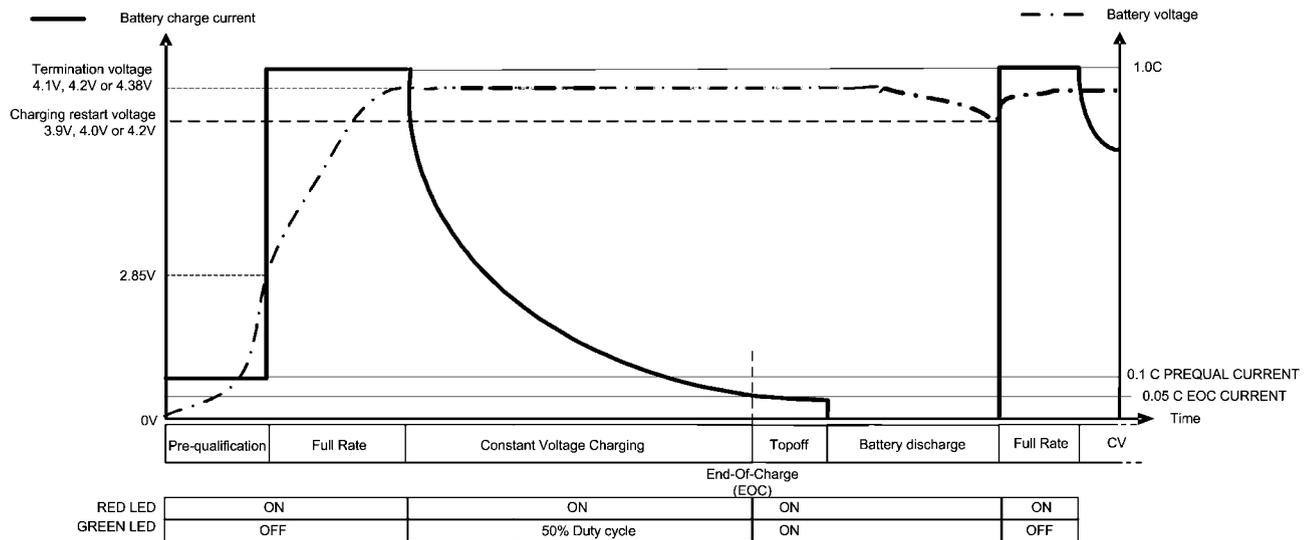
D6 and D7 in the Charger Control register to accommodate different battery chemistries. In CV charging mode, the Charge Control Status bits STAT2, STAT1 and STAT0 are respectively logic 0, logic 1 and logic 1.

**TOP-OFF Charging Mode**

When the charge current reduces to the EOC threshold (programmable to 5% or 10% of programmed full rate charge current), constant voltage charging will continue for an additional 21 minute TOP-OFF time period. In TOP-OFF charging mode, the Charge Control Status bits STAT2, STAT1 and STAT0 are respectively logic 1, logic 1 and logic 1. At the end of the TOP-OFF period, the charger transitions to Charge Cycle Complete.

**Charge Cycle Complete**

During Charge Cycle Complete, the charger is automatically disabled, regardless of the state of the Charge Enable Bit. In Charge Cycle Complete, the STAT2, STAT1 and STAT0 bits are respectively logic 1, logic 0 and logic 1. When the Battery Voltage drops below the  $V_{RESTART}$  threshold, charging will resume in Full-Rate Charging Mode.



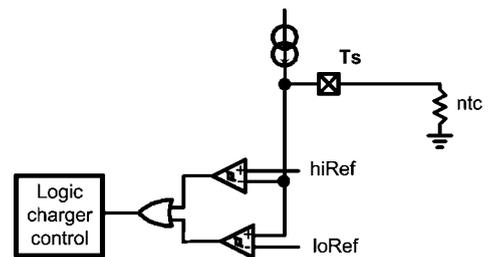
**Battery Temperature Monitoring ( $T_S$  pin)**

The LP3913 is equipped with a battery thermistor terminal to continuously monitor the battery temperature by measuring the voltage between the  $T_S$  pin and GND. With the  $T_S$  pin connected to the battery thermistor, charging is allowed only if the battery temperature is within the acceptable temperature range set by a pair of internal comparators inside the LP3910. The temperature window is 0°C–45°C or 0°C–50°C, depending on the setting of D2 of the Charger Supervisor (CHSPV) register. There is 3°C of temperature hysteresis associated with each temperature threshold. The default temperature range is 0°C–50°C and can be changed to 0°C–45°C by setting bit D3 in the CHSPV register. If the battery temperature is out of range, STAT2, STAT1 and STAT0 bits in the CHSPV Register are set to logic1, logic0, logic0, and charging is suspended.

The  $T_S$  pin is only active during charging and draws no current from the battery when no external power source is present.

If the  $T_S$  pin is not used in the application, it should be connected to GND through a 100 k $\Omega$  pull-down resistor.

When the  $T_S$  pin is left floating (battery removal), then the charger will be disabled as the  $T_S$  voltage exceeds the lower temperature limit.



**Disabling Charger**

Charging can be safely interrupted by clearing the Charge enable bit D1 in the Charge Control Register and can subsequently resume upon setting this bit. When the charger is disabled, STAT2, STAT1, and STAT0 bits in the CHSPV register are set to logic 0.

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### Safety Timer

In order to prevent endless charging, which could degrade the battery quality and life time, the LP3913 contains a safety timer that limits charging regardless whether the battery has reached its full capacity or not. In prequalification the safety timer is 1 hour. In full rate or constant voltage charging the safety timer is a maximum of 10 hours minus the time in prequalification.

When the timer times out of uninterrupted charging, an IRQ is generated to alert system processor. The status of the timer can also be polled by reading the IRQ register if the system doesn't support hardware interrupts.

The Safety timer resets and starts counting from zero upon the following events:

1. Power ON (through connecting valid power to either USBPWR or CHGN\_IN pins).
2. Interchanging USBPWR and CHG\_IN sources
3. The voltage of a charged battery drops below the restart value and the charger is enabled
4. Disabling and re-enabling of the charger by toggling bit D1 of the Charge Control Register

### CHSPV Register (02)h Charger Supervisor Register

|        | D7–6            | D5  | D4   | D3   | D2–0  |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
|--------|-----------------|---|--|--|---|-------|-------|-------|--|---|---|---|----------------|---|---|---|------------------|---|---|---|---------------------------|---|---|---|---------------------------|---|---|---|-------|---|---|---|-----------------------|---|---|---|----------------------|---|---|---|---------------|
| Access | Read only       | r/w                                       | r/w  | r/w  |   |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
| Data   | <b>Reserved</b> | <b>LED Current</b><br>0: 5 mA<br>1: 10 mA | <b>LED ENABLE</b><br>0: Disabled<br>1: Enabled | <b>Battery temperature range</b><br>0: 0°C–50°C<br>1: 0°C–45°C | <b>Charger status</b><br><br><table border="1"> <thead> <tr> <th>Stat2</th> <th>Stat1</th> <th>Stat0</th> <th></th> </tr> </thead> <tbody> <tr> <td>0</td> <td>0</td> <td>0</td> <td>Charger is off</td> </tr> <tr> <td>0</td> <td>0</td> <td>1</td> <td>Prequalification</td> </tr> <tr> <td>0</td> <td>1</td> <td>0</td> <td>Constant current charging</td> </tr> <tr> <td>0</td> <td>1</td> <td>1</td> <td>Constant voltage charging</td> </tr> <tr> <td>1</td> <td>0</td> <td>0</td> <td>Error</td> </tr> <tr> <td>1</td> <td>0</td> <td>1</td> <td>Charge cycle complete</td> </tr> <tr> <td>1</td> <td>1</td> <td>0</td> <td>Safety Timer Expired</td> </tr> <tr> <td>1</td> <td>1</td> <td>1</td> <td>EOC / Top-off</td> </tr> </tbody> </table> | Stat2 | Stat1 | Stat0 |  | 0 | 0 | 0 | Charger is off | 0 | 0 | 1 | Prequalification | 0 | 1 | 0 | Constant current charging | 0 | 1 | 1 | Constant voltage charging | 1 | 0 | 0 | Error | 1 | 0 | 1 | Charge cycle complete | 1 | 1 | 0 | Safety Timer Expired | 1 | 1 | 1 | EOC / Top-off |
| Stat2  | Stat1           | Stat0                                     |  |  |   |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
| 0      | 0               | 0   | Charger is off                                 |  |   |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
| 0      | 0               | 1   | Prequalification                               |  |   |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
| 0      | 1               | 0   | Constant current charging                      |  |   |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
| 0      | 1               | 1   | Constant voltage charging                      |  |   |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
| 1      | 0               | 0   | Error  |  |   |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
| 1      | 0               | 1   | Charge cycle complete                          |  |   |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
| 1      | 1               | 0   | Safety Timer Expired                           |  |   |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
| 1      | 1               | 1   | EOC / Top-off                                  |  |   |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |
| Reset  | n/a             | 1   | 1  | 0  | 2'b000  |       |       |       |  |   |   |   |                |   |   |   |                  |   |   |   |                           |   |   |   |                           |   |   |   |       |   |   |   |                       |   |   |   |                      |   |   |   |               |

### POWER ROUTING

The LP3913 power can originate from three different sources: Adapter power, USB power or battery power. The objective of the power routing is to be able to:

- Operate the portable system from external power regardless of the battery voltage.
- Operate the portable system from USBPWR when the battery exceeds the Full Rate Qualification Threshold voltage (Vfullrate).
- Concurrently charging and operating the system when external power is present
- Seamless selection of Adapter or USB power as the primary external power source

Power Routing supports 4 modes:

5. Emerging from Thermal Shutdown
6. Emerging from a battery temperature out-of-range and the charger is enabled
7. Emerging from USB suspend mode when charging with USB power

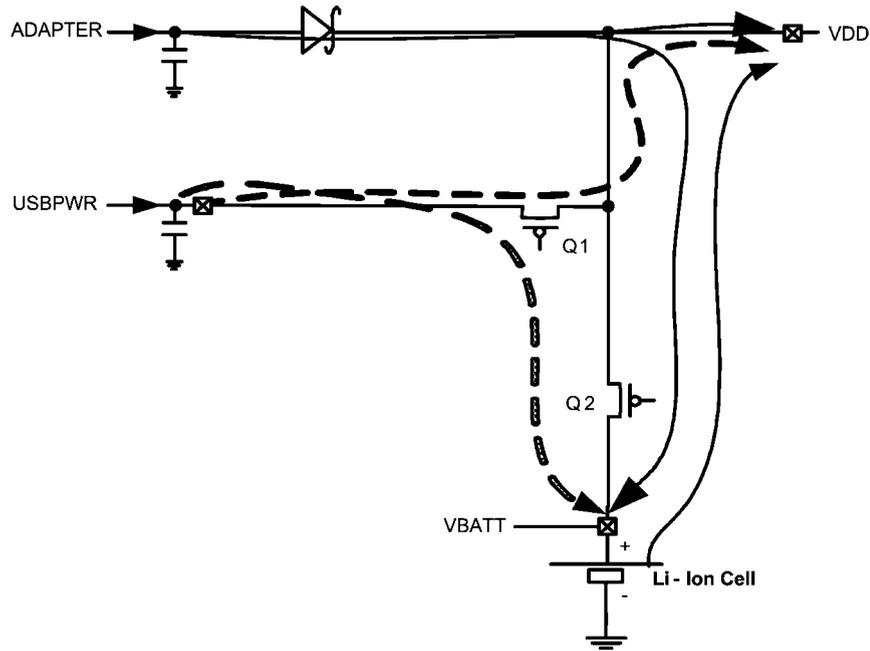
### Charging Maintenance

When a fully charged battery is being loaded by the system while the external power is present and while bit D1 in the charge control register is set to a 1 (Charge enable) then the charging will restart when the battery voltage drops below the charging restart threshold. The value of the threshold depends on the termination voltage according to the following table:

| Vterm | Charging restart voltage |
|-------|--------------------------|
| 4.1V  | 3.9V                     |
| 4.2V  | 4.0V                     |
| 4.38V | 4.2V                     |

1. A regulated external adapter power is present and concurrently supplies the system power and the battery charger.
2. USB power is present and supplies the system and the battery.
3. USB power is present but the system demand exceeds the USB current limit, so that the battery provides the additional power to operate the system.
4. The battery is the sole supply source to the system when no external power source is present

The current flows in the different modes are realized through internal FETS and an external Schottky as illustrated as follows:



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The current provided by the external adapter power or USB power, when inserted, first supplies the system load; the remainder is used for charging.

The different paths are configured through two internal power FETs, Q1 and Q2, and an external Schottky diode. Q1 is a Power FET that is only active during USB charging. Q2 functions either as a linear Power FET during charging or as a low  $R_{DS(ON)}$  switch when no external power is present and the battery discharges to supply power to the system.

| Power Route                                 | Q1  | Q2        |
|---|-----|-----------|
| Regulated adapter supply & battery charging | OFF | Regulated |
| USB supply & battery charging               | ON  | Regulated |
| No external supply & battery discharging    | OFF | ON        |

The Power Routing function will allocate power to the system through the  $V_{DD}$  pin and to the battery.  $V_{DD1}$ ,  $V_{DD2}$ ,  $V_{DD3}$ ,  $V_{IN1}$ ,  $V_{IN2}$ ,  $V_{IN3}$ , and  $V_{IN4}$  must be connected together externally.  $V_{BATT1}$ ,  $V_{BATT2}$ , and  $V_{BATT3}$  must be connected together externally.

**USB SUSPEND MODE**

The LP3913 USB current consumption can be disabled during suspend mode through a dedicated pin (USBSUSP).

**$I_{LIMIT}$  REGISTER (03)h CURRENT LIMIT REGISTER**

|        | D7-2            | D1-0  |
|--------|-----------------|---|
| Access | Read only 0     |   |
| Data   | <b>Reserved</b> | <b>USB Current Limit</b>  |
|        |                 | 00: controlled by $USB_{ISEL}$ pin<br>[low = 100 mA, high = 500 mA]<br>01: 100 mA<br>10: 500 mA<br>11: 800 mA |
| Reset  | n/a             | 2'b00   |

Applying a logic 1 to this pin will disable the USB current path and current is reduced to input leakage current less than 30  $\mu A$  on the USBPWR pin.

**SETTING THE USB CURRENT LIMIT**

The USB current that is available from the USB on the VBUS wire is limited by default to 100 mA. More current (up to 800 mA) can be negotiated through a session request protocol between host and peripheral. The USB current limit needs to be signaled to the LP3913 by means of the  $USB_{ISEL}$  pin or the  $I_{LIMIT}$  Register as indicated below.

If the USB current limit is 100 mA then the USB controller of the peripheral system needs to set the  $USB_{ISEL}$  logic 0 or by setting the  $I_{LIMIT}$  register bits [D1, D0] to 2'b00.

If the USB current limit is 500 mA, then the USB controller needs to apply logic 1 to the  $USB_{ISEL}$  pin or change the  $I_{LIMIT}$  register accordingly. Under this condition, the LP3913 will allow charging with a charge current that is determined by the Charge Control Register, not exceeding 500 mA.

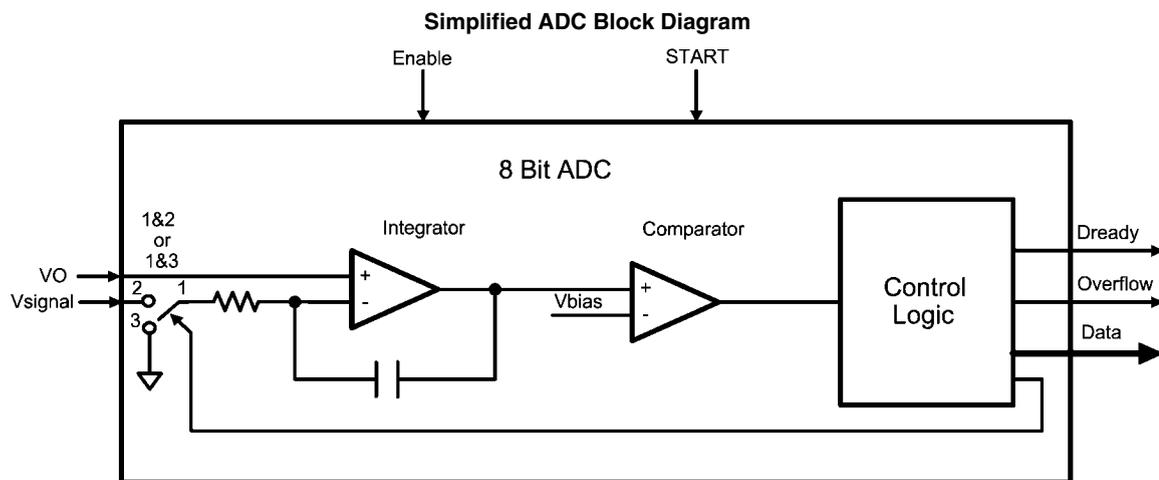
The LP3913 will prevent (through internal circuitry) the charge current from exceeding the USB current limit, even if the current setting in the Charge Control Register exceeds 500 mA.

The controller can also select a USB current limit of 800 mA through I<sup>2</sup>C that exceeds current USB spec values.

## ANALOG TO DIGITAL CONVERTER

LP3913 is equipped with an 8-bit dual-slope integrating analog to digital converter. Dual-slope converters provide effective filtering of >500 kHz and <125 kHz noise components on the input voltage, and does not require a sample and hold stage. The A/D converter core digitizes the input voltage ranging from  $V_{REF}$  to  $2V_{REF}$ , where  $V_{REF}$  is the voltage mea-

sured on the  $V_{REFH}$  pin. After an initial 2 ms warm-up for the first activation of the ADC enable bit, the dual-slope converter integrates the input signal during the first phase for approximately 2 ms, followed by a second phase that integrates  $V_{REF}$  for 0 ms to 2 ms depending on the level of the input signal. As a result the total conversion time varies from 2 ms to 4 ms.



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The A/D converter multiplexes 4 different sources:

1. The battery voltage
2. The battery charge current
3. External source ADC1
4. External source ADC2

The voltage ranges for the first two sources are scaled to match the input voltage interval of the A/D converter:  $[V_{REFH}, 2V_{REFH}]$ . This is accomplished by using two internal scalars.

### Battery Voltage Measurement

The battery voltage scalar transforms the battery voltage ranging from 2.6V–3.5V to the reference voltage interval:  $[V_{REFH}, 2*V_{REFH}]$ . A wider voltage range (2.6V–4.4V) can be selected through I<sup>2</sup>C by setting the voltage range bit D7 in register 0xA to 0'b1.

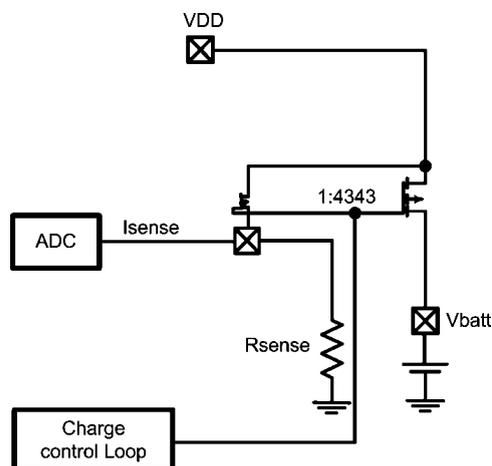
### Battery Charge Current Measurement

The battery charge current is indirectly measured by measuring the voltage across the  $I_{SENSE}$  resistor. A fixed portion of the battery charge current is mirrored over the  $I_{SENSE}$  resistor and hence:

$$V_{I_{SENSE}} = K * I_{CHARGE}$$

where K is a ratio between the  $R_{SENSE}$  current and the charge current.

The battery charge current scalar transforms the voltage across the external  $I_{SENSE}$  resistor to the  $[V_{REFH}, 2*V_{REFH}]$  input voltage interval of the A/D converter.

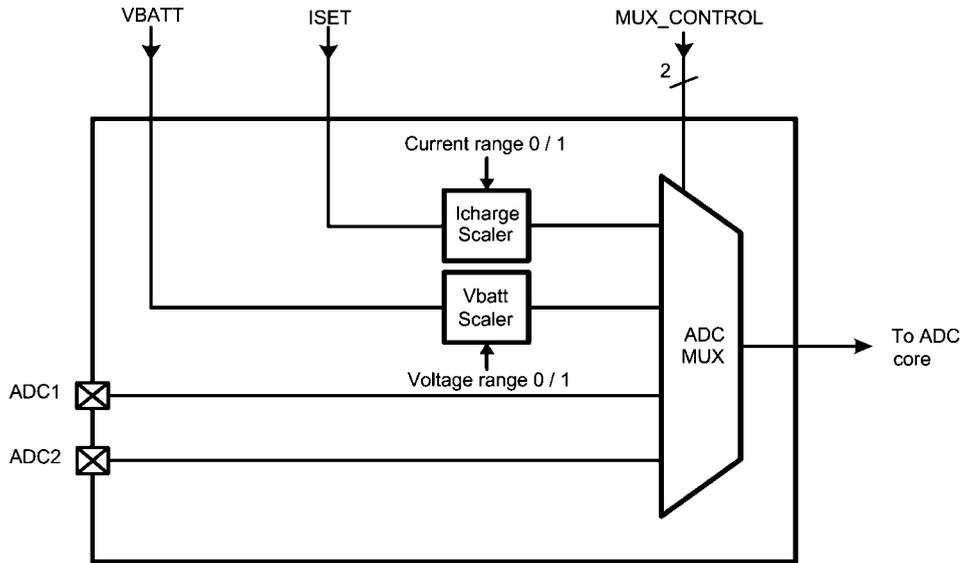


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### External General Purpose Sources

Two additional A/D converter sources are available on the ADC1 and ADC2 pins of the LP3913. These two external A/D converter sources are not internally scaled and have an input voltage range of  $[V_{REFH}, 2*V_{REFH}]$ . The system designer can use these two sources for general purpose applications such as resistive keyboard matrix scanning, temperature measurements, battery load current, battery ID resistor measurement, etc.

ADC Analog Front End Block Diagram



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The source selection and the access to the conversion results are established through the I<sup>2</sup>C linked control registers: ADCC and ADCD as described below:

**ADCC Register (0a)h A/D Converter Control Register**

|        | D7   | D6  | D5   | D4   | D3   | D2   | D1–0   |
|--------|--|---|--|--|--|--|--|
| Access | r/w  | r/w   | Read Only  |  | r/w  | r/w  |  |
| Data   | V <sub>RANGE</sub><br>0: 2.6V–3.5V<br>1: 2.6V–4.4V | I <sub>RANGE</sub><br>0: 0 mA–605 mA<br>1: 0 mA–1100 mA | <b>ADC Overflow</b><br>0: no overflow<br>1: overflow | <b>Data Ready</b><br>0: no data<br>1: data ready | <b>Start Conversion</b><br>0: default<br>1: start conversion | <b>ADC Enable</b><br>0: Disabled<br>1: Enabled | <b>ADC source selection</b><br>00: battery voltage<br>01: battery charge current<br>10: ADC1<br>11: ADC2 |
| Reset  | 0  | 0   | 0  | 0  | 0  | 0  | 0  |

**ADCD Register (0b)h A/D Converter Output Data Register**

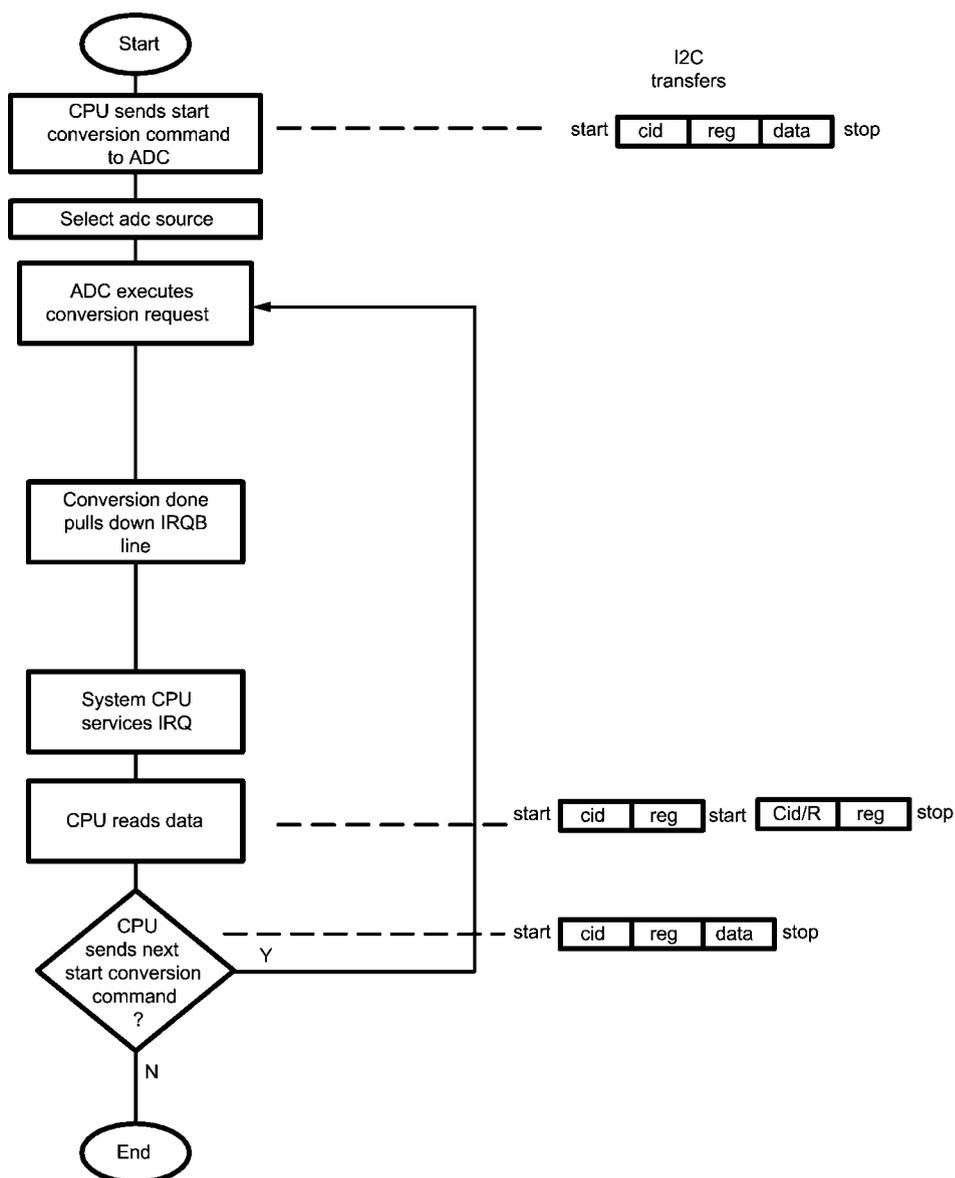
Charge current 0A to 1.1A mirrored to 0 μA to 250 μA, ADC measures voltage drop across R<sub>SENSE</sub> 4.64 kΩ.

|        | D7–0                               |  |  |
|--------|------------------------------------|--|--|
| Access | Read Only 0                        |  |  |
| Data   | Battery voltage:                   | 8'h00 = 2.6V   | 8'hFF = 3.5V    1 LSB = 0.9 / 256 = (3.5 mV) range 0                     |
|        |                                    | 8'h00 = 2.6V   | 8'hFF = 4.4V    1 LSB = 1.8 / 256 = (7.0 mV) range 1                     |
|        | Battery charge current             | 8'h00 = 0  | 8'hFF = 0.6463V = 605 mA    range 0                                      |
|        |                                    | 8'h00 = 0  | 8'hFF = 1.175V = 1100 mA    range 1                                      |
|        | ADC1:                              | 8'h00 = V <sub>REFH</sub> = 1.225V                                       | 8'hFF = 2*V <sub>REFH</sub> = 2.45 V    (1 LSB = V <sub>REFH</sub> /256) |
| ADC2:  | 8'h00 = V <sub>REFH</sub> = 1.225V | 8'hFF = 2*V <sub>REFH</sub> = 2.45 V    (1 LSB = V <sub>REFH</sub> /256) |  |
| Reset  | 8'h00                              |  |  |

The ADC is by default disabled to minimize current consumption and needs to be enabled by setting D2 in the ADCC register. Writing a logic 1 to bit D3 in the ADC will initiate a conversion. It is advised to select the correct ADC source before a conversion is started. The A/D converter will set bit D4 in the ADCC register upon the completion of a conversion, which is typically 4 ms after the start of the conversion. At the

same time an interrupt request will be generated. (See Interrupt Request Register).

To save power, disable the ADC by setting bit 2 of D2 to 0. To make repetitive starts, set bit D3 to 0 then to 1 for register 0Ah to initiate start of conversion. The interrupt driven protocol between LP3913 and the system processor is the most efficient way to acquire data from successive measurements:



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## Interrupt Request Output

The LP3913 has the ability to interrupt the system processor through the open drain IRQB pin, which transitions to an active logic low level upon the following 8 events:

- USB Power detected
- USB disconnected
- CHG\_IN Power detected
- CHG\_IN Disconnected
- Battery low alarm
- Thermal Alarm
- ADC conversion completed
- Charger safety timer time-out

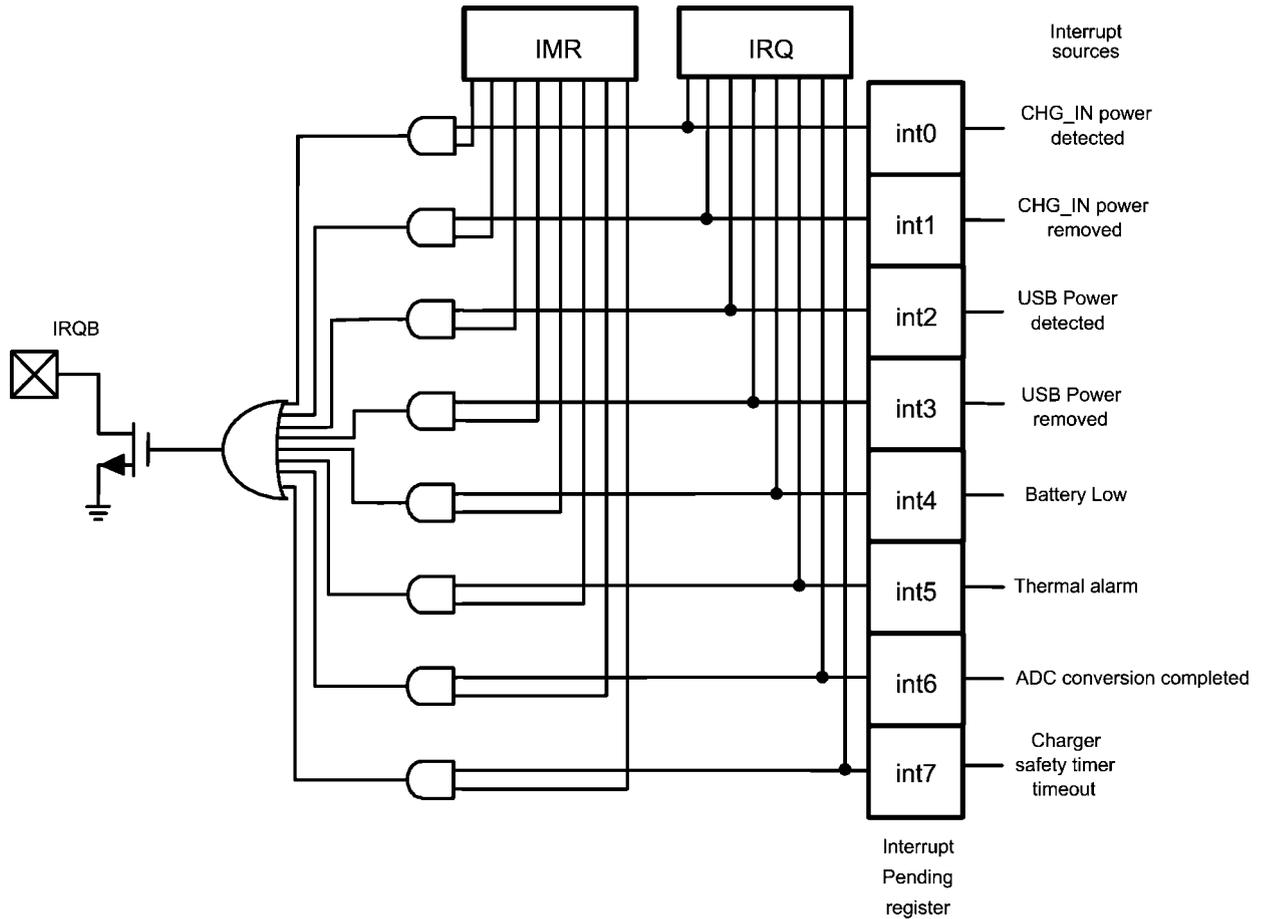
The events form the interrupt sources that correspond to a certain bit location in the Interrupt Request (IRQ) Register. All interrupt sources can be masked by the Interrupt Mask Register (IMR). Masking the interrupt prevents the interrupt event from asserting the IRQB pin, yet the event will still be captured

in the IRQ register, which allows the processor to poll the interrupt sources.

After an active low IRQB has been detected by the system processor, the latter services the interrupt and will access the IRQ register to determine which source was responsible for the interrupt request. Reading the IRQ register will automatically clear the register to enable the capture of the next interrupt events.

As new interrupts can occur while the I<sup>2</sup>C read cycle is clearing the IRQ register, a buffer register called Interrupt Pending Register (IPR), not accessible through the I<sup>2</sup>C compatible interface holds the next interrupts. De-asserting the IRQB output is immediately followed by a new transition of IRQB to logic low when an interrupt is pending.

The Interrupts are not hardware prioritized. It is up to the firmware to determine the priority in case more than one Interrupt Request is set.



**INTERRUPTS AND STANDBY MODE**

Interrupts are captured in standby mode and can be serviced when the system processor is enabled when the LP3913 is in an active state.

**INTERRUPT SOURCES**

**CHG\_IN Power Detected and CHG\_IN Disconnect (INT0 and INT1)** An interrupt (INT0) is generated when CHG\_IN power is connected to the LP3913. Another interrupt (INT1) will be generated upon CHG\_IN power removal.

**USB Power Detected and USB Disconnect (INT2 and INT3)** An interrupt (INT2) is generated when USB power is connected to the LP3913. Another interrupt (INT3) will be generated upon disconnecting the USB power.

**Battery Low (INT4)** When the battery voltage drops below the battery low threshold IRQ, an interrupt will be generated. This allows the processor to perform some housekeeping tasks prior to going to standby mode.

**Thermal Alarm (INT5)** If the Junction Temperature of the LP3913 exceeds 115°C, then an interrupt will be generated

**ADC Conversion Done (INT6)** The ADC generates an interrupt request upon the completion of a data conversion.

**DC/DC Converters**

**OVERVIEW**

The LP3913 provides the DC/DC converters that supply the various power needs of the application by means of one

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**Charger Timer Interrupt (INT7)** A charger timeout will occur 10 hours after it started (see Li-Ion Charger section) and will subsequently request an interrupt.

**IMR REGISTER (0C)H INTERRUPT MASK REGISTER**

|        |  |
|--------|--|
|        | D7-0   |
| Access | r/w  |
| Data   | 1: Enable INTn (n=0...7) to pull IRQB low<br>0: Mask Interrupt source INTn |
| Reset  | 8'h00  |

**IRQ REGISTER (0d)h INTERRUPT REQUEST REGISTER**

|        |  |
|--------|--|
|        | D7-0   |
| Access | Read only  |
| Data   | 1: Interrupt IRQn (n=0...7) requested<br>0: No interrupt requested |
| Reset  | 8'h00  |

Buck3 (HDD driver), two Linear Low Drop Regulators (LDO1, LDO2) and two Buck converters (BUCK1, BUCK2).

The table hereunder lists the output characteristics of the various regulators.

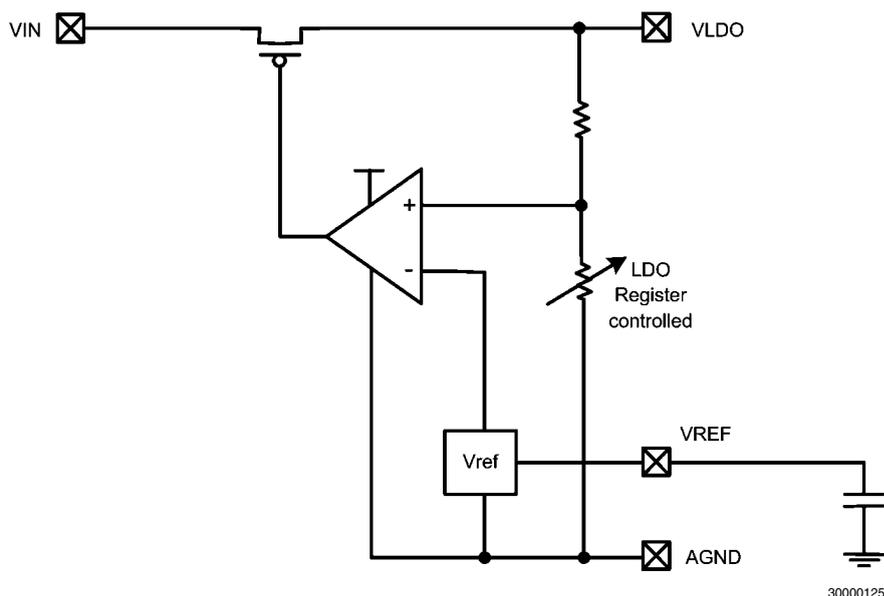
## SUPPLY SPECIFICATION

| Supply | Load                | $V_{OUT}$ (Volts) |            |                 | $I_{MAX}$ Maximum Output Current (mA) |
|--------|---------------------|-------------------|------------|-----------------|---------------------------------------|
|        |                     | Default (V)       | Range (V)  | Resolution (mV) |                                       |
| LDO1   | various             | 2.0               | 1.2 to 3.3 | 100             | 150                                   |
| LDO2   | analog              | 3.3               | 1.3 to 3.3 | 100             | 150                                   |
| BUCK1  | CPU, DSP            | 1.2               | 0.8 to 2.0 | 50              | 600                                   |
| BUCK2  | IO, Logic, Memories | 3.3               | 1.8 to 3.3 | 100             | 600                                   |
| BUCK3  | Flash               | 3.3               | 1.8 to 3.3 | 50              | 500                                   |

## LINEAR LOW DROP-OUT REGULATORS (LDOS)

LDO1 is a regulator that can respond to fast transients and is slated for digital loads and high bandwidth analog loads. LDO2 is a linear regulator with a similar architecture but has a slower transient response time with a lower noise perfor-

mance to supply analog loads. The output voltages of both LDOs are register programmable through the I<sup>2</sup>C interface. The default output voltages are factory programmed during Final Test.



## NO-LOAD STABILITY

The LDOs will remain stable and in regulation with no external load. This is an important consideration in some circuits, for example CMOS RAM keep-alive applications.

**LDO1 CONTROL REGISTER**

LDO1 can be configured through its own I<sup>2</sup>C control register. The output voltage is programmable in steps of 100 mV from 1.2V to 3.3V. LDO1 gets enabled during the power-on sequence. Disable/enable control is provided through bit D5 in

the LDO1 control register after selecting the appropriate D4–0 settings, which determine the output voltage.

The output voltage can be altered while LDO1 is enabled. When LDO1 is disabled it shunts the output to AGND with a  $R_{SHUNT} = 200\Omega$  (Max.).

**LDO1 CONTROL REGISTER (08)h**

|             | D7–6        | D5                                   | D4–0                           |     |
|-------------|-------------|--------------------------------------|--------------------------------|-----|
| Access      | Read Only 0 | R/W                                  |                                |     |
| Data        | Reserved    | Operation<br>0: disable<br>1: enable | <b>LDO1 Output Voltage (V)</b> |     |
|             |             |                                      | 5'h00                          | 1.2 |
|             |             |                                      | 5'h01                          | 1.3 |
|             |             |                                      | 5'h02                          | 1.4 |
|             |             |                                      | 5'h03                          | 1.5 |
|             |             |                                      | 5'h04                          | 1.6 |
|             |             |                                      | 5'h05                          | 1.7 |
|             |             |                                      | 5'h06                          | 1.8 |
|             |             |                                      | 5'h07                          | 1.9 |
|             |             |                                      | 5'h08                          | 2.0 |
|             |             |                                      | 5'h09                          | 2.1 |
|             |             |                                      | 5'h0A                          | 2.2 |
|             |             |                                      | 5'h0B                          | 2.3 |
|             |             |                                      | 5'h0C                          | 2.4 |
|             |             |                                      | 5'h0D                          | 2.5 |
|             |             |                                      | 5'h0E                          | 2.6 |
|             |             |                                      | 5'h0F                          | 2.7 |
| 5'h10       | 2.8         |                                      |                                |     |
| 5'h11       | 2.9         |                                      |                                |     |
| 5'h12       | 3.0         |                                      |                                |     |
| 5'h13       | 3.1         |                                      |                                |     |
| 5'h14       | 3.2         |                                      |                                |     |
| 5'h15–5'h1F | 3.3         |                                      |                                |     |
| Reset       | n/a         | 1                                    | 5'h08                          |     |

**LDO2 CONTROL REGISTER**

LDO2 can be configured through its own I<sup>2</sup>C control register. The output voltage is programmable in steps of 100mV from 1.3V to 3.3V. LDO2 is by default disabled and can be enabled by setting bit D5 in the control register after selecting the appropriate D4–0 settings, which determine the output voltage. LDO2 can also be enabled through the external LDO2EN pin, which is the default enable control. With a logic 0 programmed to bit D5 in the corresponding control register, enable/disable control is passed onto the LDO2EN pin; a logic 1 applied to this pin enables LDO2 while a logic 0 disables the LDO2. Setting D5 to 1 in the LDO2 control register enables LDO2,

regardless of the state of the LDO2EN pin. If the system designer permanently connects the LDO2EN pin to GND, then D5 is simply a enable/disable control bit. If the system design permanently connects the enable pin to V<sub>DD</sub>, then the LDO is enabled during the power-on sequence and will always be on, regardless of the state of bit D5 in the LDO2 control register. In that particular case, the LDO2 is sequenced with the same timing as LDO1 (see Power On sequencing).

The output voltage can be altered while LDO2 is enabled. When LDO2 is disabled it shunts the output to A<sub>GND</sub> with a R<sub>SHUNT</sub> = 200Ω (Max.).

**LDO2 CONTROL REGISTER (09)h**

|        | D7–6            | D5  | D4–0                          |     |
|--------|-----------------|---|-------------------------------|-----|
| Access | Read Only 0     | R/W   |                               |     |
| Data   | <b>Reserved</b> | <b>Operation</b><br>0: enable/ disable<br>determined by state of<br>LDO2EN pin<br>1: enable, override<br>LDO2EN state | <b>LDO1 OutputVoltage (V)</b> |     |
|        |                 |   | 5'h00                         | 1.3 |
|        |                 |   | 5'h01                         | 1.4 |
|        |                 |   | 5'h02                         | 1.5 |
|        |                 |   | 5'h03                         | 1.6 |
|        |                 |   | 5'h04                         | 1.7 |
|        |                 |   | 5'h05                         | 1.8 |
|        |                 |   | 5'h06                         | 1.9 |
|        |                 |   | 5'h07                         | 2.0 |
|        |                 |   | 5'h08                         | 2.1 |
|        |                 |   | 5'h09                         | 2.2 |
|        |                 |   | 5'h0A                         | 2.3 |
|        |                 |   | 5'h0B                         | 2.4 |
|        |                 |   | 5'h0C                         | 2.5 |
|        |                 |   | 5'h0D                         | 2.6 |
|        |                 |   | 5'h0E                         | 2.7 |
|        |                 |   | 5'h0F                         | 2.8 |
|        |                 |   | 5'h10                         | 2.9 |
|        |                 |   | 5'h11                         | 3.0 |
|        |                 |   | 5'h12                         | 3.1 |
|        |                 |   | 5'h13                         | 3.2 |
|        |                 |   | 5'h14 –5'h1F                  | 3.3 |
| Reset  | n/a             | 0   | 5'h14                         |     |

## BUCK1, BUCK2: Synchronous Step Down Magnetic DC/DC Converters

### FUNCTIONAL DESCRIPTION

The LP3913, incorporates two high efficiency synchronous switching buck regulators, BUCK1 and BUCK2 that deliver a constant voltage from a single Li-Ion battery to the portable system processors, Memory and I/O. Using a voltage mode architecture with synchronous rectification, both bucks have the ability to deliver up to 600 mA depending on the input voltage and output voltage (voltage head room), and the inductor chosen (maximum current capability).

There are three modes of operation depending on the current required—PWM, PFM, and shutdown. PWM mode handles current loads of approximately 70 mA or higher, delivering voltage precision of  $\pm 3\%$  with 90% efficiency or better. Lighter output current loads cause the device to automatically switch into PFM for reduced current consumption ( $I_Q = 15 \mu\text{A typ.}$ ) and a longer battery life. The Standby operating mode turns off the device, offering the lowest current consumption. PWM or PFM mode is selected automatically or PWM mode can be forced through the setting of the buck control register.

Both BUCK1 and BUCK2 can operate up to a 100% duty cycle (PMOS switch always on). Additional features include soft-start, under-voltage lock-out, current overload protection, and thermal overload protection.

### CIRCUIT OPERATION DESCRIPTION

A buck converter contains a control block, a switching PFET connected between input and output, a synchronous rectifying NFET connected between the output and ground (BCK-GND pin) and a feedback path. During the first portion of each switching cycle, the control block turns on the internal PFET switch. This allows current to flow from the input through the inductor to the output filter capacitor and load. The inductor limits the current to a ramp with a slope of  $V_{IN} - V_{OUT}/L$ .

$$\frac{V_{IN} - V_{OUT}}{L}$$

by storing energy in a magnetic field. During the second portion of each cycle, the control block turns the PFET switch off, blocking current flow from the input, and then turns the NFET synchronous rectifier on. The inductor draws current from ground through the NFET to the output filter capacitor and load, which ramps the inductor current down with a slope of

$$\frac{-V_{OUT}}{L}$$

The output filter stores charge when the inductor current is high, and releases it when low, smoothing the voltage across the load.

### PWM OPERATION

During PWM operation the converter operates as a voltage-mode controller with input voltage feed forward. This allows the converter to achieve excellent load and line regulation. The DC gain of the power stage is proportional to the input voltage. To eliminate this dependence, feed forward voltage inversely proportional to the input voltage is introduced.

### INTERNAL SYNCHRONOUS RECTIFICATION

While in PWM mode, the buck uses an internal NFET as a synchronous rectifier to reduce rectifier forward voltage drop

and associated power loss. Synchronous rectification provides a significant improvement in efficiency whenever the output voltage is relatively low compared to the voltage drop across an ordinary rectifier diode.

### CURRENT LIMITING

A current limit feature allows the buck to protect itself and external components during overload conditions PWM mode implements cycle-by-cycle current limiting using an internal comparator that trips at 1000 mA (typical).

### PFM OPERATION

At very light loads, the converter enters PFM mode and operates with reduced switching frequency and supply current to maintain high efficiency.

The part will automatically transition into PFM mode when either of two conditions occurs for a duration of 32 or more clock cycles:

The inductor current becomes discontinuous or The peak PMOS switch current drops below the  $I_{MODE}$  level

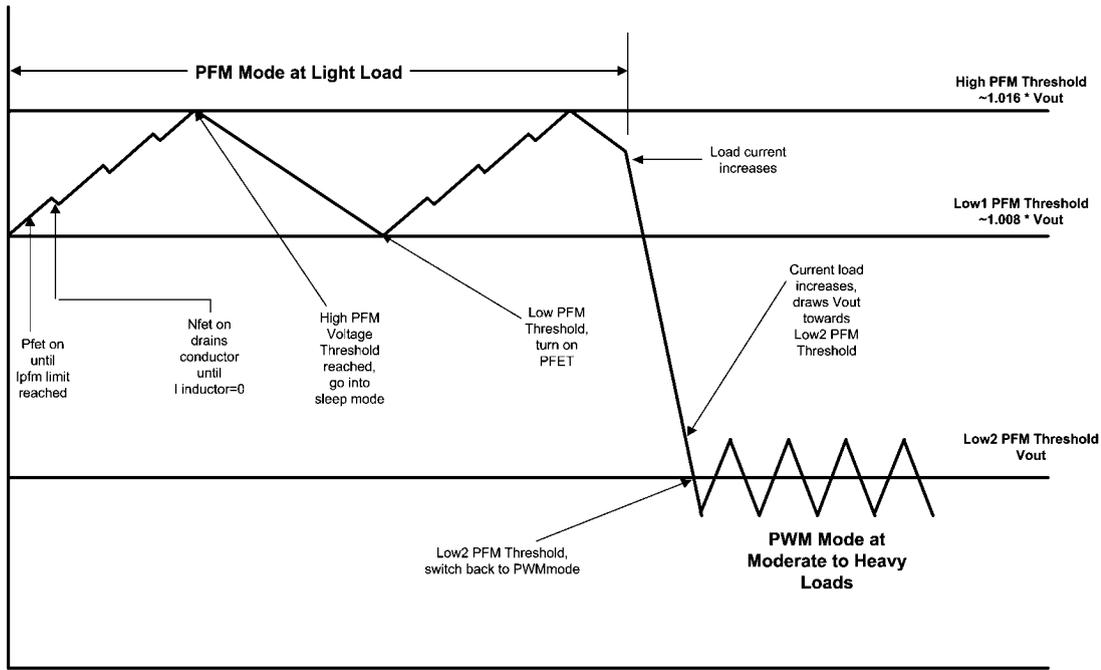
$$\left( \text{Typically } I_{MODE} < 66 \text{ mA} + \frac{V_{IN}}{160\Omega} \right)$$

During PFM operation, the converter positions the output voltage slightly higher than the nominal output voltage during PWM operation, allowing additional headroom for voltage drop during a load transient from light to heavy load. The PFM comparators sense the output voltage via the feedback pin and control the switching of the output FETs such that the output voltage ramps between 0.8% and 1.6% (typical) above the nominal PWM output voltage. If the output voltage is below the 'high' PFM comparator threshold, the PMOS power switch is turned on. It remains on until the output voltage exceeds the 'high' PFM threshold or the peak current exceeds the  $I_{PFM}$  level set for PFM mode. The typical peak current in PFM mode is:

$$I_{PFM} = 66 \text{ mA} + \frac{V_{IN}}{80\Omega}$$

Once the PMOS power switch is turned off, the NMOS power switch is turned on until the inductor current ramps to zero. When the NMOS zero-current condition is detected, the NMOS power switch is turned off. If the output voltage is below the 'high' PFM comparator threshold (see figure 4), the PMOS switch is again turned on and the cycle is repeated until the output reaches the desired level. Once the output reaches the 'high' PFM threshold, the NMOS switch is turned on briefly to ramp the inductor current to zero and then both output switches are turned off and the part enters an extremely low power mode. Quiescent supply current during this 'sleep' mode is less than  $30 \mu\text{A}$ , which allows the part to achieve high efficiencies under extremely light load conditions. When the output drops below the 'low' PFM threshold, the cycle repeats to restore the output voltage to  $\approx 1.6\%$  above the nominal PWM output voltage.

If the load current should increase during PFM mode (see figure 4) causing the output voltage to fall below the 'low' PFM threshold, the part will automatically transition into fixed-frequency PWM mode.



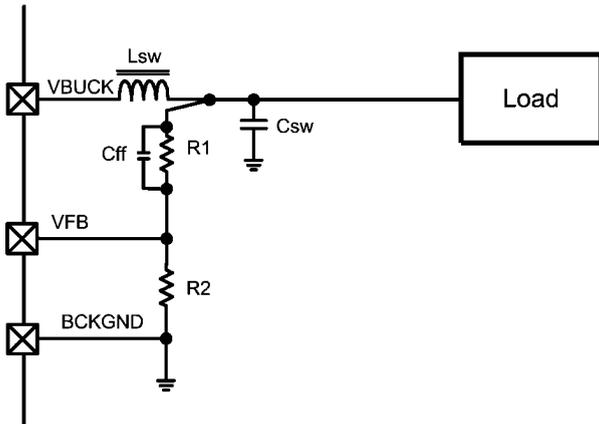
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**BUCK1, BUCK2 OPERATION**

BUCK1 is recommended to be used as the processor core supply and has I<sup>2</sup>C selectable output voltages ranging from 0.8V to 2.0V (Typ.). BUCK2 is recommended for IO power, Memory power and logic power. Its voltage range can be programmed using the I<sup>2</sup>C interface from 1.8V to 3.3V (Typ.). The default output voltage for each buck converter is factory programmable (See Application Notes).

The system designer can also determine the output voltage of either BUCK1 or BUCK2 through an external feedback resistor ladder by clearing the output voltage selection field in the BUCK1 or BUCK2 control registers.

**External Control of Buck Output Voltage through Feedback Resistor Ladder**



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**BUCK1, BUCK2 CONTROL REGISTERS AND BUCK1EN PIN**

BUCK1 and BUCK2 are configurable through I<sup>2</sup>C accessible registers. Bit fields D4–0 control the output voltage. Bit D5 defines the Modulation mode of the buck, which by default automatically selects PWM or PFM mode depending on the load as described above in the functional description. The modulation mode can be forced to PWM mode regardless of the load by setting bit D5 to a logic 1 in the corresponding buck control register.

Bit D6 controls the enable/disable state of the buck, which is different for BUCK1 and BUCK2 as BUCK1 has an external enable pin: BUCK1<sub>EN</sub>.

For BUCK1, by default or when D6 is programmed logic 0 in the BUCK1 control register, enable/disable control is passed onto the BUCK1<sub>EN</sub> pin. A logic 1 applied to this pin enables BUCK1 while a logic 0 disables BUCK1. Setting D6 to 1 in the BUCK1 control register enables BUCK1, regardless of the state of the BUCK1<sub>EN</sub> pin. If the system designer permanently connects the BUCK1<sub>EN</sub> pin to GND, then D6 is simply an enable/disable control bit. If the system design permanently connects the enable pin to V<sub>DD</sub>, then the BUCK1 is enabled during the power-on sequence and will always be on, regardless of the state of bit D6 in the BUCK1 control register (see Power On sequencing).

BUCK2 is by default enabled during the power-on sequence and can be enabled/disabled through bit D6 in the BUCK2 control register.

**BUCK1 CONTROL REGISTER (05)h**

|        | D7              | D6  | D5   | D4–0                            |                       |
|--------|-----------------|---|--|---------------------------------|-----------------------|
| Access | Read Only 0     | R/W   |  |                                 |                       |
| Data   | <b>Reserved</b> | <b>Operation</b><br>0: enable/disable determined by state of BUCK1EN pin<br>1: enable, override BUCK1EN state | <b>Force PWM mode</b><br>0: Automatic Modulation Mode<br>1: Force PWM mode | <b>BUCK1 Output Voltage (V)</b> |                       |
|        |                 |   |  | 5'h00                           | Externally controlled |
|        |                 |   |  | 5'h01                           | 0.80                  |
|        |                 |   |  | 5'h02                           | 0.85                  |
|        |                 |   |  | 5'h03                           | 0.90                  |
|        |                 |   |  | 5'h04                           | 0.95                  |
|        |                 |   |  | 5'h05                           | 1.00                  |
|        |                 |   |  | 5'h06                           | 1.05                  |
|        |                 |   |  | 5'h07                           | 1.10                  |
|        |                 |   |  | 5'h08                           | 1.15                  |
|        |                 |   |  | 5'h09                           | 1.20                  |
|        |                 |   |  | 5'h0A                           | 1.25                  |
|        |                 |   |  | 5'h0B                           | 1.30                  |
|        |                 |   |  | 5'h0C                           | 1.35                  |
|        |                 |   |  | 5'h0D                           | 1.40                  |
|        |                 |   |  | 5'h0E                           | 1.45                  |
|        |                 |   |  | 5'h0F                           | 1.50                  |
|        |                 |   |  | 5'h10                           | 1.55                  |
|        |                 |   |  | 5'h11                           | 1.60                  |
|        |                 |   |  | 5'h12                           | 1.65                  |
|        |                 |   |  | 5'h13                           | 1.70                  |
|        |                 |   |  | 5'h14                           | 1.75                  |
|        |                 |   |  | 5'h15                           | 1.80                  |
|        |                 |   |  | 5'h16                           | 1.85                  |
|        |                 |   |  | 5'h17                           | 1.90                  |
|        |                 |   |  | 5'h18                           | 1.95                  |
|        |                 |   |  | 5'h19–1F                        | 2.00                  |
| Reset  | n/a             | 0   | 0  | 5'h09                           |                       |

## BUCK2 CONTROL REGISTER (06)h

|        | D7              | D6  | D5   | D4–0                            |                       |
|--------|-----------------|---|--|---------------------------------|-----------------------|
| Access | Read Only 0     | R/W   |  |                                 |                       |
| Data   | <b>Reserved</b> | <b>Operation</b><br>0: disabled<br>1: enabled | <b>Force PWM mode</b><br>0: Automatic Modulation Mode<br>1: Force PWM mode | <b>BUCK2 Output Voltage (V)</b> |                       |
|        |                 |   |  | 5'h00                           | Externally controlled |
|        |                 |   |  | 5'h01                           | 1.80                  |
|        |                 |   |  | 5'h02                           | 1.90                  |
|        |                 |   |  | 5'h03                           | 2.00                  |
|        |                 |   |  | 5'h04                           | 2.10                  |
|        |                 |   |  | 5'h05                           | 2.20                  |
|        |                 |   |  | 5'h06                           | 2.30                  |
|        |                 |   |  | 5'h07                           | 2.40                  |
|        |                 |   |  | 5'h08                           | 2.50                  |
|        |                 |   |  | 5'h09                           | 2.60                  |
|        |                 |   |  | 5'h0A                           | 2.70                  |
|        |                 |   |  | 5'h0B                           | 2.80                  |
|        |                 |   |  | 5'h0C                           | 2.90                  |
|        |                 |   |  | 5'h0D                           | 3.00                  |
| 5'h0E  | 3.10            |   |  |                                 |                       |
| 5'h0F  | 3.20            |   |  |                                 |                       |
| 5'h1x  | 3.30            |   |  |                                 |                       |
| Reset  | n/a             | 1   | 0  | 5'h1F                           |                       |

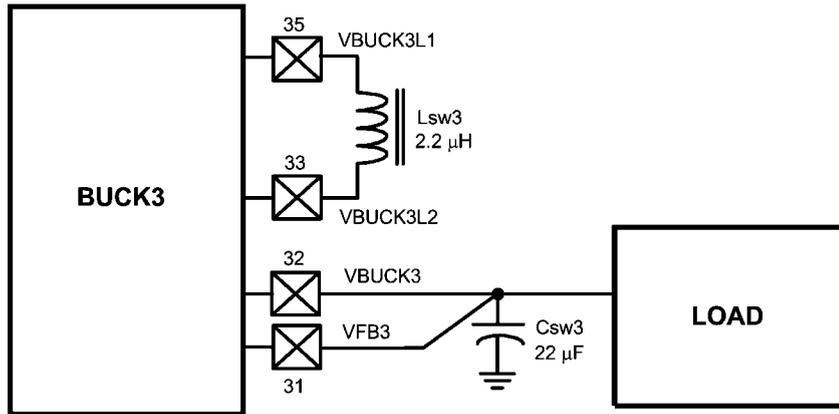
## BUCK3: Synchronous Magnetic DC/DC Converter

The LP3913 is equipped with a synchronous Buck3 magnetic DC-DC converter to supply power to the Flash memory that has a typical 1.7V-3.3V operating voltage. This voltage is lower than the maximum battery voltage (4.2V typically for Li-polymer cells) and higher than the minimum battery voltage

(typically 2.8V). Therefore, in order to provide 3.3V, regardless of the battery voltage, the Buck3 converter efficiently steps down the battery voltage. The Buck3 automatically switches between PWM and PFM modes depending on the load.

By setting bit D6 of the Buck3 control register, the Buck3 will be forced to operate using PWM modulation regardless of the load. By default, this bit is cleared.

Schematic Section for Buck3 Operation



### BUCK3 CONTROL REGISTER

Buck3 is controlled through its dedicated control register. Buck3 is enabled through the power-on sequencing. The system processor is required to select the desired Buck3 output voltage through bits D4-0 before enabling it by setting bit D6 in the control register. Buck3 is also disabled when 5'b00000

is programmed in the register field D4-0, regardless of the state of the bit D6. When Buck3 is disabled, its output is internally tied low through a 1MΩ resistor. If D4-0 is set to 5'b00000, the 1MΩ resistor is disconnected.

The default output voltage for the buck can be set to 1.8V, 2.5V, 2.8V, 3.3V, and is factory programmable.

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## BUCK3 CONTROL REGISTER (07)H

|        | D7              | D6  | D5  | D4–0                            |          |
|--------|-----------------|---|---|---------------------------------|----------|
| Access | Read Only 0     | R/W   |   |                                 |          |
| Data   | <b>Reserved</b> | <b>Force PWM</b><br>0: Automatic modulation mode<br>1: Force PWM modulation | <b>Operation</b><br>0: disable<br>1: enable | <b>BUCK3 Output Voltage (V)</b> |          |
|        |                 |   |   | 5'h00                           | disabled |
|        |                 |   |   | 5'h01                           | 1.80     |
|        |                 |   |   | 5'h02                           | 1.85     |
|        |                 |   |   | 5'h03                           | 1.90     |
|        |                 |   |   | 5'h04                           | 1.95     |
|        |                 |   |   | 5'h05                           | 2.00     |
|        |                 |   |   | 5'h06                           | 2.05     |
|        |                 |   |   | 5'h07                           | 2.10     |
|        |                 |   |   | 5'h08                           | 2.15     |
|        |                 |   |   | 5'h09                           | 2.20     |
|        |                 |   |   | 5'h0A                           | 2.25     |
|        |                 |   |   | 5'h0B                           | 2.30     |
|        |                 |   |   | 5'h0C                           | 2.35     |
|        |                 |   |   | 5'h0D                           | 2.40     |
|        |                 |   |   | 5'h0E                           | 2.45     |
|        |                 |   |   | 5'h0F                           | 2.50     |
|        |                 |   |   | 5'h10                           | 2.55     |
|        |                 |   |   | 5'h11                           | 2.60     |
|        |                 |   |   | 5'h12                           | 2.65     |
| 5'h13  | 2.70            |   |   |                                 |          |
| 5'h14  | 2.75            |   |   |                                 |          |
| 5'h15  | 2.80            |   |   |                                 |          |
| 5'h16  | 2.85            |   |   |                                 |          |
| 5'h17  | 2.90            |   |   |                                 |          |
| 5'h18  | 2.95            |   |   |                                 |          |
| 5'h19  | 3.00            |   |   |                                 |          |
| 5'h1A  | 3.05            |   |   |                                 |          |
| 5'h1B  | 3.10            |   |   |                                 |          |
| 5'h1C  | 3.15            |   |   |                                 |          |
| 5'h1D  | 3.20            |   |   |                                 |          |
| 5'h1E  | 3.25            |   |   |                                 |          |
| 5'h1F  | 3.30            |   |   |                                 |          |
| Reset  | n/a             | 0   | 1   | 5'h1F                           |          |

# Application Notes

## COMPONENT SELECTION

### Inductors for BUCK1, BUCK2 and BUCK3

There are two main considerations when choosing an inductor; the inductor should not saturate and the inductor current ripple is small enough to achieve the desired output voltage ripple. Care should be taken when reviewing the different saturation current ratings that are specified by different manufacturers.

Saturation current ratings are typically specified at 25°C, so ratings at maximum ambient temperature of the application should be requested from the manufacturer.

There are two methods to choose the inductor saturation current rating:

**Method 1:** The saturation current is greater than the sum of the maximum load current and the worst case average to peak inductor current. This can be written as follows:

$$I_{sat} > I_{outmax} + I_{ripple}$$

$$\text{where } I_{ripple} = \frac{1}{f} * \left( \frac{V_{in} - V_{out}}{2L} \right) * \left( \frac{V_{out}}{V_{in}} \right)$$

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- $I_{RIPPLE}$ : Average to peak inductor current
- $I_{OUTMAX}$ : Maximum load current
- $V_{IN}$ : Maximum input voltage to the buck
- $L$ : Min inductor value including worse case tolerances (30% drop can be considered for method 1)
- $f$ : Minimum switching frequency (1.6 MHz)
- $V_{OUT}$ : Buck Output voltage

**Method 2:** A more conservative and recommended approach is to choose an inductor that has saturation current rating greater than the maximum current limit of TBA.

| Inductor    | Value | Unit | Description      | Notes           |
|-------------|-------|------|------------------|-----------------|
| $L_{SW1,2}$ | 2.2   | µH   | BUCK1,2 Inductor | D.C.R.<br>70 mΩ |
| $L_{SW3}$   | 2.2   | µH   | BUCK3 Inductor   | D.C.R.<br>70 mΩ |

### External Capacitors

The regulators on the LP3913 require external capacitors for regulator stability. These are specifically designed for portable applications requiring minimum board space and smallest components. These capacitors must be correctly selected for good performance.

## LDO CAPACITOR SELECTION

### Input Capacitor

An input capacitor is required for stability. It is recommended that a 1.0 µF capacitor be connected between the LDO input pin and ground (this capacitance value may be increased without limit).

This capacitor must be located a distance of not more than 1 cm from the input pin and returned to a clean analog ground.

Any good quality ceramic, tantalum, or film capacitor may be used at the input.

**Important:** Tantalum capacitors can suffer catastrophic failures due to surge currents when connected to a low impedance source of power (like a battery or a very large capacitor). If a tantalum capacitor is used at the input, it must be guaranteed by the manufacturer to have a surge current rating sufficient for the application.

There are no requirements for the ESR (Equivalent Series Resistance) on the input capacitor, but tolerance and temperature coefficient must be considered when selecting the capacitor to ensure the capacitance will remain approximately 1.0 µF over the entire operating temperature range.

### Output Capacitor

The LDOs on the LP3913 are designed specifically to work with very small ceramic output capacitors. A 1.0 µF ceramic capacitor (temperature types Z5U, Y5V or X7R) with ESR between 5 mΩ to 500 mΩ, are suitable in the application circuit.

It is also possible to use tantalum or film capacitors at the device output,  $C_{OUT}$  (or  $V_{OUT}$ ), but these are not as attractive for reasons of size and cost.

The output capacitor must meet the requirement for the minimum value of capacitance and also have an ESR value that is within the range 5 mΩ to 500 mΩ for stability.

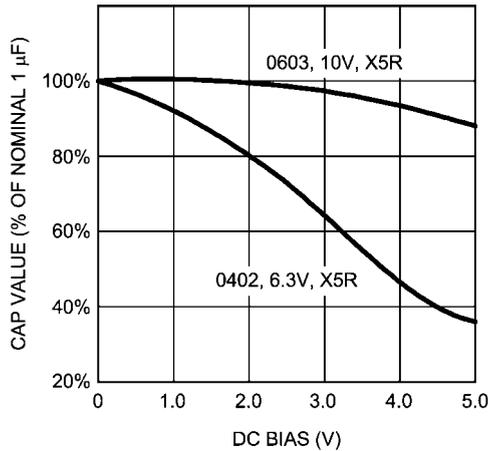
### Capacitor Characteristics

The LDOs are designed to work with ceramic capacitors on the output to take advantage of the benefits they offer. For capacitance values in the range of 0.47 µF to 4.7 µF, ceramic capacitors are the smallest, least expensive and have the lowest ESR values, thus making them best for eliminating high frequency noise. The ESR of a typical 1.0 µF ceramic capacitor is in the range of 20 mΩ to 40 mΩ, which easily meets the ESR requirement for stability for the LDO's.

For both input and output capacitors, careful interpretation of the capacitor specification is required to ensure correct device operation. The capacitor value can change greatly, depending on the operating conditions and capacitor type.

In particular, the output capacitor selection should take account of all the capacitor parameters, to ensure that the specification is met within the application. The capacitance can vary with DC bias conditions as well as temperature and frequency of operation. Capacitor values will also show some decrease over time due to aging. The capacitor parameters are also dependent on the particular case size, with smaller sizes giving poorer performance figures in general. As an example, the graph below shows a typical graph comparing different capacitor case sizes in a Capacitance vs. DC Bias plot.

**Graph Showing a Typical Variation in Capacitance vs. DC Bias**



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As shown in the graph, increasing the DC Bias condition can result in the capacitance value that falls below the minimum value given in the recommended capacitor specifications table. Note that the graph shows the capacitance out of spec for the 0402 case size capacitor at higher bias voltages. It is therefore recommended that the capacitor manufacturers' specifications for the nominal value capacitor are consulted for all conditions, as some capacitor sizes (e.g. 0402) may not be suitable in the actual application.

The ceramic capacitor's capacitance can vary with temperature. The capacitor type X7R, which operates over a temperature range of  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ , will only vary the capacitance to within  $\pm 15\%$ . The capacitor type X5R has a similar tolerance over a reduced temperature range of  $-55^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ . Many large value ceramic capacitors, larger than  $1\ \mu\text{F}$  are manufactured with Z5U or Y5V temperature characteristics. Their capacitance can drop by more than 50% as the temperature varies from  $25^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ . Therefore X7R is recommended over Z5U and Y5V in applications where the ambient temperature will change significantly above or below  $25^{\circ}\text{C}$ .

Tantalum capacitors are less desirable than ceramic for use as output capacitors because they are more expensive when comparing equivalent capacitance and voltage ratings in the  $0.47\ \mu\text{F}$  to  $4.7\ \mu\text{F}$  range.

Another important consideration is that tantalum capacitors have higher ESR values than equivalent size ceramics. This means that while it may be possible to find a tantalum capacitor with an ESR value within the stable range, it would have to be larger in capacitance (which means bigger and more costly) than a ceramic capacitor with the same ESR value. It should also be noted that the ESR of a typical tantalum will increase about 2:1 as the temperature goes from  $+25^{\circ}\text{C}$  down to  $-40^{\circ}\text{C}$ , so some guard band must be allowed.

#### Noise Bypass Capacitors for $V_{\text{REFH}}$ Pin

Connecting respectively  $100\ \text{nF}$  and  $1\ \text{nF}$  grounded bypass capacitors to the  $V_{\text{REFH}}$  pin significantly reduces noise on the LDO outputs.  $V_{\text{REFH}}$  is a high impedance nodes connected to a bandgap reference used for the LDOs. Any significant loading on this node will cause a change on the regulated output voltages. For this reason, DC leakage current through these pins must be kept as low as possible for best output voltage accuracy. The types of capacitors best suited for the noise bypass capacitors are ceramic and film capacitors. High-quality ceramic capacitors with either NPI or COG dielectric typically have very low leakage. Polypropylene and polycarbonate film capacitors are available in small surface-mount

packages and typically have extremely low leakage current. **Residual solder flux** is another potential source of leakage, which mandates thorough cleaning of the assembled PCBs.

#### Input Capacitor Selection for BUCK1, BUCK2 and BUCK3

A ceramic input capacitor of  $10\ \mu\text{F}$ ,  $6.3\text{V}$  is sufficient for the magnetic DC/DC converters. Place the input capacitor as close as possible to the input of the device. A large value may be used for improved input voltage filtering. The recommended capacitor types are X7R or X5R. Y5V type capacitors should not be used. DC bias characteristics of ceramic capacitors must be considered when selecting case sizes like 0805 and 0603. The input filter capacitor supplies current to the PFET switch of the DC/DC converter in the first half of each cycle and reduces voltage ripple imposed on the input power source. A ceramic capacitor's low ESR (Equivalent Series Resistance) provides the best noise filtering of the input voltage spikes due to fast current transients. A capacitor with sufficient ripple current rating should be selected. The input current ripple can be calculated as:

$$I_{\text{rms}} = I_{\text{outmax}} \sqrt{\frac{V_{\text{in}}}{V_{\text{out}}} \left( 1 - \frac{V_{\text{in}}}{V_{\text{out}}} + \frac{r^2}{12} \right)}$$

$$\text{where } r = \frac{(V_{\text{in}} - V_{\text{out}}) * V_{\text{out}}}{L * f * I_{\text{outmax}} * V_{\text{in}}}$$

30000136

The worse case is when  $V_{\text{IN}} = 2V_{\text{OUT}}$

#### Output Capacitor Selection for BUCK1, BUCK2 and BUCK3

A  $10\ \mu\text{F}$ ,  $6.3\text{V}$  ceramic capacitor should be used on the output of the BUCK1 and BUCK2 magnetic DC/DC converters. BUCK3 needs a  $22\ \mu\text{F}$  capacitor. The output capacitor needs to be mounted as close as possible to the output of the device. A large value may be used for improved input voltage filtering. The recommended capacitor types are X7R or X5R. Y5V type capacitors should not be used. DC bias characteristics of ceramic capacitors must be considered when selecting case sizes like 0805 and 0603. DC bias characteristics vary from manufacturer to manufacturer and DC bias curves should be requested from them and analyzed as part of the capacitor selection process.

The output filter capacitor of the magnetic DC/DC converter smoothes out current flow from the inductor to the load, helps maintain a steady output voltage during transient load changes and reduces output voltage ripple. These capacitors must be selected with sufficient capacitance and sufficiently low ESD to perform these functions.

The output voltage ripple is caused by the charging and the discharging of the output capacitor and also due to its ESR and can be calculated as follows:

$$V_{\text{pp-c}} = \frac{I_{\text{ripple}}}{4 * f * C}$$

30000137

Voltage peak-to-peak ripple due to ESR can be expressed as follows:

$$V_{\text{PP-ESR}} = 2 * I_{\text{RIPPLE}} * R_{\text{ESR}}$$

Because the  $V_{pp-c}$  and  $V_{pp-esr}$  are out of phase, the RMS value can be used to get an approximate value of the peak-to-peak ripple:

$$V_{pp-rms}^2 = \sqrt{V_{pp-c}^2 + V_{pp-esr}^2}$$

30000138

Note that the output voltage ripple is dependent on the inductor current ripple and the equivalent series resistance of the output capacitor ( $R_{ESR}$ ). The  $R_{ESR}$  is frequency dependent as well as temperature dependent. The  $R_{ESR}$  should be calculated with the applicable switching frequency and ambient temperature.

| Capacitor      | Min Value | Unit    | Description                                     | Recommended Type                              |
|----------------|-----------|---------|---|---|
| $C_{VDD}$      | 4.7       | $\mu F$ | Charger Input Capacitor                         | Ceramic, 6.3V, X5R                            |
| $C_{CHG\_DET}$ | 4.7       | $\mu F$ | Charger Input Capacitor                         | Ceramic, 6.3V, X5R                            |
| $C_{USB}$      | 4.7       | $\mu F$ | USB Power ( $V_{BUS}$ ) Capacitor               | Ceramic, 6.3V, X5R                            |
| $C_{BATT}$     | 4.7       | $\mu F$ | Li-ion Battery Capacitor                        | Ceramic, 6.3V, X5R                            |
| $C_{LDO1}$     | 1.0       | $\mu F$ | LDO Output Capacitor                            | Ceramic, 6.3V, X5R                            |
| $C_{LDO2}$     | 1.0       | $\mu F$ | LDO Output Capacitor                            | Ceramic, 6.3V, X5R                            |
| $C_{VREFH}$    | 0.1       | $\mu F$ | Bypass Capacitor for Internal Voltage Reference | Ceramic, PolyPropylene and Polycarbonate Film |
| $C_{VIN2,3}$   | 10        | $\mu F$ | Buck1, Buck2 Input Capacitor                    | Ceramic, 6.3V, X5R                            |
| $CVBUCK1,2$    | 10        | $\mu F$ | BUCK1,2 Output Capacitor                        | Ceramic, 6.3V, X5R                            |
| $C_{SW3}$      | 22        | $\mu F$ | BUCK3 Output Capacitor                          | Ceramic, 6.3V, X5R                            |
| $C_{VIN1}$     | 1         | $\mu F$ | LDO Bypass Capacitor                            | Ceramic, 6.3V, X5R                            |
| $C_{VIN4}$     | 10        | $\mu F$ | Buck Bypass Capacitor                           | Ceramic, 6.3V, X5R                            |

**Schottky Diode on Charger Input CHG\_IN**

A Schottky diode is required in the external adapter path to block the reverse current from either the USB or the battery source. The most critical parameter in the selection of the right Schottky diode is the leakage current, which needs to be below 10  $\mu A$  over the temperature range in order to prevent false detection of the presence of an external adapter. In addition the Schottky diode should have a maximum voltage rating of 10V or higher. The current rating depends on the current limit of the adapter. The forward voltage should be limited to 500 mV at its maximum current. The recommended Schottky diode is MBRA210ET3 from ON Semiconductor which has a reverse leakage current under 1  $\mu A$  at room temperature and a forward voltage drop of 500 mV at their max rated current  $I_F = 2A$ .

**RESISTORS**

**Battery Thermistor**

The LP3913 battery thermistor bias provided by the  $T_S$  pin is tailored to thermistors with the following specification:

- Negative Temperature Coefficient
- 100 k $\Omega$  resistance

A suitable solution is available from AVX thermistors: AVXNB21250104 <http://www.avxcorp.com/docs/Catalogs/nb21-23.pdf>

**I<sup>2</sup>C Pullup Resistors**

$I^2C\_SDA$ ,  $I^2C\_SCL$  terminals need to have pullup resistors connected to the  $V_{DDIO}$  pin.  $V_{DDIO}$  must be connected to a power supply that is less than or equal to  $V_{DD}$ , such as Buck2. The values of the pull-up resistors (typ.  $\approx 1.8 k\Omega$ ) are determined by the capacitance of the bus. Too large of a resistor combined with a given bus capacitance will result in a rise time that would violate the max rise time specification. Too small of a resistor will result in a contention with the pull-down transistor on either slave(s) or master.

**$R_{IREF}$  Resistor**

The current through this resistor is used as a reference current that biases many analog circuits inside the LP3913 and needs to have a resistance of 121 k $\Omega \pm 1\%$

**$R_{ISENSE}$  Resistor**

The current through this resistor is used as a reference current for the charge current. The accuracy of the ADC is dependent on the tolerance of this resistor.  $R_{ISENSE}$  needs to have a resistance of 4.64 k $\Omega \pm 1\%$  tolerance.

**Operation without I<sup>2</sup>C Interface**

Operation of the LP3913 without the I<sup>2</sup>C interface is possible if the system can operate with default values for the DC/DC converters and the charger. (Read below: Factory programmable options). The I<sup>2</sup>C-less system must use the POW-ERACK pin to power cycle the LP3913.

**I<sup>2</sup>C Master Power Concern**

The processor that contains the I<sup>2</sup>C master should be powered by BUCK1 or LDO2 as these converters require no I<sup>2</sup>C access to enable/disable them. If the I<sup>2</sup>C master were to be powered by a DC/DC converter that is enable/disabled through a control register, then a corrupted application software execution could by accident disable the power to the I<sup>2</sup>C master, which in this case has no means to recover. It is possible that the regulator connected to  $V_{DDIO}$  could accidentally disable, in which case the processor should be able to recognize that communication has been broken and then power down the system to allow for a clean restart.

**System Operation When the Load Current Exceeds the USB or Adapter Current Limit**

In the event that the system requires current that exceeds the current limit of either the USB or the adapter source, then the battery can provide the extra power provided that it has been charged. It is clear that a long sustained overload will eventually discharge the battery such that its extra power will no

longer be sufficient to properly operate the system. This will be the case when the system is for instance operated from a USB host with a 100 mA current limit.

### Factory Programmable Options

The following options are programmed for the LP3913. The system designer that needs specific options is advised to contact the local National Semiconductor sales office.

| Factory programmable options        | Default Value |
|-------------------------------------|---------------|
| LDO1 output voltage after power up  | 2.0V          |
| LDO2 output voltage after power up  | 3.3V          |
| BUCK1 output voltage after power up | 1.2V          |
| BUCK2 output voltage after power up | 3.3V          |
| BUCK3 power voltage after power up  | 3.3V          |
| Battery low threshold               | 2.90V         |
| Delay for LDO1 and LDO2             | 5 ms          |
| Delay for Buck1                     | 15 ms         |
| Delay for Buck2                     | 20 ms         |
| Delay for Buck3                     | 25 ms         |
| Delay for NRST                      | 60 ms         |
| Default Full Rate Charge Current    | 100 mA        |
| EOC Default                         | 0.1C          |
| V <sub>TERM</sub> Default           | 4.2V          |
| ONOFF Edge/Level                    | Level         |
| ONOFF Polarity                      | Positive      |
| Buck1 Enable Polarity               | Positive      |
| LDO2 Enable Polarity                | Positive      |
| Ignore Ten Hour Timer               | No            |
| LED default current                 | 10 mA         |
| Buck3 500 mA output current         | Yes           |
| Thermistor 10k/100k                 | 100k          |

The I<sup>2</sup>C Chip ID address is offered as a metal mask option. The current value equals 60 hex.

### PCB LAYOUT CONSIDERATIONS

For good performance of the circuit, it is essential to place the input and output capacitors very close to the circuit and use wide routing for the traces allowing high currents.

## Thermal Performance of the LLP Package

The LP3913 is a monolithic device with integrated power FETs. For that reason, it is important to pay special attention to the thermal impedance of the LLP package and to the PCB layout rules in order to maximize power dissipation of the LLP package.

The LLP package is designed for enhanced thermal performance and features an exposed die attach pad at the bottom center of the package that creates a direct path to the PCB for maximum power dissipation. Compared to the traditional leaded packages where the die attach pad is embedded inside the molding compound, the LLP reduces one layer in the thermal path.

The thermal advantage of the LLP package is fully realized only when the exposed die attach pad is soldered down to a thermal land on the PCB board with thermal vias planted un-

Sensitive components should be placed far from those components with high pulsating current.

Decoupling capacitors should be close to circuit's V<sub>IN</sub> pins. Digital and analog ground should be routed separately and connected together in a star connection.

It's good practice to minimize high current and switching current paths.

### LDO Regulators

Place the filter capacitors very close to the input and output pins. Use large trace width for high current carrying traces and the returns to ground.

### BUCK Regulators

Place the supply bypass, filter capacitor and inductor close together and keep the traces short. The traces between these components carry relatively high switching current and act as antennas. Following these rules reduces radiated noise.

Arrange the components so that the switching current loops curl in the same direction.

Connect the buck ground and the ground of the capacitors together using generous component-side copper fill as a pseudo-ground plane. Then connect this back to the general board system ground plane at a single point. Place the pseudo-ground plane below these components and then have it tied to system ground of the output capacitor outside of the current loops. This prevents the switched current from injecting noise into the system ground. These components along with the inductor and output should be placed on the same side of the circuit board, and their connections should be made on the same layer.

Route the noise sensitive traces such as the voltage feedback path away from the inductor. This is done by routing it on the bottom layer or by adding a grounded copper area between switching node and feedback path. Noisy traces between the power components and keep any digital lines away from this section. Keep the feedback node as small as possible so that the ground pin and ground traces will shield it from the SW or buck output.

Use wide traces between the power components and for power connections to the DC-DC converter circuit. This reduces voltage errors caused by resistive losses.

derneath the thermal land. Based on thermal analysis of the LLP package, the junction-to-ambient thermal resistance ( $\theta_j$ ) can be improved by a factor of two when the die attach pad of the LLP package is soldered directly onto the PCB with thermal land and thermal vias, as opposed to an alternative with no direct soldering to a thermal land. Typical pitch and outer diameter for thermal vias are 1.27 mm and 0.33 mm respectively. Typical copper via barrel plating is 1 oz., although thicker copper may be used to further improve thermal performance. The LP3913 die attach pad is connected to the substrate of the IC and therefore, the thermal land and vias on the PCB board need to be connected to ground (GND pin).

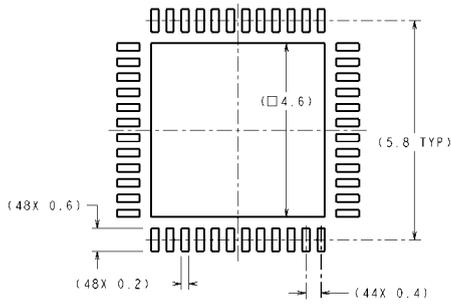
For more information on board layout techniques, refer to Application Note 1187 "Leadless Lead Frame Package (LLP)." on <http://www.national.com>

This application note also discusses package handling, solder stencil and the assembly process.

## Datasheet Revision History

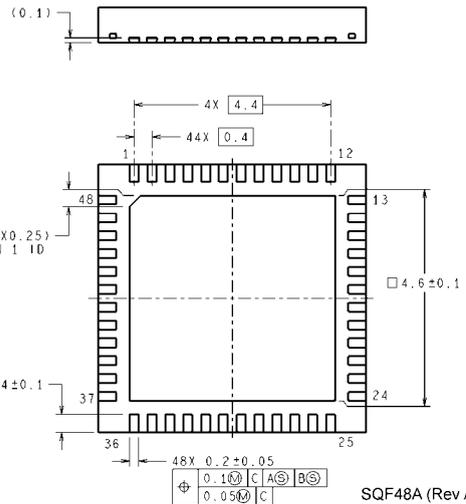
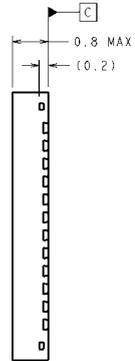
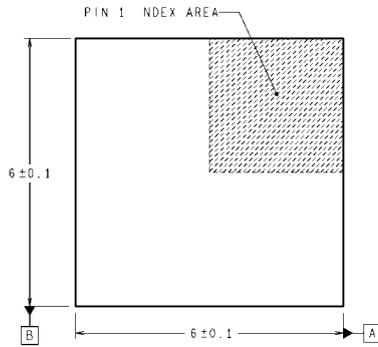
| Revision | Date       | Comments                                |
|----------|------------|---|
| 1.0      | 08/10/2006 | Initial Release, advanced specification |

**Physical Dimensions** inches (millimeters) unless otherwise noted



**DIMENSIONS ARE IN MILLIMETERS**  
DIMENSIONS IN ( ) FOR REFERENCE ONLY

**RECOMMENDED LAND PATTERN**



SQF48A (Rev A)

**SQF48A Package: 6x6x0.8mm 48-Pin LLP Package with 0.4mm Pitch**

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